

Super High-speed 1T 8051 Core Flash MCU, 4 Kbytes SRAM, 32 Kbytes Flash, 0~4 Kbytes LDROM, 1 Kbytes Independent EEPROM, 12-bit ADC, 8-channel 16-bit PWM, 5 Timers, UART, 3-channel USCI, MDU, CRC Check Module, LCD/LED Driver, LPD

## 1 General Description

SC92L7535/7533/7532/7531 (hereinafter referred to as the SC92L753X) is a series of wide voltage and low-power 8051 core industry-standard Flash Microcontroller unit (MCU), the instruction set is compatible with the standard 8051 series.

The SC92L753X integrates a hardware multiplier and divider and hardware CRC to accelerate data operations speed. The hardware multiplier and divider and hardware CRC does not occupy CPU cycles, and the operation is implemented by hardware, and the speed is faster than the multiplication and division speed realized by software.

The SC92L753X has high performance and reliability, with a wide operating voltage of 1.8V~5.5V, a super-wide operating temperature of -40°C to 105°C, and has good ESD performance and EFT anti-interference ability. The Flash can be written more than 100,000 times, and can be stored for 100 years at room temperature.

The SC92L753X has a built-in low-power consumption WDT Watchdog Timer. It has a 4-level selectable voltage LVR low voltage reset function and a system clock monitoring function. It has low power consumption capability in operation and power-down modes. In normal operating mode: about 4.5mA@32M at 5V.

The SC92L753X series is also integrated with super rich hardware resources: 32 KbytesFlash ROM, 4 Kbytes SRAM, 0~4 Kbytes LDROM, 1 Kbytes EEPROM. Up to 30 GP I/O, 13 IO can be externally interrupted, 5 16-bit timers, 11-channels 12-bit high precision ADC, Built-in 2.4/1.024/2.048V ADC reference voltage, 8-channel 16-bit dead zone complementary PWM, MDU, CRC Check Module. Internal high precision high frequency 32MHz oscillator, the system clock can be selected as the high frequency clock / 1/2/4/8 frequency division, Internal ±4% precision low-frequency 32 kHz oscillator, external 32.768 kHz resources such as crystal oscillators. And UART, SPI, TWI and other communication interfaces.

The SC92L753X is very convenient for development and debugging, with ISP (In-System Programming), ICP (In-Circuit Programming) and IAP (In-Application Programming). Allow the chip to debug and upgrade the program memory directly on the circuit board when the chip is online or powered.

The SC92L753X has very excellent anti-jamming performance. It is very suitable for all kinds of Internet of things control, smoke Sensor, smart home appliances, RF module, smart wearable, Sensor/MEMS module, temperature and humidity recorder, battery power and other applications.

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### 2 Features

### **Operating Conditions**

- 2.0V~5.5V@-40°C ~ +105°C
- 1.8V~5.5V@0°C ~ +85°C

#### **EMS**

- ESD
  - HBM: MIL-STD-883J Class 3A
  - MM: JEDEC EIA/JESD22-A115 Class C
  - CDM: ANSI/ESDA/JEDEC JS-002-2018 Class C3
- EFT
  - EN61000-4-4 Level 4

#### **Package**

- 16 PIN: SOP16
- 20 PIN: SOP20 / TSSOP20 / QFN20(3×3)
- 28 PIN: SOP28 / TSSOP28 / QFN28(4×4)
- 32 PIN: LQFP32 / QFN32

#### **CPU**

- Super-high-speed 1T 8051 core
- Instruction set fully compatible with 8051, execution speed is about 2 times of other 1T 8051

#### Flash ROM

- 32 Kbytes Flash ROM
- Divided into 64 sectors, 512 bytes per sector
- Can be rewritten 100,000 times
- Can be stored for 100 years at 25 °C
- Flash allowed IAP operation in Flash can be set to 0K/1K/2K or 32K by Code Option.

#### **LDROM**

BootLoader code memory

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### Super High-Speed Flash MCU

LDROM area can be set to 0K/1K/2K/4K by Code Option

#### **EEPROM**

- Independent 1 Kbytes EEPROM
- Can be rewritten 100,000 times, has more than 100-year preservation life in the ambient temperature of 25°C

#### **Unique ID**

96 bits Unique ID, Store the unique identifier of the IC

#### SRAM

- Internal 256 bytes in-chip direct access RAM
- 3.75 Kbytes External RAM(XRAM)
- Additional PWM & LCD/LED RAM:
  - 16 bytes Indirect access RAM Read and write PWM duty cycle SFR address: 0F40H~0F4FH through MOVX instruction
  - 24 bytes In-chip indirect access RAM Read and write the LCD/LED display RAM by MOVX instruction. The address ranges from 0F00H to 0F17H

#### System clock (fsys)

- Built-in high frequency 32 MHz oscillator (HRC)
  - The system clock frequency (Fsys) of IC can be set to 32/16/8/4MHz by programmer choice
  - Full voltage range (1.8V~5.5V):
    - ◆ -10 ~ 105°C application environment, frequency error is not more than ±1%
    - ◆ -20 ~ 105°C, the frequency error is not more than ±2%
  - The system clock can be automatically calibrated by 32.768 kHz external crystal oscillator, after calibration HRC accuracy can be infinitely close to the accuracy of external 32.768 kHz crystal oscillator.

#### Built-in low-frequency crystal oscillator circuit:

• 32.768k oscillator can be connected externally as a Base Timer clock source.

#### Built-in low-frequency 32 kHz oscillator (LRC):

- used as the clock source for Base Timer and WDT and wake up STOP
- Frequency Error: After the register correction, within ±4% @ -20 ~ 85°C @ 4.0 ~ 5.5V

### Low-voltage Reset (LVR)

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### **Super High-Speed Flash MCU**

- 4 options of reset voltage: 4.3、3.7V、2.7V、1.7V
- the default value can be selected by the Code Option

#### Low Voltage Monitoring Module (LPD)

- 8 low voltage detection: 1.85V / 2.05V / 2.25V / 2.45V / 2.85V / 3.45V / 3.85V / 4.45V
- Interruptible

#### Flash program and simulation

• 2 - line JTAG write, simulation interface, support live simulation

#### Interrupts (INT)

- Timer 0~Timer 4, INT0~2, ADC, PWM, UART, USCI0~2, Base Timer, and LPD 16 interrupt sources
- External interrupt contains 3 interrupt vectors, 13 interrupt ports. All can set up rising edge, falling edge, dual edge interrupt.
- Two-level interrupt priority capability

#### **Digital Peripheral**

- GPIO: Up to 30 bidirectional independently controllable I/O ports
  - Independent setting of pull-up resistors
  - All port source drive capacity is controlled by four levels
  - All IO ports have large sink current drive capability (50mA)
- Built-in WDT, optional clock frequency division ratio
- 5 Timer0~4
- 8-channel 16-bit PWM
  - Can be set as independent mode or complementary mode: in independent mode, 8-channel PWM has a common cycle, and duty cycle can be set separately; In complementary mode, four groups of complementary PWM waveforms with dead zone can be output simultaneously
  - The output waveform can be reversed and can be set to center aligned or edge aligned
  - Models with 20PIN packages and above support PWM fault detection (FLT)
- One independent UART communication port UART0
- 3 UART/SPI/TWI communication interfaces (USCI)
  - When USCI0 is set to SPI0, the driving capability of the pins corresponding to its signal port will be enhanced
- Built-in CRC check module
- Integrated with 16 \* 16-bit hardware Multiplier-Divide Unit (MDU)

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#### LCD/LED driver

- Choose one of two LCD/LED, share registers and IO ports
- 8 X 20, 6 X 22, 5 X 23, or 4X 24 segments LED driver
- LED segment port source drive capability is selectable in four levels
- 8 X 20, 6 X 22, 5 X 23, or 4X 24 segments LCD driver

### **Analog Peripheral**

- 11-channel 12-bit±2LSB ADC
  - 1MHz ultra-high speed sampling clock, the total time from sampling to complete conversion is as low as 2µs
  - The ADC has four options for reference voltages, VDD and internal 2.048V, 1.024V, or 2.4V
  - 1 internal channel can measure the 1/4 voltage of the power supply

### **Power Saving Mode**

- IDLE Mode: can be woken up by any interrupt
- STOP Mode: can be woken up by INT0~2, Base Timer.

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# Naming Rules for 92L Series Products

Name	SC	92	L	7	5	3	5	Х	Р	32	R
S/R	1	2	3	4	(5)	9	7	8	9	(2)	11)

S/R	Meaning
1	SinOne Chip abbreviation
2	Name of product series
3	Product Type (L: Low Power Flash MCU)
4	Serial Number: 7: GP Series, 8: TK series
\$	ROM Size: 1 for 2K, 2 for 4K, 3 for 8K, 4 for 16K, 5 for 32K and 6 for 64K
6	Subseries Number.: 0 ~ 9, A ~ Z
7	Number of Pins: 0: 8pin/ 10pin, 1: 16pin,2: 20pin,3: 28pin,5: 32pin,6: 44pin,7: 48pin,8: 64pin,9: 100pin
8	Version:(default, B, C, D)
9	Package Type: (D: DIP; M: SOP; X: TSSOP; F: QFP; P: LQFP; Q: QFN; K: SKDIP;S:MSOP)
100	Number of Pins.
11)	Packaging Mode: (U: Tube; R: Tray; T: Reel)

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# **Ordering Information**

PRODUCT ID	PACKAGE	PACK
SC92L7535P32R	LQFP32	TRAY
SC92L7535Q32R	QFN32	TRAY
SC92L7533M28U	SOP28	TUBE
SC92L7533X28U	TSSOP28	TUBE
SC92L7533Q28R	QFN28(4X4)	TRAY
SC92L7532M20U	SOP20	TUBE
SC92L7532X20U	TSSOP20	TUBE
SC92L7532Q20R	QFN20(3X3)	TRAY
SC92L7531M16U	SOP16	TUBE

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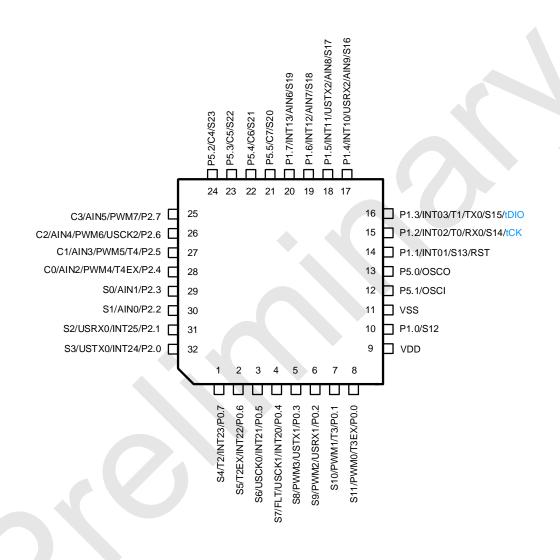


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# 3 Pin Description

## 3.1 Pin Configuration



SC9L7535 Pin Diagram

Suitable for LQFP32&QFN32 package

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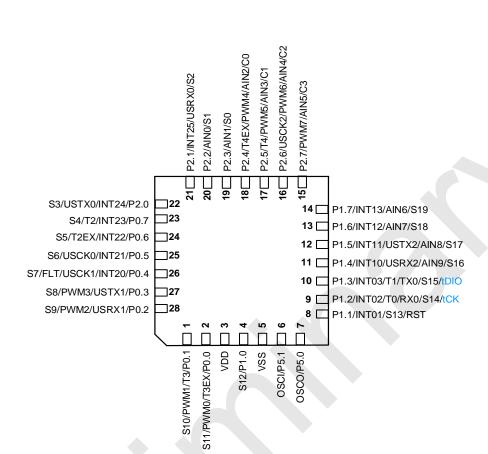
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VDD □	1	28 P0.0/T3EX/PWM0/S11
S12/P1.0	2	27 P0.1/T3/PWM1/S10
VSS □	3	26 P0.2/USRX1/PWM2/S9
OSCI/P5.1	4	25 P0.3/USTX1/PWM3/S8
OSCO/P5.0 □	5	24 P0.4/INT20/USCK1/FLT/S7
RST/S13/INT01/P1.1	6	23 P0.5/INT21/USCK0/S6
tCK/S14/RX0/T0/INT02/P1.2	7	22 P0.6/INT22/T2EX/S5
tDIO/S15/TX0/T1/INT03/P1.3	8	21 P0.7/INT23/T2/S4
S16/AIN9/USRX2/INT10/P1.4	9	20 P2.0/INT24/USTX0/S3
S17/AIN8/USTX2/INT11/P1.5	10	19 P2.1/INT25/USRX0/S2
S18/AIN7/INT12/P1.6	11	18 P2.2/AIN0/S1
S19/AIN6/INT13/P1.7	12	17 P2.3/AIN1/S0
C3/AIN5/PWM7/P2.7	13	16 P2.4/T4EX/PWM4/AIN2/C0
C2/AIN4/PWM6/USCK2/P2.6	14	15 P2.5/T4/PWM5/AIN3/C1

SC92L7533 Pin Diagram

Suitable for SOP28 & TSSOP28 package

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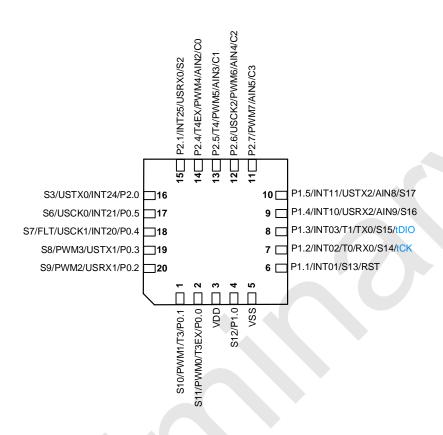


SC92L7533 Pin Diagram

Suitable for QFN28 package

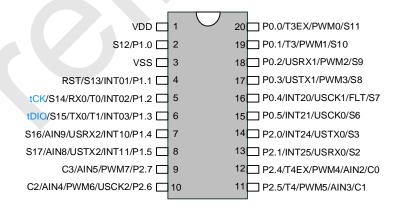
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SC92L7532 Pin Diagram

Suitable for QFN20 package



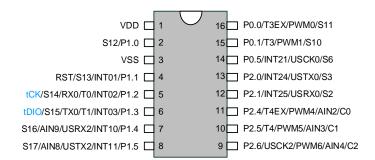
SC92L7532 Pin Diagram

Suitable for SOP20 package

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SC92L7531 Pin Diagram

Suitable for SOP16 package

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# Super High-Speed Flash MCU

## 3.2 Pin Definition

		Package						
LQFP32& QFN32	SOP28& TSSOP28	SOP20& TSSOP20	SOP 16	QFN 28	QFN 20	Pin Name	Туре	Description
1	21	-	-	23	-	P0.7/INT23/T2/S4	I/O	P0.7: GPIO P0.7 INT23: Input 3 of external interrupt 2 T2: Timer/Counter 2 External Input S4: LCD/LED SEG4
2	22	-	-	24	-	P0.6/INT22/T2EX/S5	I/O	P0.6: GPIO P0.6  INT22: Input 2 of external interrupt 2  T2EX: External capture for Timer2  S5: LCD/LED SEG5
3	23	15	14	25	17	P0.5/INT21/USCK0/S6	I/O	P0.5: GPIO P0.5  INT21: Input 1 of external interrupt 2  USCK0: USCI0 SCK

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								S6: LCD/LED SEG6
4	24	16	-	26	18	P0.4/INT20/USCK1/FLT/S7	VO	P0.4: GPIO P0.4  INT20: Input 0 of external interrupt 2  USCK1: USCI1 SCK  FLT: PWM fault detection input pin  S7: LCD/LED SEG7
5	25	17	-	27	19	P0.3/USTX1/PWM3/S8	I/O	P0.3: GPIO P0.3  USTX1: TX of USCI1  PWM3: PWM3 Output  S8: LCD/LED SEG8
6	26	18		28	20	P0.2/USRX1/PWM2/S9	I/O	P0.2: GPIO P0.2  USRX1: RX of USCI1  PWM2: PWM2 Output  S9: LCD/LED SEG9
7	27	19	15	1	1	P0.1/T3/PWM1/S10	I/O	P0.1: GPIO P0.1 T3: Timer/Counter3 external input



## Super High-Speed Flash MCU

								PWM1: PWM1 Output S10: LCD/LED SEG10
8	28	20	16	2	2	P0.0/T3EX/PWM0/S11	1/0	P0.0: GPIO P0.0  T3EX: External capture for Timer3  PWM0: PWM0 Output  S11: LCD/LED SEG11
9	1	1	1	3	3	VDD	Power	Power
10	2	2	2	4	4	P1.0/S12	I/O	P1.0: GPIO P1.0 S12: LCD/LED SEG12
11	3	3	3	5	5	vss	Power	Ground
12	4	-	-	6		P5.1/OSCI	I/O	P5.1: GPIO P5.1 OSCI: 32.768 kHz oscillator input
13	5			7		P5.0/OSCO	I/O	P5.0: GPIO P5.0 OSCO: 32.768 kHz oscillator output

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## Super High-Speed Flash MCU

14	6	4	4	8	6	P1.1/INT01/S13/RST	1/0	P1.1: GPIO P1.1 INT01: Input 1 of external interrupt 0 S13: LCD/LED SEG13 RST: Reset pin
15	7	5	5	9	7	P1.2/INT02/T0/RX0/S14/tCK	I/O	P1.2: GPIO P1.2  INT02: Input 2 of external interrupt 0  T0: Timer/Counter0 external input  RX0: UART0 Receiver  S14: LCD/LED SEG14  tCK: Programming and Emulation Clock Pin
16	8	6	6	10	8	P1.3/INT03/T1/TX0/S15/tDIO	I/O	P1.3: GPIO P1.3  INT03: Input 3 of external interrupt 0  T1: Timer/Counter1 external input  TX0: UART0 Transmitter  S15: LCD/LED SEG15  tDIO: Programming and Emulation Data Pin

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17	9	7	7	11	9	P1.4/INT10/USRX2/AIN9/S16	Power	P1.4: GPIO P1.4 INT10: Input 0 of external interrupt 1 USRX2: MISO/RX of USCI2 AIN9: ADC input channel 9 S16: LCD/LED SEG16
18	10	8	8	12	10	P1.5/INT11/USTX2/AIN8/S17	I/O	P1.5: GPIO P1.5  INT11: Input 1 of external interrupt 1  USTX2: MOSI/SDA/TX of USCI2  AIN8: ADC input channel 8  S17: LCD/LED SEG17
19	11	-		13	-	P1.6/INT12/AIN7/S18	I/O	P1.6: GPIO P1.6  INT12: Input 2 of external interrupt 1  AIN7: ADC input channel 7  S18: LCD/LED SEG18
20	12	-		14	-	P1.7/INT13/AIN6/S19	I/O	P1.7: GPIO P1.7 INT13: Input 3 of external interrupt 1



## Super High-Speed Flash MCU

								AIN6: ADC input channel 6 S19: LCD/LED SEG19
21	-	-	-	-	-	P5.5/C7/S20	I/O	P5.5: GPIO P5.5  C7: LCD/LED common output 7  S20: LCD/LED SEG20
22	-	-	-	-	•	P5.4/C6/S21	I/O	P5.4: GPIO P5.4 C6: LCD/LED common output 6 S21: LCD/LED SEG21
23	-	-	-	-		P5.3/C5/S22	I/O	P5.3: GPIO P5.3 C5: LCD/LED common output 5 S22: LCD/LED SEG22
24	-	-				P5.2/C4/S23	I/O	P5.2: GPIO P5.2 C4: LCD/LED common output 4 S23: LCD/LED SEG23
25	13	9	-	15	11	P2.7/PWM7/AIN5/C3	I/O	P2.7: GPIO P2.7

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## Super High-Speed Flash MCU

								PWM7: PWM7 Output  AIN5: ADC input channel 5  C3: LCD/LED common output 3
26	14	10	9	16	12	P2.6/USCK2/PWM6/AIN4/C2	I/O	P2.6: GPIO P2.6  USCK2: SCK of USCI2  PWM6: PWM6 Output  AIN4: ADC input channel 4  C2: LCD/LED common output 2
27	15	11	10	17	13	P2.5/T4/PWM5/AIN3/C1	I/O	P2.5: GPIO P2.5  T4: Timer/Counter4 external input  PWM5: PWM5 Output  AIN3: ADC input channel 3  C1: LCD/LED common output 1
28	16	12	11	18	14	P2.4/T4EX/PWM4/AIN2/C0	I/O	P2.4: GPIO P2.4  T4EX: External capture for Timer4  PWM4: PWM4 Output

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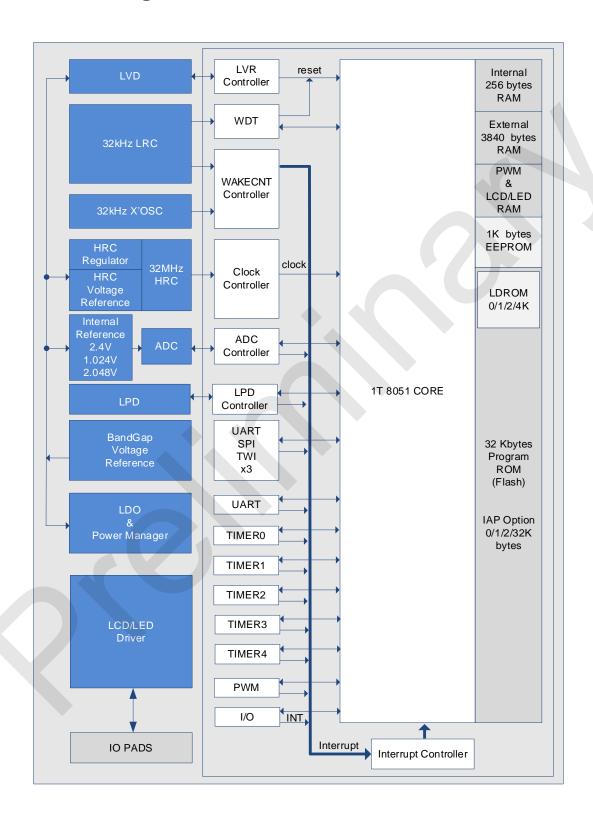
## Super High-Speed Flash MCU

								AIN2: ADC input channel 2  C0: LCD/LED common output 0
29	17	-	-	19	-	P2.3/AIN1/S0	1/0	P2.3: GPIO P2.3  AIN1: ADC input channel 1  S0: LCD/LED SEG 0
30	18	-		20	-	P2.2/AIN0/S1	I/O	P2.2: GPIO P2.2  AIN0: ADC input channel 0  S1: LCD/LED SEG 1
31	19	13	12	21	15	P2.1/INT25/USRX0/S2	I/O	P2.1: GPIO P2.1  INT25: Input 5 of external interrupt 2  USRX0: MISO/RX of USCI0  S2: LCD/LED SEG 2
32	20	14	13	22	16	P2.0/INT24/USTX0/S3	I/O	P2.0: GPIO P2.0 INT24: Input 4 of external interrupt 2 USTX0: MOSI/SDA/TX of USCI0 S3: LCD/LED SEG 3

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# 4 Inner Block Diagram



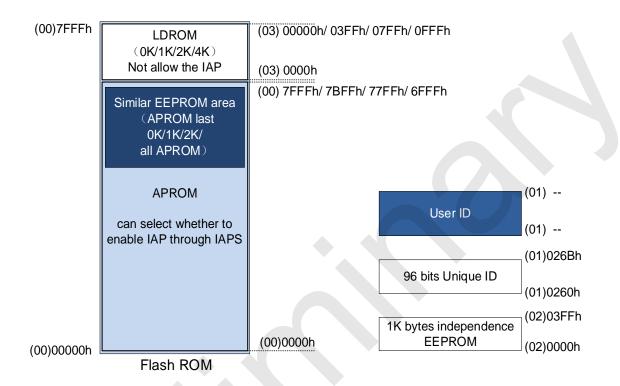
SC92L753X BLOCK DIAGRAM

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### 5 Flash ROM and SRAM

The Flash ROM of SC92L753X is divided into five regions: APROM/LDROM/EEPROM/User ID/Unique ID, as shown in the following figure:



### 5.1 APROM and LDROM

APROM and LDROM are two independent pieces of hardware that divide ROM by LDSIZE[1:0]. They are distinguished by the extended address "00" and "03" set by IAPADE register. They can be programmed and erased by SC LINK PRO.

- The extended address of the APROM area is "00". The choose of the area is 28~32 Kbytes. It supports IAP
  (In Application Programming) and APROM area allowed IAP operation in Flash can be set to 0K/1K/2K/All
  APROM by Code Option.
- The extended address of LDROM area is "03", area size 0~4 Kbytes optional. IAP on LDROM is not allowed.

APROM and LDROM have 64 sectors, each 512 bytes, and can be repeatedly written for 100,000 times. Data can be stored for more than 100 years at 25  $^{\circ}$  C

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SC92L753X APROM Sector

### 5.2 1K bytes independent EEPROM

The SC92L753X has 1 Kbytes of independent EEPROM, the address is (02)000H ~ 03FFH, "02" in brackets is the extended address, which is set by the IAPADE register. Independent EEPROM can be rewritten 100,000 times and the data written-in has more than 100-year preservation life in the ambient temperature of 25°C. EEPROM supports blank checking, programming, verification, erasing and reading functions.

EEPROM divided into 2 sectors,512 bytes per sector



SC92L753X EEPROM Sectors

Notes: EEPROM can be rewritten 100,000 times. User should not exceed the rated burn times of EEPROM, otherwise there will be exceptions!

## 5.3 96 bits Unique ID Area

96 bits Unique ID area. The address range is (01) 0260H to 026CH, where (01) is the extended address set by the IAPADE register. Stores the IC Unique ID. Users can read the IC Unique ID, but cannot write the Unique ID.

The SC92L753X provides an independent Unique ID area. A 96-bit unique code can be pre-programmed before leaving the factory to ensure the uniqueness of the chip. The only way for the user to obtain the serial number is to read the relative address (01)0260H~(01)026BH through the IAP instruction. The Unique ID range is (01)0260H~(01)026BH, the "01" in brackets indicates the extended address which is set by the IAPADE register. The specific operation method is as follows:

IAPADE (F4H) IAP Write to extended address register (Read/Write)

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for(i=0;i<12;i++)

### SC92L7535/7533/7532/7531

### **Super High-Speed Flash MCU**

Bit number	7	6	5	4	3	2	1	0				
Bit Mnemonic		IAPADER[7: 0]										
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W				
POR	0	0	0	0	0	0	0	0				

Bit number	Bit Mnemonic	Description
7~0	IAPADER[7: 0]	IAP Extended address:
		0x00: Both MOVC and IAP are for APROM
		0x01: For the unique ID area, read but write operations are not allowed, otherwise it may cause an exception!
		0x02: Both MOVC and IAP are for EEPROM
		0x03: MOVC for LDROM region (note: only MOVC, not IAP, this is only valid for LDROM program operation, APROM program operation this is not valid)
		Other: reserved

## 5.3.1 Unique ID Read Operating Demo Program In C Language

#include "intrins.h"

unsigned char UniqueID [12];//store UniqueID

unsigned char code \* POINT =0x0260;

unsigned char i;

EA = 0; // Disable the global interrupt

IAPADE = 0X01; // Expand address 0x01, select Unique ID area

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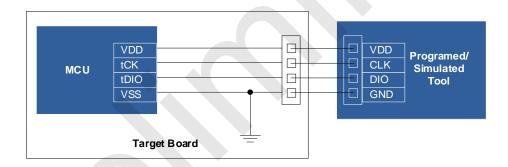
## Super High-Speed Flash MCU

### 5.4 User ID Area

User ID area, whose extended address is (01), is written for user in the factory. Users can read the User ID area, but cannot write the User ID area.

### 5.5 Programming

The SC92L753X's APROM, LDROM, EEPROM can be programmed through tDIO, tCK, VDD, VSS, the specific connection relationship is as follows:



ICP mode Flash Writer programming connection diagram

tDIO,tCK is a 2-wire JTAG programming and emulation signal line. Users can configure the mode of these two ports through the Code Option when programming:

#### 5.5.1 JTAG Specific Mode

tDIO,tCK are specific port for programming and emulation, and other functions multiplexed with it are not available. This mode is generally used in the online debugging stage, which is convenient for users to simulate and debug. After the JTAG special mode takes effect, the chip can directly enter the programming or emulation mode without powering on and off again.

#### 5.5.2 Normal Mode (JTAG specific port is invalid)

The JTAG function is not available, and other functions multiplexed with it can be used normally. This mode can prevent the programming port from occupying the MCU pins, which is convenient for users to maximize the use of MCU resources.

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### Super High-Speed Flash MCU

Note: When the invalid configuration setting of the JTAG dedicated port is successful, the chip must be completely powered off and then on again to enter the programming or emulation mode, which will affect the programming and emulation in the live mode. SinOne recommends that users select the invalid configuration of the JTAG dedicated port during mass production and programming, and select the JTAG mode during the development and debugging phase.

#### **Code Option register:**

#### OP\_CTM1 (C2H@FFH) Code Option register1 (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	VREFS[1: 0]		OP_BL	DISJTG			LDSIZE[1:0]	
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W R/W	
POR	n	n	n	n	n	n	n	n

Bit number	Bit Mnemonic	Description
4	DISJTG	IO/JTAG port switching control
		TAG mode is enabled, P1.1 and P1.3 can only be used as tCK/tDIO. Recommended settings during R&D and commissioning     Normal mode (Normal), JTAG function is invalid. The recommended setting for the mass production burning stage.

## 5.6 In Application Programming (IAP)

Application Programming (IAP) operations can be carried out in the APROM of SC92L753X (0K, 1K, 2K, or all APROM ranges are optional) and 6K bytes EEPROM. Users can implement remote program updates through IAP operations. You can also obtain Unique ID field or User ID field information via IAP reads. Before IAPS write data, you must erase the Sector to which the target address belongs. The length of a Sector is 512 bytes.

#### NOTE:

- 1. During the IAP erase/write process, the CPU holds the program counter, and after the IAP erase/write is complete, the program counter continues to execute subsequent instructions.
- 2. IAP operation in APROM area has certain risks, users need to take corresponding security measures in the software, if improper operation may cause user program rewriting! This feature is not recommended unless it is required by the user (for example, for remote application updates).

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3. The EEPROM erasure count is 100,000. Do not exceed the rated EEPROM erasure count; otherwise, an exception may occur.

The user can select the IAP region range of APROM through Customer Option during programming, or set the IAP region of APROM through IAPS control bit in the program. The relevant registers are as follows:

### OP\_CTM1 (C2H@FFH) Customer Option Register 1(Read/write)

Bit number	7	6	5	4	3	2	1	0	
Bit Mnemonic	VREF	S[1: 0]	OP_BL	DISJTG	IAPS[1: 0]		LDSIZE[1:0]-		
R/W	R/W	R/W	R/W	R/W	R/W	R/W -R		R	
POR	n	n	n	n	n	n	n	n	

Bit Number	Bit Mnemonic	Description
3~2	IAPS[1: 0]	IAP spatial range selection
		00: Full Flash ROM not allows IAP operation
		01: Last 1K Flash ROM allows IAP operation
		10: Last 2K Flash ROM allows IAP operation
		11: Full Flash ROM allows IAP operation
		Note:
		1. The above setting items are invalid in BootLoader mode. The BootLoader program can perform IAP operation on the entire Flash ROM area.
		2. LDROM does not allow IAP operation under any circumstances.

### 5.6.1 IAP Operation Related Register

Symbol Address Description	7	6	5	4	3	2	1	0	POR
----------------------------	---	---	---	---	---	---	---	---	-----

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## Super High-Speed Flash MCU

IAPKEY	F1H	Data protection register	IAPKEY[7: 0]	00000000ь
IAPADL	F2H	IAP write address low register	IAPADR[7: 0]	0000000b
IAPADH	F3H	IAP write address high register	- IAPADR[14: 8]	x0000000b
IAPADE	F4H	IAP write to extended address register	IAPADER[7: 0]	00000000Ь
IAPDAT	F5H	IAP data register	IAPDAT[7: 0]	0000000b
IAPCTL	F6H	IAP control register	BTL - SERAS PRG CMD[1: 0]	0x00xx00b

### IAPKEY (F1H) IAP Protection Register (Read/Write)

Bit number	7	6	5	4	3	2	1	0			
Bit Mnemonic		IAPKEY[7: 0]									
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W			
POR	0	0	0	0	0	0	0	0			

Bit Number	Bit Mnemonic	Description
7~0	IAPKEY[7: 0]	Open IAP function and operation time limit setting  Write a non-zero value n, representing:  1.Enable the IAP function;

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### **Super High-Speed Flash MCU**

2.If no IAP write command is received after n system clocks, the IAP function is turned off again.

### IAPADL (F2H) IAP Write Address Low Register (read/write)

Bit number	7	6	5	4	3	2	1	0	
Bit Mnemonic	IAPADR[7: 0]								
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
POR	0	0	0	0	0	0	0	0	

Bit Number	Bit Mnemonic	Description
7~0	IAPADR[7: 0]	IAP writes the low 8 bits of the address

### IAPADH (F3H) IAP Write Address High Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	-		IAPADR[14: 8]					
R/W	-	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	×	0	0	0	0	0	0	0

Bit Number	Bit Mnemonic	Description
6~0	IAPADR[14: 8]	IAP writes the high 8 bits of the address

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### **Super High-Speed Flash MCU**

### IAPADE (F4H) IAP Write to Extended Address Register (Read/Write)

Bit number	7	6	5	4	3	2	1	0		
Bit Mnemonic		IAPADER[7: 0]								
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W		
POR	0	0	0	0	0	0	0	0		

Bit Number	Bit Mnemonic	Description						
7~0	IAPADER[7: 0]	IAP extended address:						
		0x00: Both MOVC and IAP are for APROM						
		0x01: The Unique ID area is read but cannot be written 0x02: Both MOVC and IAP are for independent EEPROM						
		0x03: MOVC is performed in the LDROM region (Note: only MOVC can be used, not IAP, this item is only valid for LDROM operation, APROM operation this item is not valid!)						
		Other: reserved						

### IAPDAT (F5H) IAP Data Register (read/write)

Bit number	7	6	5	4	3	2	1	0		
Bit Mnemonic	IAPDAT[7: 0]									
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W		
POR	0	0	0	0	0	0	0	0		

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## Super High-Speed Flash MCU

Bit number	Bit Mnemonic	R/W	Description
7~0	IAPDAT[7:0]	R/W	Data written by IAP

### IAPCTL (F6H) IAP Control register (Read/Write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	BTLD		SERASE	PRG	-	-	CMD[1: 0]	
R/W	R/W	-	R/W	R/W			R/W	R/W
POR	0	х	0	0	x	х	0	0

Bit number	Bit Mnemonic	Description
7	BTLD	BootLoader control bit  0: software reset after the program from the main area (main program), began to run;  1: the software reset after the program from the BootLoader area began to run
5	SERASE	Sector Erase control bit  0: no operation  1: place a "1" and then configure CMD (1-0) = 10, then enter the Flash ROM Sector Erase operation, Flash ROM specified Sector will be erased
4	PRG	Program (the Program) control bit  0: no operation

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### Super High-Speed Flash MCU

		1: place a "1" and then configure CMD (1-0) = 10, Flash ROM to write operation, IAPDAT register data will be written to Flash ROM address specified
1~0	CMD[1:0]	IAP command can control bit
		10: write or sector erase operation command
		Other: reservations
		NOTE:
		After SERASE/PRG is set to 1, you must set CMD[1:0]=10 to start the corresponding operation
		Only one IAP action can be performed at a time, so SERASE/PRG can only have one position 1 at a time
		The IAP operation statement must be followed by at least 8 NOP instructions to ensure the normal execution of subsequent instructions after the IAP operation is completed

### 5.6.2 IAP Operation process

The IAP writing process for SC92L753X is as follows:

- 1. Write IAPADER[7:0]:
  - =0x00, perform IAP operation on APROM region
  - =0x01, read the Unique ID field, Note: this can only be read, not rewritten!
  - =0x02, reads and writes the EEPROM area
  - =0x03, read the LDROM area . Note: MOVC only, not IAP, this is only valid for LDROM program operation, APROM program operation this is not valid!
- 2. Write IAPDAT[7:0], ready for IAP to write data;
- 3. Write IAPADR[14:0], prepare the target address of IAP operation;
- 4. Write IAPKEY[7:0] a non-zero value n, turn on IAP protection, and IAP operation will be closed if no write command is received within n system clocks;
- 5. After the IAP writes, the CPU continues.

### 5.6.3 Notes for IAP operation

- 1. When programming IC, if "APROM zone prevents IAP operation" is selected through Code Option, then IAPADE[7:0]=0x00 (APROM zone is selected), IAP cannot be operated, that is, data cannot be written, data can only be read by MOVC instruction.
- 2. When IAPADE not 0 x00 MOVC and writing is not aimed at APROM area, at this time if there is interruption, and interrupt with MOVC operation, can cause MOVC result error, cause the program to run. To avoid this situation, if IAPADE is not 0x00 during IAP operation, it is important to turn off total interrupt (EA=0) before operation, and set IAPADE = 0x00 after operation before turning on total interrupt (EA=1).

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### Super High-Speed Flash MCU

- 3. IAP wipe/writing process, the CPU program counter, IAP wipe/write, after the completion of the program counter to continue after the instruction;
- 4. APROM area of IAP operation has certain risk, requires the user to do the corresponding safety measures in the software, if the improper operation may cause the user program has changed! This feature is not recommended unless it is required by the user (for example, for remote application updates).
- 5. EEPROM to wipe the number for 100000 times, user wipe block don't exceed the EEPROM rating of the burning times, otherwise will be abnormal!

#### 5.6.4 IAP Operating Demo Program In C Language

The header files shared by the following routines are as follows:

```
#include "intrins.h"
unsigned int IAP Add;
unsigned char IAP_Data;
unsigned char code * POINT =0x00;
```

\_nop\_ ();

EA = 1; // Enable total interrupt

```
IAP operation: sector erase:
    EA = 0; // close the interrupt
    IAPADE = 0 x00; // expand address 0 x00, select Flash ROM
    IAPADH = (unsigned char) ((IAP_Add > > 8)); // write IAP target address
    IAPADL = high value (unsigned char) IAP_Add; // write IAP target address
    IAPKEY = 0 xf0 low value;
    IAPCTL = 0 \times 20; // set up the sector erase bit
    IAPCTL = 0 x02; // execution block wipe
    _nop_ (); // wait (need at least eight _nop_ ())
    _nop_ ();
    _nop_ ();
    _nop_ ();
    _nop_ ();
    _nop_ ();
    _nop_ ();
     _nop_ ();
```

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#### IAP operation: write data:

```
EA = 0; // close the interrupt

IAPADE = 0 x00; // expand address 0 x00, select Flash ROM

IAPDAT = IAP_Data; // send data to the IAP data register

IAPADH = (unsigned char) ((IAP_Add > > 8)); // write IAP target address

IAPADL = high value (unsigned char) IAP_Add; // write IAP target address
```

IAPKEY = 0 xf0 low value; // This value can be adjusted according to actual situation; After the need to ensure this instruction execution to IAPCTL before assigning, // the time interval should be less than 240 (0 xf0) a system clock, otherwise the IAP functions closed; Be especially careful when // open the interrupt

```
IAPCTL = 0 \times 10; // Set the IAP write operation bit.
```

```
IAPCTL | = 0 x02; // execution _nop_ written instructions (); // wait (need at least eight _nop_ ())
_nop_ ();
```

#### EA = 1; // Enable total interrupt

#### IAP operation: read data:

```
EA = 0;  // Close global interrupt

IAPADE = 0X00;  //The extended address is 0x00, selectFlash ROM

IAP_Data = *( POINT+IAP_Add);  //Read the value of IAP_Add toIAP_Data

EA = 1;  // Open global interrupt
```

#### 5.7 BootLoader

The LDROM is used to store the bootLoader code. LDROM supports blank checking (BLANK), programming (PROGRAM), verifying (VERIFY), erasing (ERASE) and reading (READ) functions in ICP mode.

Users can realize ISP (In System Programing) function through LDROM: when ISP is executed, IC runs the boot code In LDROM area. When the boot code is executed, IC receives new program code through serial port, and then programs the received code into user code area through IAP command.

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The LDROM has four address ranges:

- (03)0000H~(03)0000H (without LDROM)
- (03)0000H~(03)03FFH (1K)
- (03)0000H~(03)07FFH (2K)
- (03)0000H~(03)0FFFH (4K)

Where: "03" in the brackets above indicates the extended address, which is set by LDSIZE [1:0].

### 5.7.1 BootLoader Mode operation related registers

#### OP\_CTM1 (C2H@FFH) Code Option Register1 (Read/Write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	VREF	S[1: 0]	OP_BL	DISJTG	IAPS	[1: 0]	LDSIZ	E [1:0]
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/	'W
POR	n	n	n	n	n	n	n	n

Bit Number	Bit Mnemonic	Description				
5	OP_BL	0	Program run area control be: After the chip is reset, it: After the chip is reset, it: The MOVC and IAP res	enters APROM		
		Operation Is it operable?		Is it operable?		
			LDROM MOVC	x		

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# Super High-Speed Flash MCU

		APROM MOVC	Only the first 256 bytes	cannot be MOVC		
		LDROM IAP	×			
		APROM IAP	$\sqrt{}$			
		② The MOVC and IAP restrictions for LDROM are as follows:				
		Operation		Is it operable?		
		LDROM MOVC		V		
		APROM MOVC √				
		LDROM IAP ×				
		ALL APROM IAP, no	t restricted by IAPRANGE	V		
1~0	LDSIZE [1:0]	LDROM space range se	election	_		
		00: None LDROM, the	APROM address is 0000H~7	7FFFH		
		01: The last 1K APROM APROM address is 000	I area of the Flash ROM is L 0H~7BFFH	DROM, and the		
		10: The last 2K APROM area of the Flash ROM is LDROM, and the APROM address is 0000H~77FFH				
		11: The last 4K APROM area of the Flash ROM is LDROM, and the APROM address is 0000H~6FFFH				
		NOTE: LDROM not alle	ow IAP operation in anywa	nys		

# IAPKEY (F1H) Data Protection Register (Read/Write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic		IAPKEY[7: 0]						
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

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# Super High-Speed Flash MCU

Bit number	Bit Mnemonic	Description
7~0	IAPKEY[7: 0]	Open IAP and operation time limit setting  Write a value n greater than or equal to 0x40, which represents:
		Enable the IAP;  2. If no IAP write command is received after n system clocks, the IAP is turned off again.

# IAPADL (F2H) IAP Write Low Address Register (Read/Write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic		IAPADR[7: 0]						
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit number	Bit Mnemonic	Description
7~0	IAPADR[7: 0]	IAP writes the low 8 bits of the address

### IAPADH (F3H) IAP Write High Address Register (Read/Write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	-	IAPADR[14: 8]						
R/W	-	R/W	R/W	R/W	R/W	R/W	R/W	R/W

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POR	Х	0	0	0	0	0	0	0

Bit number	Bit Mnemonic	Description
6~0	IAPADR[14: 8]	IAP writes the high 8 bits of the address

### IAPADE (F4H) IAP Write to Extended Address Register (Read/Write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic		IAPADER[7: 0]						
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit number	Bit Mnemonic	Description
7~0	IAPADER[7: 0]	IAP extended address:
		0x00: Both MOVC and IAP are for Flash ROM
		0x01: The Unique ID area is read but cannot be written
		0x02: Both MOVC and IAP are for independent EEPROM
		0x03: MOVC is performed in the LDROM region (Note: only MOVC can be used, not IAP, this item is only valid for LDROM operation, APROM operation this item is not valid!)
		Other: reserved

### IAPDAT (F5H) IAP Data Register (Read/Write)

Bit number	7	6	5	4	3	2	1	0
------------	---	---	---	---	---	---	---	---

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# **Super High-Speed Flash MCU**

Bit Mnemonic				IAPDA	.T[7: 0]			
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit number	Bit Mnemonic	Description
7~0	IAPDAT	Data written by IAP

# IAPCTL (F6H) IAP Control Register (Read/Write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	BTLD	<b>.</b>	SERASE	PRG	•	-	СМІ	D[1: 0]
R/W	R/W	·	R/W	R/W	-	-	R/W	R/W
POR	0	х	0	0	х	х	0	0

Bit number	Bit Mnemonic	Description
7	BTLD	BootLoader control bit  0: software reset after the program from the main area (main program), began to run;  1: the software reset after the program from the BootLoader area began to run
5	SERASE	Sector Erase control bit  0: no operation

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# **Super High-Speed Flash MCU**

		1: place a "1" and then configure CMD (1-0) = 10, then enter the Flash ROM Sector Erase operation, Flash ROM specified Sector will be erased
4	PRG	Program (the Program) control bit  0: no operation  1: place a "1" and then configure CMD (1-0) = 10, Flash ROM to write operation, IAPDAT register data will be written to Flash a ROM address specified
1~0	CMD[1:0]	IAP command can control bit  10: write or sector erase operation command  Other: reservations  NOTE:  4. After SERASE/PRG is set to 1, you must set CMD[1:0]=10 to start the corresponding operation  5. Only one IAP action can be performed at a time, so SERASE/PRG can only have one position 1 at a time  The IAP operation statement must be followed by at least 8 NOP instructions to ensure the normal execution of subsequent instructions after the IAP operation is completed

# PCON (87h) Power Management Control Register (write only, \*not readable\*)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	SMOD	-	-	-	RST	-	STOP	IDL
R/W	write	1	-	-	write only	-	write only	write only
POR	0	х	х	х	n	х	0	0

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### **Super High-Speed Flash MCU**

Bit number	Bit Mnemonic	Description
3	RST	Software reset control bit:
		Write status:
		0: The program runs normally;
		1: The CPU resets immediately after this bit is written to "1"

#### **Bootloader Notes:**

- 1. The user must erase the target sector before writing LDROM;
- 2. For the specific operation method, please refer to the description document "SinOne hardware BootLoader Function Implementation Application Guide" provided by SinOne.

# 5.8 Encryption

Users can choose whether to encrypt the SC92L753X's ROM through the settings on the computer program:

- If the encryption function is disabled, users can read the last data written in APROM and LDROM by SC LINK;
- 2. If the encryption function is enabled, the data written in APROM (32 Kbytes Flash ROM) and LDROM will never be read from outsid. It is recommended to enable the encryption function during mass production;
- 3. The only way to release security encryption is to re-programming
- 4. The encryption has no effect on iap read and write operation

For the specific operation method, please refer to the chapter of Secure Encryption and Reading in the "SOC LINK Series Programmer & Simulator User Manual".

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# 5.9 Code Option Area (User Programming Settings)

SC92L753X has a separate Flash area for storing the initial power-on Settings of the customer, which is called the Code Option area. This part of the code is written into the IC when the user programs the IC, and this setting will be called into the SFR as the initial setting when the IC is reset and initialized.

Option related SFR operation instructions:

OPINX and OPREG registers control the read and write operations of option-related SFR. OPINX determines the specific positions of each Option SFR, as shown in the following table:

Symbol	OPINX Address	Instructions	bit7	bit6	bit5	bit4	bit3	bit2	bit1	bit0
OP_CTM 0	0xC1	Code Option register 0	ENW DT	ENX TL	SCLK	S[1: 0]	DISR ST	DISL VR	LVRS	S[1: 0]
OP_CTM 1	0xC2	Code Option register 1	VREF	S[1: 0]	OP_ BL	DISJ TG	IAPS	[1: 0]	LDSIZ	E[1:0]
OP_HRC R	0x83	System clock change register				OP_HR	CR[7: 0]			

### OP\_CTM0(C1H@FFH) Code Option Register 0 (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	ENWDT	ENXTL	SCLKS[1: 0]		DISRST	DISLVR	LVRS[1: 0]	
R/W	R/W	R/W	R/W		read only	R/W	R/	W
POR	n	n	n		n	n	n	l

Bit number	Bit Mnemonic	Description
7	ENWDT	WDT control bit 0: WDT invalid

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		1: WDT valid(But the IC WDT stops counting during IAP execution)
6	ENXTL	External 32.768kHz crystal selector switch  0: External 32.768khz crystal oscillator off, P5.0, P5.1 effective;  1: the external open 32.768 kHz crystal vibration, P5.0, P5.1 is invalid.
5~4	SCLKS[1: 0]	System clock frequency selection bits  00: System clock frequency is HRC frequency divided by 1;
		<ul> <li>01: System clock frequency is HRC frequency divided by 2;</li> <li>10: System clock frequency is HRC frequency divided by 4;</li> <li>11: System clock frequency is HRC frequency divided by 8;</li> </ul>
3	DISRST	IO/RST Selection bit  0: configure P1.1 as GPIO  1: configure P1.1 as RST
2	DISLVR	LVR enable setting  0: LVR valid  1: LVR invalid
1~0	LVRS [1:0]	LVR voltage threshold selection control 11: 4.3V 10: 3.7V
		01: 2.7V 00: 1.7V

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# OP\_CTM1 (C2H@FFH) Code Option register 1 (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	VREF	S[1:0]	OP_BL	DISJTG	IAPS	S[1:0]	LDSIZE[1:0]	
R/W	R/	W	R/W	R/W	R/W	R/W	read only	read only
POR	n	n	n	n	n	n	n	n

Bit Number	Bit Mnemonic		Description				
7~6	VREFS[1: 0]		ection (the initial value in user can modify the setting				
		00: Set VREF of ADC to	00: Set VREF of ADC to VDD;				
		01: Set the VREF of AD	C to the internal accurate 2	2.4V;			
		10: Set the VREF of AD	C to the internal accurate 1	.024V;			
		11: Set the VREF of AD	C to the internal accurate 2	2.048V;			
5	OP_BL	Program run area contro	ol bit				
		0: After the chip is reset	, it enters APROM				
		1: After the chip is reset	, it enters LDROM				
		① The MOVC and IAP	restrictions for APROM are	as follows:			
		Operation	Is it operable?				
		LDROM MOVC	х				
		APROM MOVC	Only the first 256 bytes	cannot be MOVC			
		LDROM IAP	×				
		APROM IAP √					
		③ The MOVC and IAP restrictions for LDROM are as follows:					
		Operation		Is it operable?			
		LDROM MOVC		√			

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		APROM MOVC	V				
		LDROM IAP	×				
		ALL APROM IAP, not restricted by IAPRANGE √					
4	DISJTG	IO/JTAG port switching control  0: JTAG mode is enabled, P1.1 and P1.3 can only by tCK/tDIO. Recommended settings during R&D and the setting of the setting of the mass production burning recommended setting for the mass production burning points.	commissioning The				
3~2	IAPS[1: 0]	IAP spatial range selection					
		00: Full Flash ROM not allows IAP operation					
		01: Last 1K Flash ROM allows IAP operation					
		10: Last 2K Flash ROM allows IAP operation					
		11: Full Flash ROM allows IAP operation					
		Note:					
		1.The above setting items are invalid in BootLoader BootLoader program can perform IAP operation on ROM area.					
		2. LDROM does not allow IAP operation under any	circumstances.				
1~0	LDSIZE [1:0]	LDROM space range selection					
		00: None LDROM, the APROM address is 0000H~7	FFFH				
		01: The last 1K APROM area of the Flash ROM is L APROM address is 0000H~7BFFH	DROM, and the				
		10: The last 2K APROM area of the Flash ROM is LDROM, and the APROM address is 0000H~77FFH					
		11: The last 4K APROM area of the Flash ROM is L APROM address is 0000H~6FFFH	DROM, and the				
		NOTE: LDROM not allow IAP operation in anywa	ys				

OP\_HRCR (83h@FFH) System Clock Change Register (read/write)

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Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic				OP_HR	CR[7: 0]			
R/W		R/W						
POR	n	n	n	n	n	n	n	n

Bit number	Bit Mnemonic		Description				
7~0	OP_HRCR[7: 0]	HRC frequency change register					
			e high-frequency oscillator frequency fHRC by is register, and then change the system clock				
			IRCR[7: 0] after power-on OP_HRCR[s] is a t fhrc is 32 MHz, OP_HRCR[s] of each IC				
		fsys of the IC can be set	OP_HRCR[s], the system clock frequency to an accurate 32/16/8/4 MHz through the HRCR [7: 0] changes by 1, the fsys frequency				
		The relationship between is as follows:	n OP_HRCR [7: 0] and Fsys output frequency				
		OP_HRCR [7: 0] value	fsys actual output frequency (32M as an example)				
		OP_HRCR [s]-n	32000*(1-0.18%*n) kHz				
		OP_HRCR [s]-2	32000*(1-0.18%*2) = 31 884.8 kHz				
		OP_HRCR [s]-1	32000*(1-0.18%*1) = 31 942.4 kHz				

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### **Super High-Speed Flash MCU**

·		
	OP_HRCR [s]	32000 kHz
	OP_HRCR [s]+1	32000*(1+0.18%*1) = 32 057.6 kHz
	OP_HRCR [s]+2	32000*(1+0.18%*2) = 32 115.2 kHz
	OP_HRCR [s]+n	32000*(1+0.18%*n) kHz
	Note:	
	of the high-frequency The user can modify	value of IC after each power-on is the value oscillator frequency Fhrc closest to 32MHz; the HRC value after each power-on so that frequency, Fsys, works at the user's desired
	2. In order to ensure the	ne reliable operation of the IC, the maximum
	operating frequency that is 35.2 MHz;	of the IC should not exceed 10% of 32 MHz,
	Please confirm that other functions.	the change of HRC frequency will not affect

### 5.9.1 Option-related Registers Operation Instructions

Option-related SFRs reading and writing operations are controlled by both OPINX and OPREG registers, with their respective position of Option SFR depending on OPINX and its value written to option-related SFR depending on register OPREG:

Symbol	Address	Instructions		POR
OPINX	FEH	Option pointer	OPINX[7: 0]	00000000b
OPREG	FFH	Option register	OPREG[7: 0]	nnnnnnnb

The OPINX register stores the address of the related OPTION register when operating the Option related SFR, and the OPREG register stores the corresponding value.

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For example: To set ENWDT (OP\_CTM0.7) to 1, the specific operation method is as follows:

C language example:

OPINX = 0xC1; // Write the address of OP\_CTM0 to the OPINX register

OPREG |= 0x80; // Set 1 for OP\_CTM0.7

Assembly language example:

MOV OPINX,#C1H ; Write the address of OP\_CTM0 to the OPINX register

ORL OPREG,#80H ; Set 1 for OP\_CTM0.7

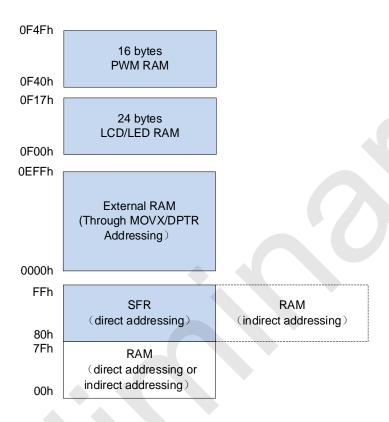
Note: It is forbidden to write any value beyond SFR address of Customer Option region into OPINX register! Or else, it may cause abnormal system operation.

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#### 5.10 SRAM

The SRAM structure of the SC92L753X is as follows:



The SRAM of SC92L753X microcontroller, It is divided into internal 256 bytes RAM, external 3840 bytes RAM, additional 16 bytes PWM duty cycle RAM (address 0F40H~0F4FH), and 24 bytes LCD/LED display RAM (address 0F00H~0F17H). The address range of the internal RAM is 00H to FFH, where high 128 bytes (address 80H to FFH) can only be addressed indirectly, and low 128 bytes (address 00H to 7FH) can be addressed directly or indirectly. Special function register address is 80 h ~ FFH SFR.

However, the SFR differs from the internal high 128 bytes SRAM in that the SFR registers are addressed directly, while the internal high 128 bytes SRAM can only be addressed indirectly.

External RAM address is 0000 H ~ 0EFFH, but need to be addressed through the MOVX instructions.

#### 5.10.1 Internal 256 Bytes SRAM

The internal low 128 bytes SRAM area can be divided into three parts: ① Working register groups 0~3, address 00H~1FH, the combination of RS0 and RS1 in the program state word register PSW determines the current working register, using working register groups 0~3 can speed up the operation speed; ② Bit addressable area 20H~2FH, this area can be used as normal RAM or as bit-addressable RAM; When addressing by bit, the bit address is 00H~7FH, (this address is encoded by bit, different from the general SRAM encoded by byte address), the program can be distinguished by instruction; ③ User RAM and stack area, SC92L753X after reset, the 8-bit stack pointer points to the stack area, initialization program needs to set the initial value of the user.

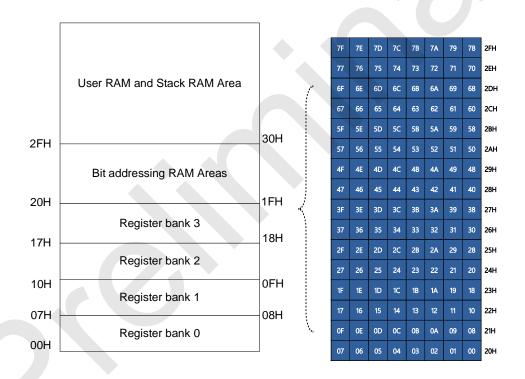
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FFh	SFR	RAM	
80h	(direct addressing)	(indirect addressing)	
7Fh 00h	RAM (direct addressing or indirect addressing)		

Internal 256 bytes RAM structure diagram

The internal low 128 bytes RAM structure is as follows:



SRAM structure diagram

#### 5.10.2 External 3840 bytes SRAM

External 3840 bytes RAM can be accessed through MOVX @DPTR, A; you can also use MOVX A, @Ri or MOVX @Ri, A with EXADH register to access external 3840 bytes RAM: EXADH register stores the high address of external SRAM, Ri register stores the low 8 bits of the external SRAM.

**EXADH (F7H) External SRAM Operation Address High Bit (read/write)** 

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### **Super High-Speed Flash MCU**

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	-	-	-	-		EXADI	H [3: 0]	
POR	х	х	х	х	0	0	0	0

Bit number	Bit Mnemonic	Description
3~0	EXADH [3: 0]	High-bit of external SRAM operation address
7~4	-	reserved

#### 5.10.3 PWM&LCD/LED SRAM

16 bytes of in-chip indirect access RAM, used as PWM duty cycle SFR. The address ranges from 0F40H to 0F4FH. It can be read and written. For details, see 13.3.2 Duty Cycle Configuration in PWM Independent Mode or 13.4.2 Duty cycle Configuration in PWM Complementary Mode.

24 bytes on chip indirect access to RAM, as the LCD/LED display RAM, address is: 0F00H ~ 0F17H, read/write. For details, see 15 LCD/LED Display Driver.

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# 6 Special Function Register (SFR)

# 6.1 SFR Mapping

The SC92L753X provides some registers equipped with special functions, called SFR. The addresses of these registers are located at 80H~FFH, some are bit-addressable, and others are not. It is very convenient for these bit addressable registers to change the value of single bit, of which the address is end up with figure "0" or "8". All SFR shall use direct addressing for addressing.

The SC92L753X SFR Map is as follows:

	0/8	1/9	2/A	3/B	4/C	5/D	6/E	7/F
F8h	-	-	-	BTMCON	CRCINX	CRCREG	OPINX	OPREG
F0h	В	IAPKEY	IAPADL	IAPADH	IAPADE	IAPDAT	IAPCTL	EXADH
E8h	-	EXA0	EXA1	EXA2	EXA3	EXBL	EXBH	OPERCON
E0h	ACC	-	-	-	-	-	-	-
D8h	P5	P5CON	P5PH	P5VO	-	-	-	-
D0h	PSW	PWMCFG	PWMCON0	PWMCON1	PWMPDL	PWMPDH	PWMDFR	PWMFLT
C8h	TXCON	TXMOD	RCAPXL	RCAPXH	TLX	THX	TXINX	WDTCON
C0h	- <		-	-	US2CON0	US2CON1	US2CON2	US2CON3
B8h	IP	IP1	IP2	INT0R	INT1F	INT1R	INT2F	INT2R
B0h	-	-	-	-	INTOF	ADCCFG2	-	LPDCFG
A8h	ΙE	IE1	IE2	ADCCFG0	ADCCFG1	ADCCON	ADCVL	ADCVH
A0h	P2	P2CON	P2PH	P2VO	US1CON0	US1CON1	US1CON2	US1CON3
98h	SCON	SBUF	POCON	P0PH	US0CON0	US0CON1	US0CON2	US0CON3

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### **Super High-Speed Flash MCU**

90h	P1	P1CON	P1PH	P1VO	P0VO	DDRCON	IOHCON0	IOHCON1		
88h	TCON	TMOD	TL0	TL1	TH0	TH1	TMCON	OTCON		
80h	P0	SP	DPL	DPH	-	-	-	PCON		
	Bit addressabl e		Non-bit addressable							

#### Note:

- 1. The empty part of the SFR register are not recommended for users.
- 2. FEH to FFH in the SFR are special function registers used for system configuration. Users may use these registers to cause system exceptions. During system initialization, users cannot clear or perform other operations on these registers.

#### 6.2 SFR Instructions

#### 6.2.1 SFR

SFR specific explanations are as follows:

Mnemonic	Add	Description	7	6	5	4	3	2	1	0	POR
P0	80H	P0 port data register	P07	P06	P05	P04	P03	P02	P01	P00	00000000b
SP	81H	Stack pointer		SP[7: 0]					00000111b		
DPL		DPTR data pointer low		DPL[7: 0]						00000000Ь	
DPH		DPTR data pointer high				D	PH[7: 0]				00000000Ь
PCON	87H	Power management control register	SMOD	-	-	-	RST	-	STOP	IDL	0xxx0x00b
TCON	88H	Timer control register	TF1 TR1 TF0 TR0 IE1 - IE0 -				00000x0xb				
TMOD	89H	Timer operating mode register	-	C/T1	M11	M01	-	С/Т0	M10	M00	x000x000b

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TL0	8AH	Low 8 bits of timer 0				Т	ΓL0[7: 0]				00000000b
TL1	8BH	Low 8 bits of timer 1				Т	ΓL1[7: 0]				00000000ь
тно	8CH	Timer 0 high 8 bits				Т	H0[7: 0]				00000000ь
TH1	8DH	Timer 1 high 8 bits				Т	<sup>-</sup> H1[7: 0]				0000000b
TMCON	8EH	Timer frequency control register	USM	D2[1: 0]	-	-	-	-	T1FD	T0FD	00xxxx00b
OTCON	8FH	Output control register	USM	D1[1: 0]	USMD	USMD0[1: 0]		RS[1: 0]	scs	BIAS	00000000ь
P1	90H	P1 port data register	P17	P16	P15	P14	P13	P12	P11	P10	0000000b
P1CON	91H	P1 port input/output control register	P1C7	P1C6	P1C5	P1C4	P1C3	P1C2	P1C1	P1C0	00000000ь
DDRCON	95H	显示驱动控制寄存器	DDRON DMOD DUTY[1:0] VLCD[3:0]					00000000Ь			
P1VO	93H	P1 口显示驱动输出 寄存器	-	1	P17VO	P16VO	P15VO	P14VO	P13VO	P10VO	xx000000b
P1PH	92H	P1 port pull-up resistor control register	P1H7	P1H6	P1H5	P1H4	P1H3	P1H2	P1H1	P1H0	00000000ь
US0CON0	9CH	USCI0 control register 0				US0	CON0[7: 0]				00000000ь
IOHCON0	96H	IOH setting register 0	P1H	H[1: 0]	P1L	[1: 0]	POI	H[1: 0]	POL	<b>_</b> [1: 0]	00000000ь
IOHCON1	97H	IOH setting register	P5H	H[1: 0]	P5L	[1: 0]	P2I	H[1: 0]	P2l	L[1: 0]	00000000ь
SCON	98H	Serial control register	SM0 SM1 SM2 REN TB8 RB8				TI	RI	00000000ь		
SBUF	99H	Serial data buffer register	SBUF[7: 0]				00000000ь				
P0CON	9AH	P0 port input/output control register	P0C7	P0C6	P0C5	P0C4	P0C3	P0C2	P0C1	P0C0	00000000b
·	l	1			1	ı	1	i	ı		

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# Super High-Speed Flash MCU

P0PH	9BH	P0 port pull-up resistor control register	P0H7	P0H6	P0H5	P0H4	P0H3	P0H2	P0H1	P0H0	00000000Ь
P0VO	94H	P0 port display driver output register	P07VO	P06VO	P05VO	P04VO	P03VO	P02VO	P01VO	P00VO	00000000b
US0CON1	9DH	USCI0 control register 1				US0	CON1[7: 0]				00000000b
US0CON2	9EH	USCI0 control register 2				US0	CON2[7: 0]				00000000Ь
US0CON3	9FH	USCI0 control register 3				US0	CON3[7: 0]				00000000b
P2	АОН	P2 port data register	P27	P26	P25	P24	P23	P22	P21	P20	00000000ь
P2CON	A1H	P2 port input/output control register	P2C7	P2C6	P2C5	P2C4	P2C3	P2C2	P2C1	P2C0	00000000b
P2PH	A2H	P2 port pull-up resistor control register	P2H7	P2H6	P2H5	P2H4	P2H3	P2H2	P2H1	P2H0	00000000ь
P2VO	АЗН	P2 port display driver output register	P27VO	P26VO	P25VO	P24VO	P23VO	P22VO	P21VO	P20VO	00000000b
US1CON0	A4H	USCI1 control register 0				US1	CON0[7: 0]				00000000b
US1CON1	A5H	USCI1 control register 1				US1	CON1[7: 0]				00000000b
US1CON2	A6H	USCI1 control register 2				US1	CON2[7: 0]				0000000b
US1CON3	А7Н	USCI1 control register 3				US1	CON3[7: 0]				00000000b
IE	A8H	Interrupt enable register	EA EADC ET2 EUART ET1 EINT1 ET0 EINT0					00000000b			
IE1	А9Н	Interrupt enable register 1	ET4	ET3	-	-	EINT2	EBTM	EPWM	EUSCI0	00xx0000b
IE2	ААН	Interrupt enable register 2	ELPD	-	-	-	-	-	EUSCI2	EUSCI1	0xxxxx00b
-											

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ADCCFG0	АВН	ADC setting register 0	EAIN7	EAIN6	EAIN5	EAIN4	EAIN3	EAIN2	EAIN1	EAIN0	00000000ь
ADCCFG1	ACH	ADC setting register	-	•	-	-	-	-	EAIN9	EAIN8	xxxxxx00b
ADCCON	ADH	ADC control register	ADCEN	ADCS	EOC/ ADCIF			ADCIS[4: 0]			00000000b
ADCVL	AEH	ADC Conversion Value Register		ADC	CV[3: 0]		-	-			1111xxxxb
ADCVH	AFH	ADC Conversion Value Register				ΑС	DCV[11: 4]				11111111b
INTOF	В4Н	INTO falling edge interrupt control register	-	-	-	-	INT0F3	INT0F2	INT0F1	-	xxxx000xb
ADCCFG2	B5H	ADC setting register 2	-	-	-		LOWSP[2:	0]	-	-	xxx000xxb
LPDCFG	В7Н	LPD Control Register	LPDOF	LPDIF				LPDIS[2:0]		LPDEN	00xx0000b
IP	B8H	Interrupt priority control register	\ <u>.</u>	IPADC	IPT2	IPUART	IPT1	IPINT1	IPT0	IPINT0	х0000000Ь
IP1	В9Н	Interrupt priority control register 1	IPT4	IPT3		-	IPINT2	IPBTM	IPPWM	IPSSI0	00xx00000b
IP2	ВАН	Interrupt priority control register 2	IPLPD		-	-	-	-	IPUSCI2	IPUSCI1	0xxxxx00b
INTOR	ВВН	INTO rising edge interrupt control register		-	-	-	INT0R3	INT0R2	INT0R1	-	xxxx000xb
INT1F	ВСН	INT1 falling edge interrupt control register	-	-	-	-	INT1F3	INT1F2	INT1F1	INT1F0	xxxx0000b
INT1R	BDH	INT1 rising edge interrupt control register	-	-	-	-	INT1R3	INT1R2	INT1R1	INT1R0	xxxx0000b
INT2F	BEH	INT2 falling edge interrupt control register	-	-	INT2F5	INT2F4	INT2F3	INT2F2	INT2F1	INT2F0	xx000000b
<u> </u>	1	1	1								·

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# Super High-Speed Flash MCU

INT2R	BFH	INT2 rising edge interrupt control register	-	-	INT2R5	INT2R4	INT2R3	INT2R2	INT2R1	INT2R0	xx000000b
US2CON0	C4H	USCI2 control register 0				US2	2CON0[7:0]			l	0000000b
US2CON1	C5H	USCI2 control register 1				US2	2CON1[7:0]				00000000Ь
US2CON2	С6Н	USCI2 control register 2				US2	2CON2[7:0]				00000000ь
US2CON3	С7Н	USCI2 control register 3				US2	2CON3[7:0]				0000000b
TXCON	C8H	Timer 2/3/4 control register	TFX	EXFX	RCLKX	TCLKX	EXENX	TRX	С/ТХ	CP/RLX	00000000b
TXMOD	С9Н	Timer 2/3/4 operating mode register	TXFD	-	-			-	TXOE	DCXEN	0xxxxx00b
RCAPXL	САН	Timer 2/3/4 reload low 8 bits				RC	APXL[7: 0]				00000000b
RCAPXH	СВН	Timer 2/3/4 reload high 8 bits				RC	APXH[7: 0]				00000000b
TLX	ССН	Timer 2/3/4 low 8 bits				Т	LX[7: 0]				00000000b
тнх	CDH	Timer 2/3/4 high 8 bits				Т	HX[7: 0]				00000000b
TXINX	CEH	Timer control register pointer	1	1	-	-	-		TXINX[2: 0]		xxxxx010b
WDTCON	CFH	WDT control register	-	-	-	CLRWDT	-	V	/DTCKS[2: 0	)]	xxx0x000b
PSW	DOH	Program status word register	CY	AC	F0	RS1	RS0	OV	F1	Р	00000000ь
PWMCFG	D1H	PWM setting register	er INV7 INV6 INV5 INV4 INV3 INV2 INV1 INV0						00000000Ь		
PWMCON0	D2H	PWM control register0	ENPWM PWMIF PWMCK[1: 0] PWMMD[1:0]					0000xx00b			
PWMCON1	D3H	PWM control register 1	ENPWM 7	ENPWM6	ENPWM5	ENPWM4	ENPWM3	ENPWM2	ENPWM1	ENPWM0	x0000000b

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PWMPDL	D4H	PWM period register low 8 bits				PW	MPDL[7:0]				00000000b
PWMPDH	D5H	PWM period register high 8 bits				PW	MPDH[7:0]				0000000b
PWMDFR	D6H	PWM dead time setting register		PDF	F1[3: 0]			PDR1	1[3: 0]		00000000b
PWMFLT	D7H	PWM fault detection setting register	FLTEN1	FLTSTA1	FLTMD1	FLTLV1	-	-	FLTD	T1[1: 0]	0000xx00b
P5	D8H	P5 port data register	-	-	P55	P54	P53	P52	P51	P50	xx000000b
P5CON	D9H	P5 port input/output control register	-	-	P5C5	P5C4	P5C3	P5C2	P5C1	P5C0	xx000000b
P5PH	DAH	P5 port pull-up resistor control register	P5H5 P5H4 P5H3 P5H2 P5H1 P5H0					xx000000b			
P5VO	DBH	P5 port display driver output register	-	P55VO P54VO P53VO P52VO P11VO P12VO					xx000000b		
ACC	E0H	accumulator				А	CC[7: 0]				00000000Ь
EXA0	E9H	Extended Accumulator 0				E	XA[7: 0]				00000000b
EXA1	EAH	Extended Accumulator 1			>	E.	XA[15: 8]				00000000b
EXA2	ЕВН	Extended Accumulator 2				ΕX	(A[23: 16]				00000000Ь
EXA3	ECH	Extended Accumulator 3				ΕX	(A[31: 24]				00000000b
EXBL	EDH	Extended B register L				E	XB [7: 0]				00000000Ь
EXBH	EEH	Extended B register H	EXB [15: 8]						00000000b		
OPERCON	EFH	Arithmetic control register	OPERS MD CRCRST CRCSTA					00xxxx00b			
В	F0H	B register					B[7: 0]				0000000b

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IAPKEY	F1H	IAP protection register				IAF	PKEY[7: 0]			00000000Ь
IAPADL	F2H	IAP write address low register				IAP	PADR[7: 0]			00000000Ь
IAPADH	F3H	IAP write address high register	-				IAPADR[1	4: 8]		x0000000b
IAPADE	F4H	IAP write to extended address register		1		IAP	ADER[7: 0]			00000000Ь
IAPDAT	F5H	IAP data register		IAPDAT[7: 0]						
IAPCTL	F6H	IAP control register	BTLD	BTLD - SERASE PRG CMD[1: 0]						0x00xx00b
EXADH	F7H	High-bit address of external SRAM operation address	-	-	-			EXADI	H [3: 0]	xxxx0000b
BTMCON	FBH	Low frequency timer control register	ENBTM	BTMIF		-		BTMF	S[3: 0]	00xx0000b
CRCINX	FCH	CRC pointer				CR	CINX[7: 0]			00000000b
CRCREG	FDH	CRC register		CRCREG[7: 0]						nnnnnnnb
OPINX	FEH	Option pointer	OPINX[7: 0]							00000000ь
OPREG	FFH	Option register				OP	REG[7: 0]			nnnnnnnb

# 6.2.2 PWM Duty Cycle Adjustment Register(R/W)

ADD	7	6	5	4	3	2	1	0	POR		
0F40H				PDTO	)[15:8]				00000000ь		
0F41H				PDT	0[7:0]				00000000ь		
0F42H				PDT1	[15:8]				00000000ь		
0F43H				PDT	1[7:0]				00000000ь		
0F44H				PDT2	2[15:8]				00000000Ь		
0F45H		PDT2[7:0]									

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# Super High-Speed Flash MCU

0F46H	PDT3[15:8]	0000000b
0F47H	PDT3[7:0]	00000000ь
0F48H	PDT4[15:8]	0000000b
0F49H	PDT4[7:0]	0000000b
0F4AH	PDT5[15:8]	00000000ь
0F4BH	PDT5[7:0]	00000000ь
0F4CH	PDT6[15:8]	00000000ь
0F4DH	PDT6[7:0]	00000000ь
0F4EH	PDT7[15:8]	00000000ь
0F4FH	PDT7[7:0]	00000000ь

# 6.2.3 LCD/LED display RAM configuration (R/W)

ADD	7	6	5	4	3	2	1	0
	СОМ7	СОМ6	COM5	COM4	сомз	COM2	COM1	СОМО
0F00H	SEG0							
0F01H	SEG1							
0F02H	SEG2							
0F03H	SEG3							
0F04H	SEG4							
0F05H	SEG5							
0F06H	SEG6							
0F07H	SEG7							
0F08H	SEG8							
0F09H	SEG9							
0F0AH	SEG10							
0F0BH	SEG11							
0F0CH	SEG12							
0F0DH	SEG13							

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#### Super High-Speed Flash MCU

ADD	7	6	5	4	3	2	1	0
	СОМ7	COM6	COM5	COM4	COM3	COM2	COM1	СОМО
0F0EH	SEG14							
0F0FH	SEG15							
0F10H	SEG16							
0F11H	SEG17							
0F12H	SEG18							
0F13H	SEG19							
0F14H	SEG20							
0F15H	SEG21							
0F16H	SEG22							
0F17H	SEG23							

### 6.2.4 Introduction of Common Special Function Registers of 8051 Core

#### **Program Counter PC**

The program counter PC does not belong to the SFR register. The PC has 16 bits and is a register used to control the order of execution of instructions. After the MCU is powered on or reset, the PC value is 0000H, which means that the MCU program starts executing the program from the 0000H address.

#### **Accumulator ACC (E0H)**

The accumulator ACC is one of the most commonly used registers of the 8051 core single-chip microcomputer, and A is used as a mnemonic in the instruction set. Commonly used to store operands and results that participate in calculations or logical operations.

#### B Register (F0H)

The B register must be used with the accumulator A in multiplication and division operations. The multiplication instruction MUL A, B multiplies the 8-bit unsigned number in accumulator A and register B. The low-bit byte of the resulting 16-bit product is placed in A, and the high-bit byte is placed in B. The division instruction DIV A, B divides A by B, the integer quotient is placed in A, and the remainder is placed in B. Register B can also be used as a general temporary storage register.

#### Stack Pointer SP (81H)

The stack pointer is an 8-bit special register that indicates the location of the top of the stack in general-purpose RAM. After the Microcontroller unit (MCU) is reset, the initial value of SP is 07H, that is, the stack will increase upward from 08H. 08H~1FH is operating register group 1~3.

#### PSW (D0H) Program Status Word Register (read/write)

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Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	CY	AC	F0	RS1	RS0	OV	F1	Р
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit number	Bit Mnemonic			Description			
7	CY	Flag  1: When there is a carry in the highest bit of addition, or a borrow in the highest bit of subtraction  0: When there is no carry in the highest bit of addition, or there is no borrow in the highest bit of subtraction					
6	AC	Carry auxiliary flag (can be easily adjusted during the addition and subtraction of BCD code)  1: When the addition operation has a carry in bit3, or the subtraction operation has a borrow in bit3  0: No borrowing, carry					
5	F0	User flag					
4~3	RS1,RS0	Operating	register g	Operating register set currently in use 0~3			
		0 0 TEAM 0 (00H~07H)					
		0 1 TEAM 1 (08H~0FH)					
		1	0	TEAM 2 (10H~17H)			

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		1	1	TEAM 3 (18H~1FH)				
2	ov	Overflow t	flag					
1	F1	F1 flag User-defined flag						
0	Р	1: The nu	tor ACC.	bit is the parity value of the number of 1s in the in ACC is odd in ACC is even (including 0)				

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# 7 Power, Reset And System Clock

#### 7.1 Power Circuit

The SC92L753X power supply system includes BG, LDO, POR, LVR and other circuits, which can achieve reliable operation in the range of 1.8~5.5V. In addition, the IC has a built-in, accurate 2.048V, 1.024V and 2.4V voltage that can be used as an internal reference voltage for the ADC. Users can find the specific settings in the 18 analog-to-digital converter (ADC).

#### 7.2 Power-on Reset

After the SC92L753X power-on, the processes carried out before execution of client software are as follows:

- Reset stage
- Loading information stage
- Normal operation stage

#### 7.2.1 Reset Stage

The SC92L753X will always be reset until the voltage supplied to SC92L753X is higher than a certain voltage, and the internal Clock starts to be effective. The duration of reset stage is related to rising speed of external power. Once the external supply voltage is up to built-in POR voltage, the reset stage would be completed.

### 7.2.2 Loading Information Stage

There is a warm-up counter inside The SC92L753X. During the reset stage, the warm-up counter is cleared to 0 until the voltage exceeds the POR voltage, the internal RC oscillator starts to oscillate, and the warm-up counter starts counting. When the internal warm-up counter counts to a certain number, every certain number of HRC clocks will read a byte of data from the IFB (including Code Option) in the Flash ROM and store it in the internal system register. This reset signal will not end until the warm-up is completed.

#### 7.2.3 Normal Operation Stage

After finishing the Loading Information stage, The SC92L753X starts to read the instruction code from Flash and enters the normal operation stage. The LVR voltage is the set value of Code Option written by the user.

#### 7.3 Reset Modes

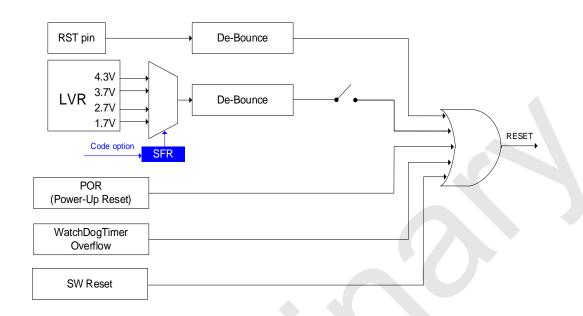
The SC92L753X has 5 reset methods, the first four are hardware reset:

- 1. External reset
- 2. Low-voltage reset LVR
- 3. Power-on reset POR
- 4. Watchdog WDT reset
- Software reset.

The circuit diagram of the reset part of the SC92L753X is as follows:

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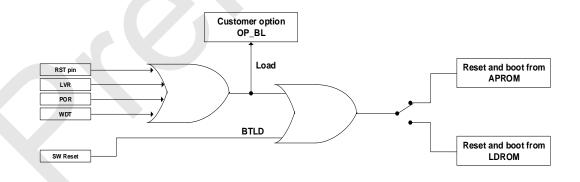


SC92L753X Reset circuit diagram

#### After reset the boot area:

After the external RST reset, low voltage reset LVR, power-on reset POR, watchdog WDT, the chip starts from the boot region (APROM/LDROM) set by the user OP\_BL.

After the software is reset, the chip is started according to the boot region (APROM/LDROM) set by BTLD (IAPCTL.7).



SC92L753X's boot area switch after reset

#### 7.3.1 External Reset

External reset is a reset pulse signal of a certain width given to SC92L753X from external RST pin to realize the reset of SC92L753X. The user can configure the P1.1/RST pin as RST (reset pin) by Code Option.

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#### 7.3.2 Low-voltage Reset LVR

The SC92L753X provides a low-voltage reset circuit. There are 4-level LVR voltage options: 4.3V, 3.7V, 2.7V, 1.7V. The default value is the Option value written by the user. A reset occurs when the VDD voltage is less than the threshold voltage for low-voltage reset and the duration is greater than  $T_{LVR}$ . Among them,  $T_{LVR}$  is the buffeting time of LVR, about 30 $\mu$ s.

#### OP\_CTM0(C1H@FFH) Code Option Register 0 (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	ENWDT	ENXTL	SCLKS[1: 0]		DISRST	DISLVR	LVRS[1: 0]	
R/W	R/W	R/W	R/W		read only	R/W	R/\	W
POR	n	n	n		n	n	n	

Bit number	Bit Mnemonic	Description					
2	DISLVR	LVR enable setting					
		0: LVR valid					
		1: LVR invalid					
1~0	LVRS [1: 0]	LVR voltage threshold selection control					
		11: 4.3V					
		10: 3.7V					
		01: 2.7V					
		00: 1.7V					

#### 7.3.3 Power-on Reset (POR)

The SC92L753X has a power-on reset circuit inside. When the power supply voltage VDD reaches the POR reset voltage, the system automatically resets.

#### 7.3.4 Watchdog Reset (WDT)

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# SC92L7535/7533/7532/7531 Super High-Speed Flash MCU

The SC92L753X has a WDT, the clock source of which is the internal 32.768 kHz LRC. The user can choose whether to enable the watchdog reset function by Code Option.

#### OP\_CTM0 (C1H@FFH) Code Option Register 0 (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	ENWDT	ENXTL	SCLKS[1: 0]		DISRST	DISLVR	LVRS[1: 0]	
R/W	R/W	R/W	R/W		read only	R/W	R/	W
POR	n	n	n		n	n	r	n

Bit number	mber Bit Mnemonic Description					
7	ENWDT	WDT control bit (This bit is transferred by the system to the value set by the user Code Option)				
		1: WDT valid				
		0: WDT invalid				

### WDTCON (CFH) WDT Control Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	-	-	1	CLRWDT	1	WDTCKS[2: 0]		
R/W	-	-	ı	R/W	1	R/W		
POR	х	х	х	0	х	0	0	0

Bit number	Bit Mnemonic	Description
------------	--------------	-------------

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4	CLRWDT	Clear WDT (Only valid when set to 1)  1: WDT counter restart, cleared by system hardware							
2~0	WDTCKS [2: 0]	Watchdog clock selection							
		WDTCKS[2: 0]	WDTCKS[2: 0] WDT overflow time						
		000							
		001							
		010							
		011							
		100							
		101	15.75ms						
		110 7.88ms							
		111 3.94ms							
7~5,3		Reserved							

# 7.3.5 Software Reset

# PCON (87h) Power Management Control Register (write only, \*unreadable\*)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	SMOD	-	-	-	RST	-	STOP	IDL
R/W	write only	-	-	-	Write only	-	Write only	Write only

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POR 0 x x x n x 0	0
-------------------	---

Bit number	Bit Mnemonic	Description
3	RST	Software reset control bit: Write status: 0: The program runs normally; 1: The CPU resets immediately after this bit is written to "1"

### 7.3.6 Register Reset Value

When The SC92L753X is in reset state, most registers will return to their initial state. The watchdog (WDT) is turned off. The initial value of the program counter PC is 0000h, and the initial value of the stack pointer SP is 07h. The "hot restart" Reset (such as WDT, LVR, software reset, etc.) will not affect the SRAM, and the SRAM value is always the value before the reset. The loss of SRAM content will occur when the power supply voltage is so low that the RAM cannot be saved.

The initial values of the power-on reset of the SFR register see 6.2.1 SFR.

# 7.4 High- frequency System Clock Circuit

The SC92L753X has a built-in high-precision high-frequency oscillator (HRC) with adjustable oscillation frequency. The HRC is accurately adjusted to 32 MHz@5V/25°C at the factory. Users can set the system clock to 32/16/8/4 MHz through the Code Option when programming. This HRC will have a certain drift under the influence of the ambient temperature and operating voltage:

- 2.0V ~ 5.5V,-40 ~ 85°C application environment, frequency error does not exceed ±1%
- -40 ~ 105°C application environment, does not exceed ±2%

The HRC can be automatically calibrated by connecting an external 32.768 kHz crystal oscillator. After calibration, HRC precision can be infinitely close to the precision of external 32.768kHz crystal oscillator.

Users only need to connect an external 32.768 kHz crystal oscillator, and set the external 32.768 kHz crystal oscillator function through the Code Opiton when programming. The HRC self-calibration function is automatically turned on after the IC is powered on.

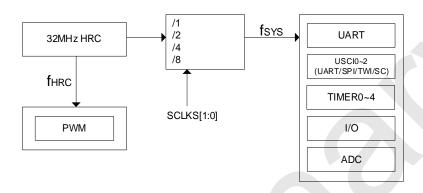
#### Note:

1. The clock source of the PWM is fixed at  $f_{HRC}$  = 32 MHz.

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2. After the external 32.768khz crystal oscillator function is enabled, the HRC self-calibration function will start synchronously. At this point, if the external 32.768khz crystal oscillator is not connected or abnormally connected, the HRC calibration value will have unexpected deviation, resulting in abnormal HRC frequency value.



SC92L753X Internal clock relationship

### OP\_CTM0 (C1H@FFH) Code Option Register 0 (read/write)

Bit number	7	6	5 4	3	2	1	0
Bit Mnemonic	ENWDT	ENXTL	SCLKS[1: 0]	DISRST	DISLVR	LVRS	6[1: 0]
R/W	R/W	R/W	R/W	read only	R/W	R/W	
POR	n	n	n	n	n	n	

Bit number	Bit Mnemonic	Description
5~4	SCLKS[1: 0]	System clock frequency selection bits
		00: System clock frequency is HRC frequency divided by 1;
		01: System clock frequency is HRC frequency divided by 2;
		10: System clock frequency is HRC frequency divided by 4;

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### **Super High-Speed Flash MCU**

	11: System clock frequency is HRC frequency divided by 8;

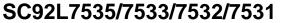
Note: The SC92L753X has a special function: the user can modify the value of SFR to adjust the HRC frequency within a certain range. The user can achieve this by configuring the OP\_HRCR register. Note: HRC can be automatically calibrated by connecting a 32.768 kHz crystal oscillator. Therefore, if the user uses the 32.768 kHz external crystal oscillator function, the HRC frequency will always be corrected to 32 MHz. At this time, adjusting OP\_HRCR cannot change the HRC frequency.

### OP\_HRCR (83h@FFH) System Clock Change Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic		OP_HRCR[7: 0]						
R/W		R/W						
POR	n	n	n	n	n	n	n	n

Bit number	Bit Mnemonic		Description		
7~0	OP_HRCR[7: 0]	HRC frequency change	register		
			high-frequency oscillator frequency fhac by s register, and then change the system clock		
		The initial value of OP_HRCR[7: 0] after power-on OP_HRCR[s] is a fixed value to ensure that f <sub>HRC</sub> is 32 MHz, OP_HRCR[s] of each IC may be different			
		When the initial value is OP_HRCR[s], the system clock frequency fsys of the IC can be set to an accurate 32/16/8/4 MHz through the Option item. When OP_HRCR [7: 0] changes by 1, the fsys frequency changes by about 0.18%			
		The relationship between OP_HRCR [7: 0] and Fsys output frequency is as follows:			
		OP_HRCR [7: 0] value	fsys actual output frequency (32M as an example)		

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OP_HRCR [s]-n	32000*(1-0.18%*n) kHz
OP_HRCR [s]-2	32000*(1-0.18%*2) = 31 884.8 kHz
OP_HRCR [s]-1	32000*(1-0.18%*1) = 31 942.4 kHz
OP_HRCR [s]	32000 kHz
OP_HRCR [s]+1	32000*(1+0.18%*1) = 32 057.6 kHz
OP_HRCR [s]+2	32000*(1+0.18%*2) = 32 115.2 kHz
OP_HRCR [s]+n	32000*(1+0.18%*n) kHz

### Note:

- The OP\_HRCR[7:0] value of IC after each power-on is the value of the high-frequency oscillator frequency Fhrc closest to 32MHz; The user can modify the HRC value after each power-on so that the IC's system clock frequency, Fsys, works at the user's desired frequency
- 2. In order to ensure the reliable operation of the IC, the maximum operating frequency of the IC should not exceed 10% of 32 MHz, that is 35.2 MHz;
- 3. Please confirm that the change of HRC frequency will not affect other functions.

# 7.5 Low- frequency RC Oscillator and Low- frequency Clock Timer

The SC92L753X built-in a 32.768 kHz RC and 32.768 kHz crystal oscillator circuit, can be used as the Base Timer clock. source. SC92L753X, which The oscillator is directly connected to a Base Timer, which can wake the CPU from STOP mode and generate an interrupt.

BTMCON (FBH) Low-frequency Timer Control Register (read/write)

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Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	ENBTM	BTMIF	-	-	BTMFS[3: 0]			
R/W	R/W	R/W	-	-	R/W			
POR	0	0	х	х	0	0	0	0

Bit number	Bit Mnemonic	Description
7	ENBTM	Low frequency Base Timer start control  0: Base Timer and its clock source do not start
		1: Base Timer and its clock source start
6	BTMIF	Base Timer interrupt application flag
		When the CPU accepts the Base Timer interrupt, this flag will be automatically cleared by hardware.
3~0	BTMFS [3: 0]	Low frequency clock interrupt frequency selection
		0000: An interrupt is generated every 15.625ms
		0001: An interrupt is generated every 31.25ms
		0010: An interrupt is generated every 62.5ms
		0011: An interrupt is generated every 125ms
		0100: An interrupt is generated every 0.25 seconds
		0101: An interrupt is generated every 0.5 seconds
		0110: An interrupt is generated every 1.0 seconds
		0111: An interrupt is generated every 2.0 seconds
		1000: An interrupt is generated every 4.0ms
		1001: An interrupt is generated every 8.0 seconds

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-	5~4	-	reserved	_
			1011: An interrupt is generated every 32.0 seconds	
			1010: An interrupt is generated every 16.0 seconds	

### OP\_CTM0 (C1H@FFH) Code Option Register 0 (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	ENWDT	ENXTL	SCLK	SCLKS[1: 0]		DISLVR	LVRS[1: 0]	
R/W	R/W	R/W	R/	R/W		read only	R/W	
POR	n	n	r	n		n	r	1

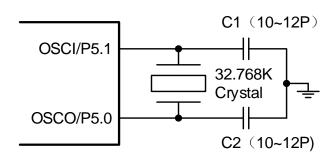
Bit number	Bit Mnemonic	Description					
6	ENXTL	External 32.768kHz crystal selector switch					
		0: The external 32.768kHz crystal is off, P5.0 and P5.1 are valid, and the internal LRC is valid;					
		1: The external 32.768kHz crystal is turned on, P5.0 and P5.1 are invalid, and the internal LRC is invalid.					

Note: HRC can be automatically calibrated by connecting a 32.768 kHz crystal oscillator. Therefore, if the user uses the 32.768 kHz external crystal oscillator function, the HRC frequency will always be corrected to 32 MHz. At this time, adjusting OP\_HRCR cannot change the HRC frequency.

The connection circuit used by P5.0/P5.1 external 32.768kHz oscillator as BaseTimer is as follows:

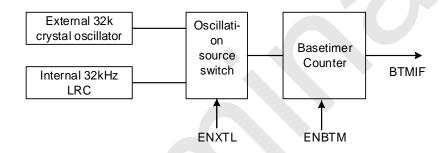
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32.768kHz external crystal connection diagram

The internal and external oscillation selection relationship of Base Timer is as follows:



Base Timer Structure diagram

### 7.6 STOP Mode and IDLE Mode

The SC92L753X supports two different software selectable power-reducing modes: IDLE and STOP. These modes are accessed through the PCON register.

Write 1 to pcon. 1, the internal high frequency system clock will STOP, into the STOP mode, to achieve power saving function. In STOP mode, the user can wake up SC92L753X by external interrupt INT0~INT2, low-frequency clock interrupt and WDT, or by external reset STOP.

Setting the PCON.0 bit enters IDLE mode. In IDLE mode the program stops running and all CPU states are saved before entering IDLE mode. IDLE mode can be woken up by any interrupt.

#### PCON (87H) Power Management Control Register (read/write) (write only, \*not readable\*)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	SMOD	-	-	-	RST	-	STOP	IDL

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## **Super High-Speed Flash MCU**

R/W	Write only	-	-	-	Write only	-	Write only	Write only
POR	0	х	х	х	n	х	0	0

Bit number	Bit Mnemonic	Description
1	STOP	STOP mode bit. Setting this bit activates STOP mode operation.
0	IDL	IDLE mode bit. Setting this bit activates IDLE mode operation.

Notes: When Configuring MCU to enter STOP or IDLE mode, the instruction of configuring PCON register should be followed by 8 "NOP" instructions rather than other instructions. Or else, it will be unable to execute following instructions normally after wake-up!

For example: set MCU to enter STOP mode:

Example in C Language

#include"intrins.h"

PCON |= 0x02; // PCON bit1 STOP bit write 1, configure the MCU to enter STOP mode

\_nop\_(); // At least 8 \_nop\_() are required

\_nop\_();

\_nop\_();

\_nop\_();

\_nop\_();

\_nop\_();

\_nop\_();

\_nop\_();

. . . . . .

Assembly Language:

ORL PCON,#02H ; PCON bit1 STOP bit write 1, configure the MCU to enter STOP mode



## Super High-Speed Flash MCU

NOP	; At least 8 NOPs are requiredNOP
NOP	

### **7.7 LPD**

. . . . . .

A low voltage monitoring circuit (LPD) is built into the SC92L753X to monitor the supply voltage VDD and compare it with the LPD threshold voltage VLPD threshold.

When the VDD voltage value dropped to below VLPD or when the VDD voltage value, rise to above VLPD LPD status flag bit LPDOF will have corresponding change. If LPD interrupt is enabled, LPD interrupt occurs. LPDIF must be cleared by the software.

SC92L753X LPD of threshold voltage:  $1.85\ V\ /\ 2.05\ V\ /\ 2.25\ V\ /\ 2.45\ V\ /\ 2.85\ V\ /\ 3.45\ V\ /\ 3.85\ V\ /\ 4.45\ V$ , a total of eight gears. Users can read LPD status, obtain LPD interrupt flag, and configure LPD threshold voltage tap through the LPDCFG register.

### IE2 (AAH) Interrupt Enable Register 2 (read/write)

Bit number	7	6	5	4	3	2	1	0
Symbol	ELPD	-		-	-	-	EUSCI2	EUSCI1
Read/ Write	R/W		-	-	-	-	R/W	R/W
Initial power-on value	0	х	х	х	х	х	0	0

Bit number	Bit Mnemonic	Description
7	ELPD	Low voltage monitoring module interrupt enable control
		0: Turn off low voltage monitoring interrupts
		1: Allows low voltage monitoring interruption

### IP2 (BAH) Interrupt priority control register 2 (read/write)

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Bit number	7	6	5	4	3	2	1	0
Symbol	IPLPD	-	-	-	-	-	IPUSCI2	IPUSCI1
Read/ Write	R/W	-	-	-	-	-	R/W	R/W
Initial power-on value	0	х	х	х	х	х	0	0

Bit number	Bit Mnemonic	Description
7	IPLPD	Low voltage monitoring module interrupt priority
		0: low voltage monitoring interrupt priority for
		1: low voltage monitoring interrupt priority is high

LPDCFG(B7H) LPD control register (read/write)

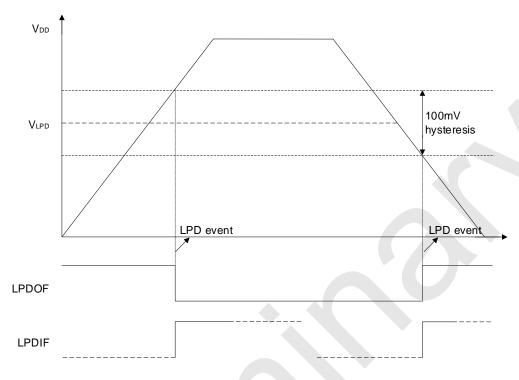
Bit number	7	6	5	4	3	2	1	0
Symbol	LPDOF	LPDIF	-	-		LPDIS[2:0]		LPDEN
Read/	R	R/W	-	-	R/W	R/W	R/W	R/W
Write Initial power-on	0	0	Х	х	0	0	0	0
value								

Bit number	Bit Mnemonic	Description						
7	LPDOF	LPD status flag bit						
		0: VDD voltage above LPD threshold (reset by hardware)						
		1: VDD below LPD threshold voltage (set by hardware)						
6	LPDIF	LPD interrupt request flag. When an interruption occurs, the hardware						
		sets LPDIF to 1 to request an interruption. This interrupt flag requires						
		software to clear "0"						
3~1	LPDIS[2:0]	LPD threshold voltage tap selection, VLPD is LPD threshold voltage						
		threshold:						
		000: $V_{LPD} = 1.85V \text{ typ.}$						
		001: $V_{LPD} = 2.05V$ typ.						
		010: $V_{LPD} = 2.25V$ typ.						
		011: $V_{LPD} = 2.45V$ typ.						
		100: V <sub>LPD</sub> = 2.85V typ.						
		101: $V_{LPD} = 3.45V$ typ.						
		110: V <sub>LPD</sub> = 3.85V typ.						
		111: V <sub>LPD</sub> = 4.45V typ.						
0	LPDEN	Power on the LPD						
		0: Power off the LPD module						
		1: Power on the LPD module						

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The LPD threshold is shown as follows:



LPD threshold

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## 8 CPU and Instruction Set

### 8.1 CPU

The SC92L753X is built around an enhanced super-high-speed 1T 8051 core, and its instructions are fully compatible with classic 8051 core.

## 8.2 Addressing Mode

The addressing modes of 1T 8051 CPU instructions of the SC92L753X are: ①Immediate Addressing ② Direct Addressing ③ Indirect Addressing ④ Register Addressing ⑤ Relative Addressing ⑥ Indexed Addressing ⑦ Bit Addressing.

### 8.2.1 Immediate Addressing

Immediate addressing is also called immediate data addressing. It directly gives the operands participating in the operation in the instruction operand. Examples of instructions are as follows:

MOV A, #50H (This instruction moves the immediate value 50H to accumulator A)

### 8.2.2 Direct Addressing

In direct addressing mode, the instruction operand field gives the address of the operand to participate in the operation. The direct addressing mode can only be used to represent special function registers, internal data registers, and bit address spaces. The special function registers and bit address spaces can only be accessed by direct addressing.

Examples are as follows:

ANL 50H, #91H

(indicating that the number in the 50H unit is ANDed with the immediate 91H, and the result is stored in the 50H unit. 50H is direct address, representing a unit in the internal data register RAM.)

### 8.2.3 Indirect Addressing

Indirect addressing is indicated by adding the "@" symbol before R0 or R1. Assuming that the data in R1 is 40H, and the data in the internal data memory 40H unit is 55H, the instruction is

MOV A, @R1 (Move data 55H to accumulator A).

#### 8.2.4 Register Addressing

When register addressing, operate on the selected operating registers R7~R0, accumulator A, general register B, address register and carry C. Registers R7~R0 are represented by the low three bits of the instruction code, and ACC, B, DPTR and carry bit C are implicitly contained in the instruction code. Therefore, register addressing also includes an implicit addressing method. The selection of the register operating area is determined by RS1 and RS0 in the program status word register PSW. The register specified by the instruction operand refers to the register in the current operating area.

INC R0 Refers to(R0)+1→R0

### 8.2.5 Relative Addressing

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Relative addressing is to add the current value in the program counter PC to the number given by the second byte of the instruction, and the result is used as the branch address of the branch instruction. The branch address also becomes the branch destination address, the current value in the PC becomes the base address, and the number given by the second byte of the instruction becomes the offset. Since the destination address is relative to the base address in the PC, this addressing method becomes relative addressing. The offset is a signed number, and the range that can be expressed is -128~+127. This addressing method is mainly used for branch instructions.

JC \$+50H

It means that if the carry bit C is 0, the content in the program counter PC does not change, that is, it does not transfer. If the carry bit C is 1, the current value as base address in the PC plus the offset 50H will be used as the destination address of the branch instruction.

### 8.2.6 Indexed Addressing

In the indexed addressing mode, the instruction operand specifies an index register that stores the index base address. In indexed addressing, the offset is added to the index base value, and the result is used as the address of the operand. The index registers are the program counter PC and the address register DPTR.

MOVC A, @A+DPTR

It indicates that the accumulator A is an offset register, and its content is added to the content of the address register DPTR. The result is used as the address of the operand, and the number in this unit is taken out and sent to the accumulator A.

### 8.2.7 Bits Addressing

Bit addressing refers to the addressing mode when performing bit operations on some internal data memory RAMs and special function registers that can perform bit operations. When performing bit operations, with the help of carry bit C as a bit operation accumulator, the instruction operand directly gives the address of the bit, and then performs bit operation on the bit according to the nature of the opcode. The bit address is exactly the same as the byte address encoding method in direct byte addressing, which is mainly distinguished by the nature of the operation instruction, and special attention should be paid when using it.

MOV C, 20H (The value of the bit manipulation register with address 20H is sent to carry bit C)

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# 9 Interrupts

SC92L753X provides 16 interrupt sources: TIMER 0~4, INT0~2, ADC, PWM, UART, USCI0~2, BASE TIMER, LPD. The 16 interrupt sources are divided into two interrupt priorities and can be set to either high or low priority separately. Three external interrupts can be set as up, down or both trigger conditions for each interrupt source respectively. Each interrupt has its own priority setting bit, interrupt flag, interrupt vector and enable bit respectively. The total enable bit EA can open or close all interrupts.

## 9.1 Interrupt Source and Vector

The list of the SC92L753X interrupt sources, interrupt vectors, and related control bits are as follows:

Interrupt Source	Interrupt condition	Interrupt Flag	Interrupt Enable Control	Interrupt Priority Control	Interrupt Vector	Query Priority	Interrupt Number (C51)	Flag Clear Mode	Capability of Waking up STOP
INTO	External interrupt 0 conditions are met	IE0	EINTO	IPINT0	0003H	1 (HIGH)	0	H/W Auto	YES
Timer 0	Timer 0 overflow	TF0	ET0	IPT0	000BH	2	1	H/W Auto	NO
INT1	External interrupt 1 conditions are met	IE1	EINT1	IPINT1	0013H	3	2	H/W Auto	YES
Timer 1	Timer 1 overflow	TF1	ET1	IPT1	001BH	4	3	H/W Auto	NO
UART	Receive or send completed	RI/TI	EUART	IPUART	0023H	5	4	Must user Clear	NO
Timer 2	Timer 2 overflow	TFX	ET2	IPT2	002BH	6	5	Must user Clear	NO
ADC	ADC conversio n completed	ADCIF	EADC	IPADC	0033H	7	6	Must user Clear	NO

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USCI0	Receive or send completed	SPIF0/TWI F0	EUSCI0	IPSPI	003BH	8	7	Must user Clear	NO
PWM	PWM overflow	PWMIF	EPWM	IPPWM	0043H	9	8	Must user Clear	NO
ВТМ	Base timer overflow	BTMIF	EBTM	IPBTM	004BH	10	9	H/W Auto	YES
INT2	External interrupt 2 conditions are met	-	EINT2	IPINT2	0053H	11	10	-	YES
Timer 3	Timer 3 overflow	TFX	ET3	IPT3	006BH	14	13	Must user Clear	NO
Timer 4	Timer 4 overflow	TFX	ET4	IPT4	0073H	15	14	Must user Clear	NO
USCI1	Receive or send completed	SPIF1/TWI F1	EUSCI1	IPSPI1	007BH	16	15	Must user Clear	NO
USCI2	Receive or send completed	SPIF2/TWI F2	EUSCI2	IPSPI2	0083H	17	16	Must user Clear	NO
LPD	Low voltage monitoring is interrupte d	LPDIF	ELPD	IPLPD	00B3H	18	22	Must user Clear	NO

Under the circumstance where the master interrupt control bit EA and the respective interrupt control bit have been enable, the interrupt occurrence is shown below:

**Timer Interrupt:** Interrupt generates when Timer 0 or Timer 1 overflows and the interrupt flag TF0 or TF1 is set to "1". When the microcontroller unit responds to the timer interrupt, the interrupt flag TF0 or TF1 is reset automatically by hardware. Interrupt generates when Timer 2 overflows and the interrupt flag TF2 is set to "1". Once Timer 2 interrupt generates, the hardware would not automatically clear TF2 bit, which must be cleared by the user's software.

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**UART Interrupt:** When UART0 completes receiving or transmitting a frame of data, bit RI or TI will be set to "1" automatically by hardware, and UART interrupt occurs. Once UART interrupt occurs, the hardware would not automatically clear up RI/TI bit, which shall be cleared by user's software.

**ADC Interrupt:** After ADC conversion is completed, ADC interrupt generates, whose interrupt flag is the ADC conversion completion flag EOC/ADCIF (ADCCON.5). When user starts ADCS conversion, EOC will be reset automatically by hardware. Once conversion completes, EOC would be set to "1" automatically by hardware. User should clear the ADC interrupt flag by software when the interrupt service routine is executed after ADC interrupt generates.

**SSI Interrupt:** When SSI completes receiving or transmitting a frame of data, SPIF/TWIF bit will be set to "1" automatically by hardware, and SSI interrupt generates. When the microcontroller unit serves SSI interrupt, the interrupt flag SPIF/TWIF must be cleared by software.

**PWM Interrupt:** When PWM counter overflows (beyond PWMPD), the flag will be set as 1 automatically by hardware. Meanwhile, if the PWM interrupt control bit IE1[1] (EPWM) is set as 1, PWM interrupt will occurs. Once PWM interrupt occurs, the hardware would not clear the interrupt flag automatically, which shall be cleared by user's software.

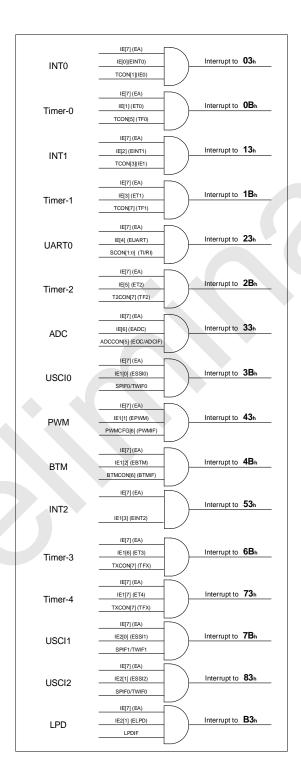
**External Interrupt INT0 ~ 2:** An external interrupt occurs when an external interrupt condition occurs at an external intermediate fracture. The interrupt flags of INT0 and INT1 are IE0/IE1. Users do not need to handle these flags, but the hardware automatically clears them. INT0 has three external interrupt sources, INT1 has four external interrupt sources, INT2 has six external interrupt sources, users can be as required to set the top edge, bottom edge, or double edge interrupt, by setting SFR (INTxF and INTxR) to achieve. The user can set the priority level of each interrupt through the IP register. External interrupt INT0~2 can also wake up the MCU STOP.

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# 9.2 Interrupt Structure Diagram

The interrupt structure of SC92L753X is shown below:



SC92L753X Interrupt structure and vector

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## 9.3 Interrupt Priority

Each interrupt source can be individually programmed to one of two priority levels by setting or clearing bits in the interrupt priority registers: IP, IP0, IP1. An interrupt service routine in progress can be interrupted by a higher priority interrupt. The highest priority interrupt cannot be interrupted by any other interrupt source. If two requests of different priority levels are pending at the end of an instruction, the request of higher priority level is serviced. If requests of the same priority level are pending at the end of an instruction, an internal polling sequence determines which request is serviced. The polling sequence is based on the vector address; an interrupt with a lower vector address has higher priority than an interrupt with a higher vector address.

## 9.4 Interrupt Processing Flow

When an interrupt is generated and responded by the CPU, the main program execution is interrupted and the following operations will be performed:

- (1) The currently executing instruction is finished;
- 2 The PC value is pushed into the stack to protect the scene;
- The interrupt vector address is loaded into the program counter PC;
- 4 Execute the corresponding interrupt service program;
- (5) The interrupt service routine ends and RETI;
- 6 Unstack the PC value and return to the program before the interruption.

In this process, the system will not immediately execute other interrupts of the same priority, but will retain the interrupt request that has occurred, and after the current interrupt processing is completed, go to execute a new interrupt request.

# 9.5 Interrupt-related SFR Registers

#### IE (A8H) Interrupt Enable Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	EA	EADC	ET2	EUART	ET1	EINT1	ET0	EINT0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit number	Bit Mnemonic	Description
------------	--------------	-------------

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	T	
7	EA	Interrupt enable total control  0: Close all interrupts  1: Enable all interrupts
6	EADC	ADC interrupt enable control  0: Disable ADC interrupt  1: Allow the ADC to generate an interrupt when the conversion is complete
5	ET2	Timer 2 interrupt enable control  0: Disable Timer 2 interrupt  1: Enable Timer 2 interrupt
4	EUART	UART interrupt enable control  0: Disable UART interrupt  1: Allow UART interrupt
3	ET1	Timer 1 interrupt enable control  0: Disable Timer  1 interrupt1: Enable Timer 1 interrupt
2	EINT1	External interrupt 1 enable control  0: close INT1 interrupt  1: Enable INT1 interrupt
1	ET0	Timer 0 interrupt enable control  0: Disable TIMER0 interrupt  1: Enable TIMER0 interrupt
0	EINT0	External interrupt 0 enable control  0: close INT0 interrupt

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	1: Enable INT0 interrupt

### IP (B8H) Interrupt Priority Control Register (Read/Write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	•	IPADC	IPT2	IPUART	IPT1	IPINT1	IPT0	IPINT0
R/W	-	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	х	0	0	0	0	0	0	0

Bit number	Bit Mnemonic	Description
6	IPADC	ADC interrupt priority selection  0: ADC interrupt priority is low  1: ADC interrupt priority is high
5	IPT2	Timer 2 interrupt priority selection  0: Timer 2 interrupt priority is low  1: Timer 2 interrupt priority is high
4	IPUART	UART interrupt priority selection  0: UART interrupt priority is low  1: UART interrupt priority is high
3	IPT1	Timer 1 interrupt priority selection  0: Timer 1 interrupt priority is low  1: Timer 1 interrupt priority is high

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2	IPINT1	INT1 counter interrupt priority selection  0: INT1 interrupt priority is low  1: INT1 interrupt priority is high
1	IPT0	Timer 0 interrupt priority selection  0: Timer 0 interrupt priority is low  1: Timer 0 interrupt priority is high
0	IPINT0	INTO counter interrupt priority selection  0: INTO interrupt priority is low  1: INTO interrupt priority is high
7	-	Reserved

## IE1 (A9H) Interrupt Enable Register 1 (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	ET4	ЕТ3		-	EINT2	EBTM	EPWM	EUSCI0
R/W	R/W	R/W	-	-	R/W	R/W	R/W	R/W
POR	0	0	х	х	0	0	0	0

Bit number	Bit Mnemonic	Description
7	ET4	Timer 4 interrupt enable control  0: Disable Timer 4 interrupt  1: Enable Timer 4 interrupt

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6	ЕТ3	Timer 3 interrupt enable control  0: Disable Timer 3 interrupt  1: Enable Timer 3 interrupt
3	EINT2	External interrupt 2 enable control  0: close INT2 interrupt  1: Open INT2 interrupt
2	EBTM	Base Timer interrupt enable control  0: Disable Base Timer interrupt  1: Enable Base Timer interrupt
1	EPWM	PWM interrupt enable control  0: Disable PWM interrupt  1: Enable interrupt when PWM count overflows
0	EUSCI0	Three-in-one serial port USCI0 interrupt enable control  0: Disable serial port interrupt  1: Allow serial port interrupt
5,4	-	Reserved

## IP1 (B9H) Interrupt Priority Control Register 1 (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	IPT4	IPT3	-	-	IPINT2	IPBTM	IPPWM	IPUSCI0
R/W	R/W	R/W	-	-	R/W	R/W	R/W	R/W
POR	0	0	х	х	0	0	0	0

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Bit number	Bit Mnemonic	Description
7	IPT4	Timer 4 interrupt priority selection  0: Timer 4 interrupt priority is low  1: Timer 4 interrupt priority is high
6	IPT3	Timer 3 interrupt priority selection  0: Timer 3 interrupt priority is low  1: Timer 3 interrupt priority is high
3	IPINT2	INT2 counter interrupt priority selection  0: INT2 interrupt priority is low  1: INT2 interrupt priority is high
2	IPBTM	Base Timer interrupt priority selection  0: Base Timer interrupt priority is low  1: Base Timer interrupt priority is high
1	IPPWM	PWM interrupt enable selection  0: PWM interrupt priority is low  1: PWM interrupt priority is high
0	IPUSCI0	Three-in-one serial port USCI0 interrupt priority selection  0: USCI0 interrupt priority is low  1: USCI0 interrupt priority is high
5,4	-	Reserved

IE2 (AAH) Interrupt Enable Register 2 (read/write)

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Bit number	7	6	5	4	3	2	1	0
Symbol	ELPD	-	-	-	-	-	EUSCI2	EUSCI1
Read/ Write	R/W	-	-	-	-	-	R/W	R/W
Initial power-on value	0	Х	х	х	х	х	0	0

Bit number	Bit Mnemonic	Description
1	EUSCI2	Three-in-one serial port USCI2 interrupt enable control
		0: Disable serial port interrupt
		1: Allow serial port interrupt
0	EUSCI1	Three-in-one serial port USCI1 interrupt enable control
		0: Disable serial port interrupt
		1: Allow serial port interrupt
7~2		Reserved

# IP2 (BAH) Interrupt Priority Control Register 2 (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	IPLPD	-	-	-	-	-	IPUSCI2	IPUSCI1
R/W	R/W	-	-	-	-	-	R/W	R/W
POR	0	х	х	х	х	х	0	0

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Bit number	Bit Mnemonic	Description
1	IPUSCI2	Three-in-one serial port USCI2 interrupt priority selection  0: USCI2 interrupt priority is low  1: USCI2 interrupt priority is high
0	IPUSCI1	Three-in-one serial port USCI1 interrupt priority selection  0: USCI1 interrupt priority is low  1: USCI1 interrupt priority is high
7~2	-	Reserved

## TCON (88H) Timer Control Register (read/write)

Bit number	7	6	.5	4	3	2	1	0
Bit Mnemonic	TF1	TR1	TF0	TR0	IE1	-	IE0	-
R/W	R/W	R/W	R/W	R/W	R/W	-	R/W	-
POR	0	0	0	0	0	х	0	Х

Bit number	Bit Mnemonic	Description
3	IE1	INT1 overflow interrupt request flag. INT1 generates an overflow. When an interrupt occurs, the hardware sets IE1 to "1" and applies for an interrupt. When the CPU responds, the hardware clears "0".
1	IE0	INTO overflow interrupt request flag. INTO generates an overflow. When an interrupt occurs, the hardware sets IEO to "1" and applies for an interrupt. When the CPU responds, the hardware clears "0".

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2,0	Reserved
-----	----------

### INT0F (B4H) INT0 Falling Edge Interrupt Control Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	-	-	-	-	INT0F3	INT0F2	INT0F1	
R/W	-	-	-	-	R/W	R/W	R/W	-
POR	х	х	х	х	0	0	0	х

Bit number	Bit Mnemonic	Description
3~1	INT0Fn (n=3~1)	INT0 falling edge interrupt control  0: INT0n falling edge interrupt close  1: INT0n falling edge interrupt enable
7~4,0	-	Reserved

## INTOR (BBH) INTO Rising Edge Interrupt Control Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	_	-	-	-	INT0R3	INT0R2	INT0R1	-
R/W	-	-	-	-	R/W	R/W	R/W	-
POR	х	х	х	х	0	0	0	х

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Bit number	Bit Mnemonic	Description
3~1	INT0Rn (n=3~1)	INT0 rising edge interrupt control  0: INT0n rising edge interrupt close  1: INT0n rising edge interrupt enable
7~4,0	-	Reserved

# INT1F (BCH) INT1 Falling Edge Interrupt Control Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	-	-	-		INT1F3	INT1F2	INT1F1	INT1F0
R/W	-	-	-		R/W	R/W	R/W	R/W
POR	х	x	x	х	0	0	0	0

Bit number	Bit Mnemonic	Description
3~0	INT1Fn (n=3~0)	INT1 falling edge interrupt control  0: INT1n falling edge interrupt close  1: INT1n falling edge interrupt enable
7~4	-	Reserved

### INT1R (BDH) INT1 Rising Edge Interrupt Control Register (read/write)

Bit number 7 6 5 4 3 2 1
--------------------------

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Bit Mnemonic	-	-	-	-	INT1R3 INT1R2 I		INT1R1	INT1R0
R/W	-	-	-	-	R/W	R/W R/W R/W		R/W
POR	х	х	х	х	0 0		0	0

Bit number	Bit Mnemonic	Description
3~0	INT1Rn (n=3~0)	INT1 rising edge interrupt control  0: INT1n rising edge interrupt off  1: INT1n rising edge interrupt enable
7~4	-	Reserved

## INT2F (BEH) INT2 Falling Edge Interrupt Control Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	-		INT2F5	INT2F4	INT2F3	INT2F2	INT2F1	INT2F0
R/W	-		R/W	R/W	R/W	R/W	R/W	R/W
POR	x	х	0	0	0	0	0	0

Bit number	Bit Mnemonic	Description
5~0	INT2Fn (n=5~0)	INT2 falling edge interrupt control  0: INT2n falling edge interrupt close

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		1: INT2n falling edge interrupt enable
7~6	-	Reserved

### INT2R (BFH) INT2 Rising Edge Interrupt Control Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	-	-	INT2R5	INT2R4	INT2R3	INT2R2	INT2R1	INT2R0
R/W	-	-	R/W	R/W	R/W	R/W	R/W	R/W
POR	х	х	0	0	0	0	0	0

Bit number	Bit Mnemonic	Description
5~0	INT2Rn	INT2 rising edge interrupt control
	(n=5~0)	0: INT2n rising edge interrupt close
		1: INT2n rising edge interrupt enable
7~6		Reserved

# 10 Timer/Counter T0 and T1

Timer 0 and Timer 1 inside the SC92L753X MCU are two 16-bit timers/counters. They have two operating modes: counting mode and timing mode. There is a control bit C/Tx in the special function register TMOD to select whether T0 and T1 are timers or counters. They are essentially an addition counter, but the source of the count is different. The source of the timer is the system clock or its divided clock, but the source of the counter is the input pulse of the external pin. Only when TRx=1, T0 and T1 will be opened to count.

In counter mode, for each pulse on the P1.2/T0 and P1.3/T1 pins, the count value of T0 and T1 increases by 1, respectively.

In the timer mode, the count source of T0 and T1 can be selected as fsys/12 or fsys through the special function register TMCON (fsys is the divided system clock).

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There are 4 operating modes for timer/counter T0, and 3 operating modes for timer/counter T1 (mode 3 does not exist):

① Mode 0: 13-bit timer/counter mode

2) Mode 1: 16-bit timer/counter mode

(3) Mode 2: 8-bit auto-reload mode

(4) Mode 3: Two 8-bit timer/counter modes

In the above modes, modes 0, 1, and 2 of T0 and T1 are the same, and mode 3 is different.

# 10.1 T0 and T1-related Registers

Symbol	Address	Description	7	6	5	4	3	2	1	0	POR
TCON	88H	Timer control register	TF1	TR1	TF0	TR0	IE1	-	IE0	-	00000x0xb
TMOD	89H	Timer operating mode register	1	C/T1	M11	M01	-	C/T0	M10	M00	x000x000b
TL0	8AH	Low 8 bits of timer 0				TL	.0[7: 0]				00000000b
TL1	8BH	Low 8 bits of timer 1				TL	.1[7: 0]				0000000b
TH0	8CH	Timer 0 high 8 bits		TH0[7: 0]			0000000b				
TH1	8DH	Timer 1 high 8 bits		TH1[7: 0]			0000000b				
TMCON	8EH	Timer frequency control register		1D2[1: 0]	-	-	-	-	T1FD	T0FD	00xxxx00b

The explanation of each register is as follows:

### TCON (88H) Timer Control Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	TF1	TR1	TF0	TR0	IE1	-	IE0	-

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R/W	R/W	R/W	R/W	R/W	R/W	-	R/W	-	
POR	0	0	0	0	0	х	0	х	

Bit number	Bit Mnemonic	Description
7	TF1	T1 overflow interrupt request flag. T1 generates an overflow. When an interrupt occurs, the hardware sets TF1 to "1" and applies for an interrupt. When the CPU responds, the hardware clears "0".
6	TR1	Operation control bit of timer T1. This bit is set and cleared by software. When TR1=1, T1 is allowed to start counting. When TR1=0, T1 counting is prohibited.
5	TF0	To overflow interrupt request flag. To overflows. When an interrupt occurs, the hardware sets TF0 to "1" and applies for an interrupt. When the CPU responds, the hardware clears "0".
4	TR0	Operation control bit of timer T0. This bit is set and cleared by software. When TR0=1, T0 is allowed to start counting. When TR0=0, T0 counting is prohibited.
2,0	-	Reserved

# TMOD (89H) Timer Operating Mode Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	-	C/T1	M11	M01	1	C/T0	M10	M00
R/W	-	R/W	R/W	R/W	-	R/W	R/W	R/W
POR	х	0	0	0	х	0	0	0
	T1					Т	0	

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Bit number	Bit Mnemonic	Description
6	С/Т1	TMOD[6] control timer 1  0: Timer, T1 count comes from fsys frequency division  1: Counter, T1 count comes from external pin T1/P1.3
5~4	M11,M01	Timer/Counter 1 mode selection  00: 13-bit timer/counter, the upper 3 bits of TL1 are invalid  01: 16-bit timer/counter, TL1 and TH1 all are valid  10: 8-bit auto-reload timer, automatically reload the value stored in TH1 into TL1 when overflow  11: Timer/Counter 1 is invalid (stop counting)
2	С/ТО	TMOD[2] control timer 0  0: Timer, T0 count comes from fsys frequency division  1: Counter, T0 count comes from external pin T0/P1.2
1~0	M10,M00	Timer/Counter 0 mode selection  00: 13-bit timer/counter, the upper 3 bits of TL0 are invalid  01: 16-bit timer/counter, TL0 and TH0 all are valid  10: 8-bit auto-reload timer, automatically reload the value stored in TH0 into TL0 when overflow  11: Timer 0 is now a dual 8-bit timer/counter. TL0 is an 8-bit timer/counter controlled by the control bits of standard timer 0; TH0 is only an 8-bit timer controlled by the control bits of timer 1.
7,3	-	Reserved

TMOD[0]~TMOD[2] in TMOD register is to set the operating mode of T0; TMOD[4]~TMOD[6] is to set the operating mode of T1.

The timer and counter Tx functions are selected by the control bits C/Tx of the special function register TMOD. M0x and M1x are used to select the Tx operating mode. TRx acts as the switch control of T0 and T1. Only when TRx=1, T0 and T1 are turned on.

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### TMCON (8EH) Timer Frequency Control Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	USMD	2[1: 0]	-	-	-	-	T1FD	T0FD
R/W	R/W	R/W	-	-	-	-	R/W	R/W
POR	0	0	х	х	х	х	0	0

Bit number	Bit Mnemonic	Description
1	T1FD	T1 input frequency selection control  0: T1 frequency is derived from fsys/12  1: T1 frequency is derived from fsys
0	TOFD	T0 input frequency selection control  0: T0 frequency is derived from fsys/12  1: T0 frequency is derived from fsys

### IE (A8H) Interrupt Enable Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	EA	EADC	ET2	EUART	ET1	EINT1	ET0	EINT0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

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Bit number	Bit Mnemonic	Description					
3	ET1	Timer 1 interrupt enable control  0: Disable Timer 1 interrupt  1: Enable Timer 1 interrupt					
1	ET0 Timer 0 interrupt enable control 0: Disable Timer 0 interrupt 1: Enable Timer 0 interrupt						

### IP (B8H) Interrupt Priority Control Register (Read/Write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	-	IPADC	IPT2	IPUART	IPT1	PIPINT1	IPT0	IPINT0
R/W	-	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	x	0	0	0	0	0	0	0

Bit number	Bit Mnemonic	Description					
3	IPT1	Timer 1 interrupt priority  0: Set the interrupt priority of Timer 1 to "Low"  1: Set the interrupt priority of Timer 1 to "High"					
1	IPT0	Timer 0 interrupt priority  0: Set the interrupt priority of Timer 0 to "Low"  1: Set the interrupt priority of Timer 0 to "High"					

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## 10.2 T0 Operating Modes

By setting M10 and M00 (TMOD[1], TMOD[0]) in the register TMOD, timer/counter 0 can realize 4 different operating modes.

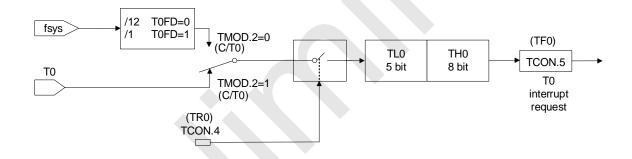
#### Operating Mode 0: 13-bit Counter/Timer

TH0 register stores the upper 8 bits (TH0.7~TH0.0) of the 13-bit counter/timer, and the TL0 stores the low 5 bits (TL0.4~TL0.0). The upper three bits of TL0 (TL0.7~TL0.5) are uncertain values and should be ignored when reading. When the 13-bit timer/counter overflows, the system will set the timer overflow flag TF0 to 1. If the timer 0 interrupt is enabled, an interrupt will be generated.

C/T0 bit selects the clock input source of the counter/timer. If C/T0=1, the level change of the timer 0 input pin T0 (P1.2) from high to low will increase the timer 0 data register by 1. If C/T0=0, select the frequency division of the system clock as the clock source of timer 0.

When TR0 is set to 1, the timer T0 is started. Setting TR0 does not forcibly reset the timer, meaning that if TR0 is set, the timer register will start counting from the value when TR0 was cleared last time. Therefore, before enabling the timer, the initial value of the timer register should be set.

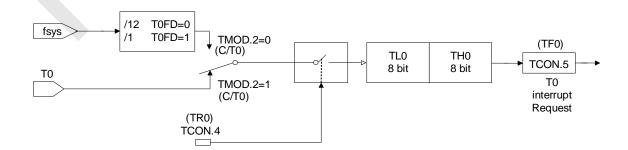
When applied as a timer, TOFD can be configured to select the frequency division ratio of the clock source.



Timer/counter operating mode 0: 13-bit timer/counter

#### Operating Mode 1: 16-bit Counter/Timer

Except for using a 16-bit (all 8-bit data of TL0 is valid) counters/timers, Mode 1 and Mode 0 operate in the same way. The way to open and configure the counter/timer is the same.



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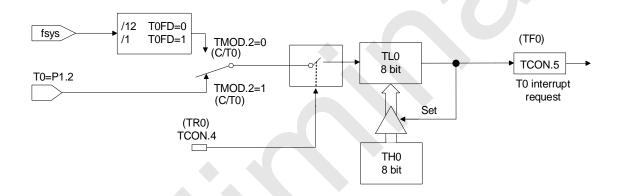
Timer/Counter Operating Mode 1: 16-bit Timer/Counter

#### Operating Mode 2: 8-bit Automatic Reload Counter/Timer

In operating mode 2, Timer 0 is an 8-bit auto-reload counter/timer. TL0 stores the count value, and TH0 stores the reload value. When the counter in TL0 overflows to 0x00, the timer overflow flag TF0 is set to 1, and the value of register TH0 is reloaded into register TL0. If the timer interrupt is enabled, an interrupt will be generated when TF0 is set to 1, but the reload value in TH0 will not change. Before allowing the timer to count correctly, TL0 must be initialized to the required value.

Except for the auto-reload function, the counter/timer in operating mode 2 is enabled and configured in the same way as in modes 0 and 1.

When used as a timer, the register TMCON.0 (T0FD) can be configured to select the ratio of the timer clock source divided by the system clock fsys.



Timer/counter operating mode 2: 8-bit timer/counter with automatic reload

### Operating Mode 3: Two 8-bit Counters/Timers (Timer 0 Only)

In operating mode 3, Timer 0 is used as two independent 8-bit counters/timers, which are controlled by TL0 and TH0, respectively. TL0 is controlled by timer 0 control bits (in TCON) and status bits (in TMOD): TR0, C/T0, TF0. Timer 0 can select the timer mode or counter mode through T0 TMOD.2 (C/T0).

TH0 sets related control by timer 1 control TCON, but TH0 is only limited to timer mode and cannot be set to counter mode by TMOD.2 (C/T0). TH0 is enabled by the control of the timer control bit TR1, and TR1=1 needs to be set. When an overflow occurs and an interrupt is generated, TF1 will be set to 1, and the interrupt will be processed according to T1.

When T0 is set to operating mode 3, the TH0 timer occupies the interrupt resources of T1 and the registers in TCON, and the 16-bit counter of T1 will stop counting, which is equivalent to "TR1=0". When using the TH0 timer to work, set TR1=1.

## 10.3 T1 Operating Mode

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By setting M11 and M01 (TMOD[5], TMOD[4]) in the register TMOD, timer/counter 1 can realize three different operating modes.

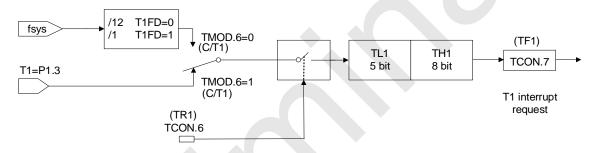
#### Operating mode 0: 13-bit Timer/Counter

The TH1 register stores the upper 8 bits (TH1.7~TH1.0) of the 13-bit counter/timer; the TL1 stores the low 5 bits (TL1.4~TL1.0). The upper three bits of TL1 (TL1.7~TL1.5) are uncertain values and should be ignored when reading. When the 13-bit timer counter increments and overflows, the system sets the timer overflow flag TF1 to 1. If Timer 1 interrupt is enabled, an interrupt will be generated. The C/T1 bit selects the clock source of the counter/timer.

If C/T1=1, the level of timer 1 input pin T1 (P1.3) changes from high to low, which will increase the timer 1 data register by 1. If C/T1=0, select the frequency division of the system clock as the clock source of timer 1.

Set TR1 to enable the timer. Setting TR1 does not forcibly reset the timer, meaning that if TR1 is set to 1, the timer register will start counting from the value when TR1 was cleared to 0 last time. Therefore, before enabling the timer, the initial value of the timer register should be set.

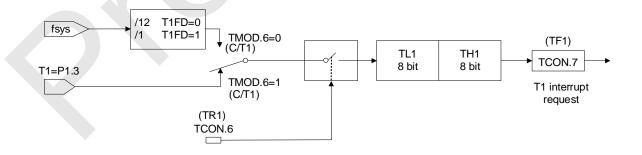
When applied as a timer, T1FD can be configured to select the frequency division ratio of the clock source.



Timer/counter operating mode 0: 13-bit timer/counter

#### Operating mode 1: 16-bit Counter/Timer

Except for using a 16-bit (all 8-bit data of TL1 is valid) counter/timer, Mode 1 and Mode 0 operate in the same way. The way to open and configure the counter/timer is the same.



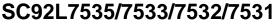
Timer/counter operating mode 1: 16-bit timer/counter

#### Operating mode 2: 8-bit Automatic Reload Counter/Timer

In operating mode 2, Timer 1 is an 8-bit auto-reload counter/timer. TL1 stores the count value, and TH1 stores the reload value. When the counter in TL1 overflows to 0x00, the timer overflow flag TF1 is set to 1, and the

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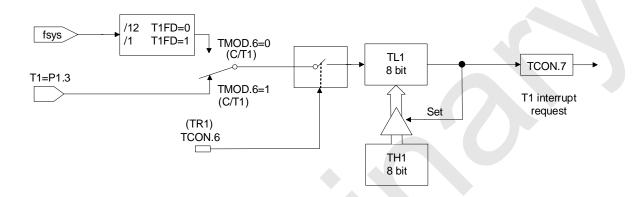


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value of register TH1 is reloaded into register TL1. If the timer interrupt is enabled, an interrupt will be generated when TF1 is set to 1, but the reload value in TH1 will not change. Before allowing the timer to count correctly, TL1 must be initialized to the required value.

Except for the auto-reload function, the counter/timer in operating mode 2 is enabled and configured in the same way as modes 0 and 1.

When used as a timer, the register TMCON.1 (T1FD) can be configured to select the ratio of the timer clock source divided by the system clock fsys.



Timer/counter operating mode 2: 8-bit timer/counter with automatic reload

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### 11 Timer/Counter T2/T3/T4

Timer 2/3/4 inside The SC92L753X MCU are three independent Timers, among which Timer 2 has 4 operating modes, Timer 3 and Timer 4 have 3 operating mode.

The control registers of Timer 2/3/4 share the same set of addresses (C8H-CDH), users can point the Timer X register set (TXCON / TXMOD / RCAPXL / RCAPXH / TLX / THX) to Timer 2/3/4 through TXINX[2: 0] In order to realize the function of three independent Timers configured by a group of registers.

Note: Only after the TXINX[2: 0] configuration is successful, the Timer X register group will point to the Timer 2/3/4 specified by the user. At this time, operating the TimeX register group is an effective operation for the corresponding Timer.

### 11.1 T2/3/4-related Registers

Symbol	Address	Description	7	6	5	4	3	2	1	0	POR
TXINX	CEH	Timer 2/3/4 control register pointer	1	TXINX[2: 0]					xxxxx010b		
TXCON	C8H	Timer 2/3/4 control register	TFX	EXFX	RCLK X	TCL KX	EXEN X	TRX	C/TX	CP/RL X	00000000b
TXMOD	С9Н	Timer 2/3/4 operating mode register	TXF D	1	1	'	-	1	TXO E	DCXE N	0xxxxx00b
RCAPXL	CAH	Timer 2/3/4 reload low 8 bits		RCAPXL[7: 0]							
RCAPXH	СВН	Timer 2/3/4 reload high 8 bits		RCAPXH[7: 0]							
TLX	ССН	Timer 2/3/4 low 8 bits		TLX[7: 0]							00000000b
тнх	CDH	Timer 2/3/4 high 8 bits		THX[7: 0]							00000000b
TMCON	8EH	Timer frequency control register	USME	D2[1: 0]	-	-	-	-	T1FD	T0FD	00xxxx00b

TXINX (CEH) Timer 2/3/4 Control Register Pointer (read/write)

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Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	-	-	-	-	-	TXINX[2: 0]		
R/W	-	-	-	-	-	R/W	R/W	R/W
POR	х	х	х	х	х	0	1	0

Bit number	Bit Mnemonic	Description
2~0	TXINX[2: 0]	Timer 2/3/4 control register pointer  010: Timer X register set: TXCON / TXMOD / RCAPXL / RCAPXH / TLX / THX points to T2  011: Timer X register set points to T3  100: Timer X register set points to T4  Other: reserved
7~3	-	Reserved

# 11.2 Timer 2

Timer 2 inside the SC92L753X MCU has two operating modes: counting mode and timing mode. There is a control bit C/TX in the special function register TXCON to select whether T2 is a timer or a counter. They are essentially an addition counter, but the source of the count is different. The source of the timer is the system clock or its divided clock, but the source of the counter is the input pulse of the external pin. TRX is the switch control of T2 counting in the timer/counter mode. Only when TRX=1, T2 will be opened for counting.

In counter mode, for every pulse on the T2 pin, the count value of T2 increases by 1 respectively.

In timer mode, the count source of T2 can be selected as fsys/12 or fsys through the special function register TXMOD.7 (TXFD).

Timer/counter T2 has 4 operating modes:

① Mode 0: 16-bit capture mode

2 Mode 1: 16-bit auto-reload timer mode

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- ③ Mode 2: Baud rate generator mode
- 4 Mode 3: Programmable clock output mod

TXINX[2: 0] = 010, the Timer X register group points to Timer 2, the explanation of each register is as follows:

### TXCON (C8H) Timer 2 Control Register (read/write) ( TXINX[2: 0] = 010)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	TFX	EXFX	RCLKX	TCLKX	EXENX	TRX	C/TX	CP/RLX
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit number	Bit Mnemonic	Description
7	TFX	Timer 2 overflow flag  0: No overflow (must be cleared by software)  1: Overflow (if RCLKX = 0 and TCLKX = 0, set by hardware 1)
6	EXFX	Flag bit detected by external event input (falling edge) of T2 pin  0: No external event input (must be cleared by software)  1: External input detected (if EXENX = 1, set by hardware)
5	RCLKX	UART0 receive clock control bit  0: Timer 1 generates the receive baud rate  1: Timer 2 generates the receive baud rate
4	TCLKX	UART0 transmit clock control bit  0: Timer 1 generates transmission baud rate

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		1: Timer 2 generates transmission baud rate
3	EXENX	T2EX pin is used as a reload/capture trigger enable/disable control:  0: Ignore events on T2EX pin  1: When Timer 2 is not used as the UART0 clock, a falling edge on the T2EX pin is detected, and a capture or reload is generated
2	TRX	Timer 2 start/stop control bit  0: stop timer 2  1: Start timer 2
1	С/ТХ	Timer 2 Timer/counter mode selection positioning 2  0: Timer mode, T2 pin is used as I/O port  1: Counter mode
0	CP/RLX	Capture/reload mode selection positioning  0: 16-bit timer/counter with reload function  1: 16-bit timer/counter with capture function, T2EX is timer 2 external capture signal input port

# TXMOD (C9H) Timer 2 Operating Mode Register (read/write) ( TXINX[2: 0] = 010)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	TXFD	-	-	-	-	-	TXOE	DCXEN
R/W	R/W	-	-	-	-	-	R/W	R/W
POR	0	х	х	х	х	х	0	0

Bit number Bit Mnemonic
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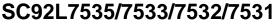
7	TXFD	T2 input frequency selection control  0: T2 frequency is derived from fsys/12  1: T2 frequency is derived from fsys
1	TXOE	Timer 2 output enable bit  0: Set T2 as clock input or I/O port  1: Set T2 as the clock output
0	DCXEN	Count down enable bit  0: Timer 2 is prohibited as an up/down counter, Timer 2 is only used as an up counter  1: Allow Timer 2 as an up/down counter
6~2	-	Reserved

### IE (A8H) Interrupt Enable Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	EA	EADC	ET2	EUART	ET1	EINT1	ET0	EINT0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit number	Bit Mnemonic	Description
5	ET2	Timer 2 interrupt enable control
		0: Disable Timer 2 interrupt
		1: Enable Timer 2 interrupt

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#### IP (B8H) Interrupt Priority Control Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	-	IPADC	IPT2	IPUART	IPT1	IPINT1	IPT0	IPINT0
R/W	-	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	x	0	0	0	0	0	0	0

Bit number	Bit Mnemonic	Description
5	IPT2	Timer 2 interrupt priority  0: Set the interrupt priority of Timer 2 to "Low"  1: Set the interrupt priority of Timer 2 to "High"

#### 11.3 Timer 3

Timer3 in SC92L753X microcontroller has two working modes: counting mode and timing mode. The special function register TXCON has a control bit C/TX to choose whether T3 is a timer or a counter. They are essentially an addition counter, just from different sources. The source of the timer is the system clock or its divider clock, but the source of the counter is the input pulse of the external pin. TRX is the switch control of T3 counting in timer/counter mode. Only when TRX=1, T3 will be turned on to count

In counter mode, the count value of T3 increases by 1 for each pulse on T3 pin.

Timer mode, can through the special function register TXMOD. 7 (TXFD) to select the count source of T3 is Fsys / 12 or Fsys.

The timer/counter T3 has three work modes:

Mode 0:16 bit capture mode

Mode 1:16-bit auto reload timer mode

Mode 3: Programmable clock output mode

TXINX[2: 0] = 011, the Timer X register group points to Timer 3, the explanation of each register is as follows:

TXCON (C8H) Timer 3 Control Register (read/write) (TXINX[2: 0] = 011)

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Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	TFX	EXFX	-	-	EXENX	TRX	C/TX	CP/RLX
R/W	R/W	R/W	-	-	R/W	R/W	R/W	R/W
POR	0	0	х	х	0	0	0	0

Bit number	Bit Mnemonic	Description
7	TFX	Timer 3 control register (read/write) Timer 3 overflow flag  0: No overflow (must be cleared by software)  1: Overflow (set by hardware 1)
6	EXFX	Flag bit detected by external event input (falling edge) of T3 pin  0: No external event input (must be cleared by software)  1: External input detected (if EXENX = 1, set by hardware)
3	EXENX	T3EX pin is used as a reload/capture trigger enable/disable control:  0: Ignore events on T3EX pin  1: A falling edge on the T3EX pin is detected, and a capture or reload is generated
2	TRX	Timer 3 start/stop control bit  0: stop timer 3  1: Start timer 3
1	с/тх	Timer 3 Timer/counter mode selection positioning 2  0: Timer mode, T3 pin is used as I/O port  1: Counter mode

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0	CP/RLX	Capture/reload mode selection positioning  0: 16-bit timer/counter with reload function  1: 16-bit timer/counter with capture function, TXEX is timer 3 external capture signal input port
5~4	-	Reserved

### TXMOD (C9H) Timer 3 Operating Mode Register (read/write) ( TXINX[2: 0] = 011)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	TXFD	-	-	-			TXOE	DCXEN
R/W	R/W	-	-		-	· -	R/W	R/W
POR	0	х	x	х	x	x	0	0

Bit number	Bit Mnemonic	Description
7	TXFD	T3 input frequency selection control  0: T3 frequency is derived from fsys/12  1: T3 frequency is derived from fsys
1	TXOE	Timer 3 output enable bit  0: Set T3 as clock input or I/O port  1: Set T3 as the clock output
0	DCXEN	Count down enable bit  0: Timer 3 is prohibited as an up/down counter, Timer 3 is only used as an up counter

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		1: Allow Timer 3 as an up/down counter, T3EX is used to select the counting direction
6~2	-	Reserved

### IE1 (A9H) Interrupt Enable Register 1 (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	ET4	ET3	-	-	EINT2	EBTM	EPWM	EUSCI0
R/W	R/W	R/W	-	-	R/W	R/W	R/W	R/W
POR	0	0	х	х	0	0	0	0

Bit number	Bit Mnemonic	Description
6	ET3	Timer 3 interrupt enable control  0: Disable Timer 3 interrupt  1: Enable Timer 3 interrupt
5,4		Reserved

# IP1 (B9H) Interrupt Priority Control Register 1 (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	IPT4	IPT3	-	-	IPINT2	IPBTM	IPPWM	IPUSCI0
R/W	R/W	R/W	-	-	R/W	R/W	R/W	R/W

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### **Super High-Speed Flash MCU**

POR 0 0 x x 0 0 0	0	
-------------------	---	--

Bit number	Bit Mnemonic	Description
6	IPT3	Timer 3 interrupt priority selection  0: Timer 3 interrupt priority is low  1: Timer 3 interrupt priority is high
5,4	-	Reserved

#### 11.4 Timer 4

Timer4 in SC92L753X microcontroller has two working modes: counting mode and timing mode. The special function register TXCON has a control bit C/TX to choose whether T4 is a timer or a counter. They are essentially an addition counter, just from different sources. The source of the timer is the system clock or its divider clock, but the source of the counter is the input pulse of the external pin. TRX is the on-off control of T4 counting in timer/counter mode. T4 will only be counted when TRX=1.

In counter mode, the T4 count increases by 1 for each pulse on the T4 pin.

Timer mode, can through the special function register TXMOD. 7 (TXFD) to select the count source of T4 is Fsys / 12 or Fsys.

The timer/counter T4 has three work modes:

Mode 0:16 bit capture mode

Mode 1:16-bit auto reload timer mode

Mode 3: Programmable clock output mode

TXINX[2: 0] = 100, Timer X register group points to Timer 4, the explanation of each register is as follows:

### TXCON (C8H) Timer 4 Control Register (read/write) (TXINX[2: 0] = 100)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	TFX	EXFX	-	-	EXENX	TRX	C/TX	CP/RLX

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R/W	R/W	R/W	-	-	R/W	R/W	R/W	R/W
POR	0	0	х	х	0	0	0	0

Bit number	Bit Mnemonic	Description
7	TFX	Timer 4 overflow flag  0: No overflow (must be cleared by software)  1: Overflow (set by hardware 1)
6	EXFX	Flag bit detected by external event input (falling edge) of T4 pin  0: No external event input (must be cleared by software)  1: External input detected (if EXENX = 1, set by hardware)
3	EXENX	T4EX pin is used as a reload/capture trigger enable/disable control:  0: Ignore events on T4EX pin  1: A falling edge on the T4EX pin is detected, and a capture or reload is generated
2	TRX	Timer 4 start/stop control bit  0: stop timer 4  1: Start timer 4
1	С/ТХ	Timer 4 Timer/counter mode selection positioning 2  0: Timer mode, T4 pin is used as I/O port  1: Counter mode
0	CP/RLX	Capture/reload mode selection positioning  0: 16-bit timer/counter with reload function  1: 16-bit timer/counter with capture function, T4EX is timer 4 external capture signal input port

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# **Super High-Speed Flash MCU**

5~4	-	Reserved
-----	---	----------

### TXMOD (C9H) Timer 4 Operating Mode Register (read/write) ( TXINX[2: 0] = 100)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	TXFD		-	-	-	-	TXOE	DCXEN
R/W	R/W	-	-	-	-	-	R/W	R/W
POR	0	х	х	х	x	x	0	0

Bit number	Bit Mnemonic	Description
7	TXFD	T4 input frequency selection control  0: T4 frequency is derived from fsys/12  1: T4 frequency is derived from fsys
1	TXOE	Timer 4 output enable bit  0: Set T4 as clock input or I/O port  1: Set T4 as the clock output
0	DCXEN	Count down enable bit  0: Timer 4 is prohibited as an up/down counter, Timer 4 is only used as an up counter  1: Allow Timer 4 as an up/down counter
6	-	Reserved

### IE1 (A9H) Interrupt Enable Register 1 (read/write)

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Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	ET4	ET3	-	-	EINT2	EBTM	EPWM	EUSCI0
R/W	R/W	R/W	-	-	R/W	R/W	R/W	R/W
POR	0	0	х	Х	0	0	0	0

Bit number	Bit Mnemonic	Description
7	ET4	Timer 4 interrupt enable control
		0: Disable Timer 4 interrupt
		1: Enable Timer 4 interrupt
5,4	-	Reserved

# IP1 (B9H) Interrupt Priority Control Register 1 (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	IPT4	IPT3	-	-	IPINT2	IPBTM	IPPWM	IPUSCI0
R/W	R/W	R/W	-	-	R/W	R/W	R/W	R/W
POR	0	0	х	Х	0	0	0	0

Bit number	Bit Mnemonic	Description
7	IPT4	Timer 4 interrupt priority selection

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		0: Timer 4 interrupt priority is low
		1: Timer 4 interrupt priority is high
5,4	-	Reserved

# 11.5 T2/3/4 Operating Modes

Timer 2 have 4 operating modes. Timer3 and Timer4 have only three working modes, but no mode 2.

① Mode 0: 16-bit capture

2 Mode 1: 16-bit auto-reload timer

3 Mode 2: Baud rate generator

4 Mode 3: Programmable clock output

The preceding working modes and configuration modes are listed as follows:

C/TX	TXOE	DCXEN	C/TX	TXOE	DCXEN	C/TX	Мо	de	
Х	0	Х	1	1	0	0	0	16-bit capture	
Х	0	0	1	0	0	0	1	16-bit auto-reload	
Х	0	1	1	0	0	0			
Х	0	X	1	Х	1	Х	2	Baud rate generator, only for Timer 2	
					Х	1		Timer Z	
0	1	Х	_1	Х	0	0	3	Programmable clock output	
					1	Х	3	Programmable clock output	
					Х	1		with baud rate generator	
Х	Х	Х	0	Х	Х	Х	Х	Timer stops, TnEX(n=2~4) channel is still allowed	
1	1	Х	1	Х	Х	Х		Not recommand	

#### 11.5.1 Operating Mode 0: 16-bit Capture

In the capture mode, the EXENX bit of TXCON has two options:

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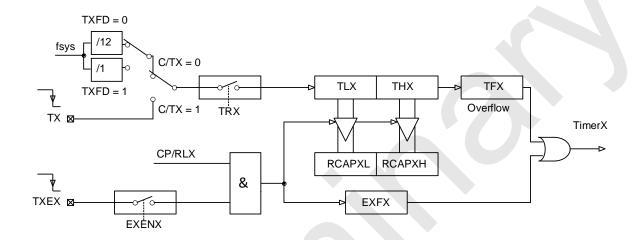




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If EXENX = 0, Timer n(n=2/3/4) acts as a 16-bit timer or counter. If ETn is enabled, Timer n can set TFX overflow to generate an interrupt.

If EXENX = 1, Timer n(n=2/3/4) performs the same operation, but the falling edge on external input TnEX can also cause the current values in THX and TLX to be captured in RCAPXH and RCAPXL, respectively. In addition, the falling edge on TnEX also Can cause EXFX in TXCON to be set. If ETn is enabled, the EXFX bit also generates an interrupt like TFX.



Mode 0: 16-bit capture

#### 11.5.2 Operating Mode 1: 16-bit Auto-Reload Timer

In 16-bit auto-reload mode, Timer n(n=2/3/4) can be selected to count up or count down. This function is selected by the DCEN bit (down counting allowed) in TXMOD. After the system is reset, the reset value of the DCEN bit is 0, and the timer n counts up by default. When DCEN is set to 1, Timer n counts up or down depending on the level on the TnEX pin.

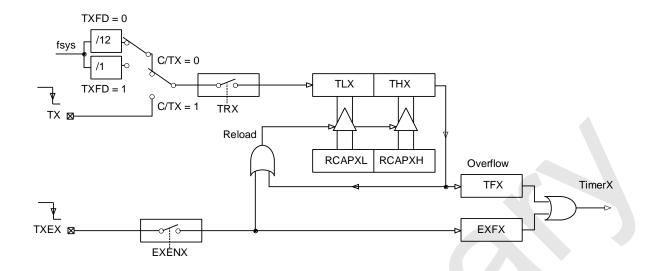
When DCEN = 0, two options are selected through the EXENX bit in TXCON.

If EXENX = 0, Timer n increments to 0xFFFFH, sets the TFX bit after overflow, and the timer automatically loads the 16-bit values of registers RCAPXH and RCAPXL written in user software into the THX and TLX registers.

If EXENX = 1, an overflow or a falling edge on TnEX can trigger a 16-bit reload and set the EXFX bit. If ETn is enabled, both TFX and EXFX bits can generate an interrupt.

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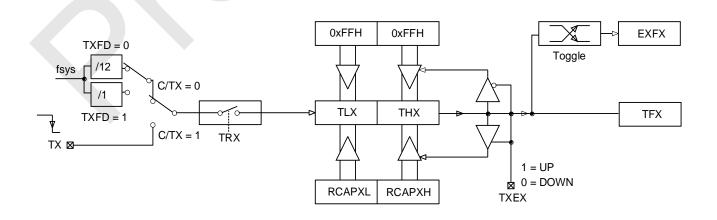
Mode 1: 16-bit auto-reload DCEN = 0

Setting the DCEN bit allows Timer n(n=2/3/4) to count up or down. When DCEN = 1, the TnEX pin controls the direction of the count, and EXENX control is invalid.

Setting TnEX(n=2/3/4) causes Timer n to count up. The timer overflows to 0xFFFFH, and then sets the TFX bit. Overflow can also cause the 16-bit values on RCAPXH and RCAPXL to be reloaded into the timer register, respectively.

Setting TnEX(n=2/3/4) to 0 causes Timer n to count down. When the values of THX and TLX are equal to the values of RCAPXH and RCAPXL, the timer overflows. The TFX bit is set and 0xFFFFH is reloaded into the timer register.

Regardless of whether Timer n overflows or not, the EXFX bit is used as the 17th bit of the result. In this operating mode, EXFX is not used as an interrupt flag.



Mode 1: 16-bit auto-reload DCEN = 1

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#### 11.5.3 Operating Mode 2: Baud Rate Generator, only for Timer 2

Set TCLKX and/or RCLKX in the TXCON register to select Timer 2 as the baud rate generator. The baud rate of the receiver and transmitter can be different. If Timer 2 acts as a receiver or transmitter, then Timer 1 acts as another baud rate generator

Set TCLKX and/or RCLKX in the TXCON register to make Timer 2 enter the baud rate generator mode, which is similar to the automatic reload mode

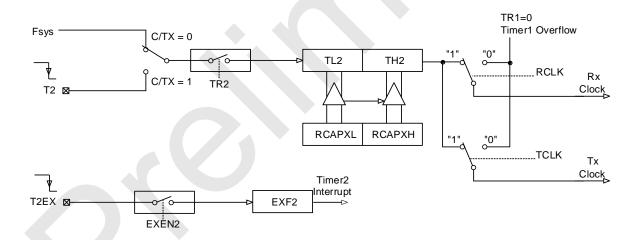
The overflow of Timer 2 will reload the values in the RCAPXH and RCAPXL registers to the Timer 2 count, but no interrupt will be generated

If EXENX is set to 1, the falling edge on the T2EX pin will set up EXFX, but it will not cause a heavy load. So when Timer 2 is used as a baud rate transmitter, T2EX can be used as an additional external interrupt

The baud rate in UART0 mode 1 and 3 is determined by the overflow rate of timer 2 according to the following equation:

$$BaudRate = \frac{fsys}{[RCAPXH,RCAPXL]}; (Note: [RCAPXH, RCAPXL] must be bigger than 0x0010)$$

The schematic diagram of Timer 2 as a baud rate generator is as follows:



Mode 2: Baud rate generator

Note: When timer 2 is used as baud rate generator, THX/TLX or RCAPXH/RCAPXL written in UART0 communication will affect the accuracy of baud rate and cause communication errors.

### 11.5.4 Operating Mode 3: Programmable Clock Output

In this way, T2(P0.7)/T3(P0.1)/T4(P2.5) can be programmed to output a 50% duty cycle clock cycle: when C/TX = 0; TXOE = 1, timer n(n=2/3/4) is enabled as a clock generator

In this way, Tn outputs a clock with a 50% duty cycle

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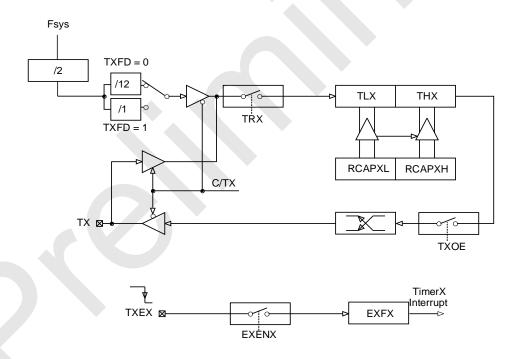
Colck Out Frequency = 
$$\frac{\text{ftn}}{(65536-[\text{RCAPXH,RCAPXL}])\times 4}$$
;

Among them, fn is the timer n(n=2/3/4) clock frequency:

$$ftn = \frac{fsys}{12}$$
; TXFD = 0

$$ftn = fsys; TXFD = 1$$

Timer n overflow does not generate an interrupt, and the Tn T2(P0.7)/T3(P0.1)/T4(P2.5) port is used as a clock output.



Mode 3: Programmable clock output

#### Note:

- 1. Both TFX and EXFX can cause the interrupt request of Timer n(n=2/3/4), both have the same vector address;
- 2. When the event occurs or at any other time, TFX and EXFX can be set to 1 by software, and only software and hardware reset can clear it to 0;
- 3. When EA = 1 and ETn = 1, setting TFX or EXFX to 1 can cause Timer n to interrupt;

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4. When Timer n is used as a baud rate generator, writing THX/TLX or RCAPXH/RCAPXL will affect the accuracy of the baud rate and cause communication errors.

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# 12 Multiplier-Divider Unit (MDU)

The SC92L753X provides a 16-bit hardware multiplier and divider, which consists of extended accumulators EXA0~EXA3, extended B register EXB and operation control register OPERCON.

The SC92L753X hardware multiplier and divider does not occupy CPU cycles, and the operation is implemented by hardware. The speed is dozens of times faster than the software implementation of multiplication and division. It can replace software for 16-bit  $\times$  16-bit multiplication and 32-bit/16-bit division and increase program running efficiency.

Symbol	Address	Description	7	6	5	4	3	2	1	0	POR
EXA0	E9H	Extended Accumulator 0		EXA [7: 0]						00000000Ь	
EXA1	EAH	Extended Accumulator 1		EXA [15: 8]						00000000b	
EXA2	ЕВН	Extended Accumulator 2		EXA [23: 16]						00000000ь	
EXA3	ECH	Extended Accumulator 3				EXA [	[31: 24]				00000000b
EXBL	EDH	Extended B register L				EXB	[7: 0]				00000000b
EXBH	EEH	Extended B register H		EXB [15: 8]						00000000b	
OPERC ON	EFH	Operation control register	OPE RS	MD	-	-	-	-	CRCR ST	CRCS TA	00xxxx00b

#### **OPERCON (EFH) Operation control register (read/write)**

Bit number	7	6	5	4	3	2	1	0	
------------	---	---	---	---	---	---	---	---	--

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Bit Mnemonic	OPERS	MD	-	-	-	-	CRCRST	CRCSTA
R/W	R/W	R/W	-	-	-	-	R/W	R/W
POR	0	0	х	х	х	х	0	0

Bit number	Bit Mnemonic		D	escription		
7	OPERS	Multiplier-divider op	peration start	trigger contro	ol (Operater S	Start)
		Write "1" to this bit is, this bit is just th start calculation. W been completed. The	e trigger sign hen the bit is	nal for the must zero, it mea	ultiplication and the case of	nd division to
6	MD	Multiplication and d	livision			
		0: Multiplication ope and the product is i			and multiplier	are written
		Byte Operand	Byte 3	Byte 2	Byte 1	Byte 0
		multiplicand 16bit	-	-	EXA1	EXA0
		multiplier 16bit	-	-	EXBH	EXBL
		multiplier 32bit	EXA3	EXA2	EXA1	EXA0
		1: Divide operation and remainder as for		idend and di	visor, read th	e quotient
		Byte Operand	Byte 3	Byte 2	Byte 1	Byte 0

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dividend 32bit	EXA3	EXA2	EXA1	EXA0
divisor 16bit	-	-	EXBH	EXBL
quotient 32bit	EXA3	EXA2	EXA1	EXA0
remainder 16bit	-	-	EXBH	EXBL

#### Note:

- 1. It is forbidden to perform read or write operations on the EXA and EXB data registers during the calculation operation.
- 2. The time required for the operation conversion of the multiplier-divider is 16/fsys.

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#### **13 PWM**

The SC92L753X provides a 16-bit PWM with up to 8-channel common cycle and independently adjustable duty cycle.

The functions are as follows:

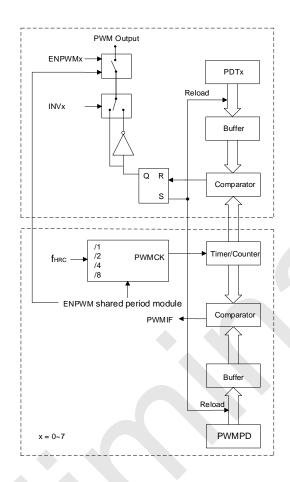
- 1. 16-bit PWM accuracy;
- 2. The output waveform can be reversed;
- Type: Can be set to center-aligned or edge-aligned;
- 4. Mode: can be set to independent mode or complementary mode:
  - a) In independent mode, the 8 PWM cycles are the same, but the duty cycle of each PWM output waveform can be set separately;
  - b) In complementary mode, four sets of complementary PWM waveforms with dead zones can be output simultaneously;
- 5. Provide one PWM overflow interrupt;
- 6. Support fault detection mechanism.

The PWM of the SC92L753X can support the adjustment of period and duty cycle. The registers PWMCFG, PWMCON0 and PWMCON1 control the state and period of PWM. The opening of each PWM and the output waveform duty cycle can be adjusted separately.

### 13.1 PWM Structure Diagram

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SC92L753X PWM Structure diagram

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## 13.2 PWM General Configuration Register

#### 13.2.1 PWM General Configuration Register

The user can set the PWM output mode of SC92L753X to independent mode or complementary mode by configuring PWMMD[1: 0]. In independent mode, the 8 PWM cycles are the same, but the duty cycle of each PWM output waveform can be set separately. In complementary mode, four complementary PWM waveforms with dead zones can be output simultaneously.

The PWM type of SC92L753X is divided into edge-aligned type and center-aligned type:

#### **Edge-aligned:**

The PWM counter starts counting from 0, and when the count value matches the value of the duty cycle setting item PDTx[15: 0], the PWM output waveform switches between high and low levels, The PWM counter then continues counting upward until it matches the value of the period setting PWMPD[15:0] +1 (the end of a PWM period), the PWM counter is cleared, if the PWM interrupt is enabled, a PWM interrupt will be generated at this time.

The output PWM waveform is aligned on the left edge.

Calculation formula of edge-aligned period T<sub>PWM</sub>:

$$\mathbf{Tpwm} = \frac{PWMPD[15:0] + 1}{PWM Clock frequency}$$

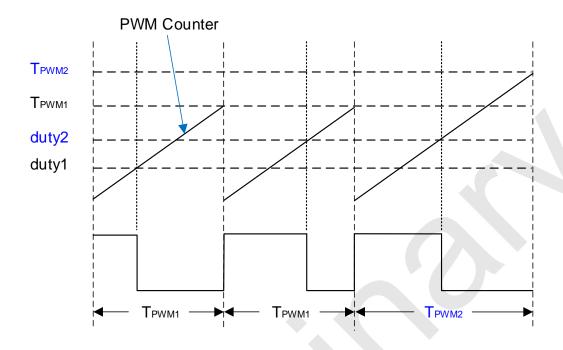
Edge-aligned **duty** calculation formula:

$$\mathbf{duty} = \frac{\text{PDTx} [15:0]}{\text{PWMPD}[15:0] + 1}$$

The edge-aligned waveform is as follows:

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**Edge-aligned PWM** 

#### Center-aligned type:

The PWM counter starts counting from 0. When the count value matches the value of the duty cycle setting item PDTx [15: 0], the PWM output waveform switches between high and low levels. Then the PWM counter continues to count up. When the count matches the value of PWMPD[15:0] +1 (that is, the midpoint of the PWM cycle), it automatically starts to count down. When the count value matches the value of PDTx [15: 0] again, the PWM output waveform switches high and low again, and then The PWM counter continues to count down until it overflows (the end of a PWM period). If the PWM interrupt is enabled, a PWM interrupt will be generated at this time.

Calculation formula of center-aligned period T<sub>PWM</sub>:

$$\mathbf{Tpwm} = 2 * \frac{PWMPD[15:0] + 1}{PWM Clock frequency}$$

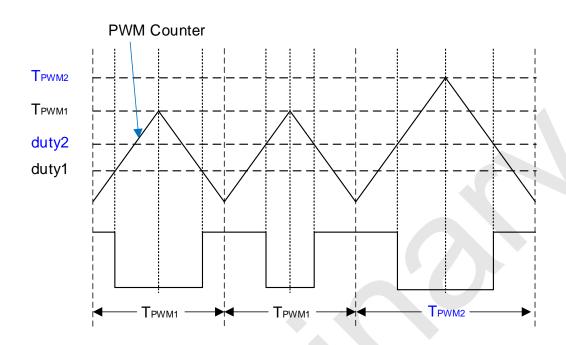
Center-aligned duty calculation formula:

$$\mathbf{duty} = \frac{\text{PDTx} [15:0]}{\text{PWMPD}[15:0] + 1}$$

The center aligned waveform is as follows:

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Center-aligned PWM

The above modes and types can be set through the PWMMOD register:

### PWMCON0 (D2H) PWM Control Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	ENPWM	PWMIF	PWMCK[1:0]		-	•	PWMMD[1:0]	
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	х	х	0	0

Bit number	Bit Mnemonic	Description
7	ENPWM	PWM module switch control (Enable PWM)

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		1: Allow Clock to enter the PWM unit, the PWM is in the operating state, and the state of the PWM output port is controlled by the register ENPWMx (x=0~7)  0: The PWM unit stops operating, the PWM counter is cleared, and all PWM output ports are set to the GPIO state
6	PWMIF	PWM interrupt request flag
		When the PWM counter overflows (that is, when the count exceeds PWMPD), this bit is automatically set to 1 by the hardware. If IE1[1] (EPWM) is also set to 1, the PWM interrupt is generated at this time. After the PWM interrupt occurs, the hardware will not automatically clear this bit. This bit must be cleared by the user's software.
5~4	PWMCK[1: 0]	PWM Clock Source Selector (PWM Clock Source Selector)
		00: fhrc
		01: fhrc /2
		10: f <sub>HRC</sub> /4
		11: f <sub>HRC</sub> /8
		The frequency of the PWM clock source is fixed at fhrc
1~0	PWMMD[1: 0]	PWM operating mode setting
		0x: Independent mode
		1x: complementary mode
		x0: edge alignment mode
		x1: center alignment mode
3~2	-	Reserved

# PWMCFG (D1H) PWM Set Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	INV7	INV6	INV5	INV4	INV3	INV2	INV1	INV0

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| R/W |
|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| POR | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |

Bit number	Bit Mnemonic	Description
7~0	INVx(x=0~7)	PWMx waveform output reverse control  1: PWMx waveform output is reversed  0: PWMx waveform output is not reversed

# PWMCON1 (D3H) PWM Control Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	ENPWM 7	ENPWM 6	ENPWM 5	ENPWM 4	ENPWM 3	ENPWM 2	ENPWM 1	ENPWM 0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit number	Bit Mnemonic	Description
7~0	ENPWMx (x=0~7)	PWMx Waveform output select  0: PWMx output is disabled  1: I/O where PWMx resides serves as the output port of the PWM waveform

Note:

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### **Super High-Speed Flash MCU**

1. If ENPWM is set to 1, the PWM module is turned on, but ENPWMx=0, and the PWM output is turned off as a GPIO port. In this case, the PWM module can be used as a 16-bit Timer. When EPWM(IE1.1) is set to 1, the PWM will still interrupt.

#### PWMPDL (D4H) period register low 8 bits(R/W)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic		PWMPDL[7:0]						
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

#### PWMPDH (D5H)PWMn period register high 8 bits (R/W)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	PWMPDH[7:0]							
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit number	Bit Mnemonic	Description
7~0	PWMPD[15:0]	PWM cycle set  This value represents the output waveform of PWMn (cycle-1); that is to say PWMn cycle of output is(PWMPDX[15:0] + 1)* PW clock

#### IE1 (A9H) Interrupt Enable Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	ET4	ET3	-	-	EINT2	EBTM	EPWM	EUSCI0
R/W	R/W	R/W	-	-	R/W	R/W	R/W	R/W
POR	0	0	х	X	0	0	0	0

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### **Super High-Speed Flash MCU**

Bit number	Bit Mnemonic	Description
1	EPWM	PWM interrupt enable control  0: Disable PWM interrupt  1: Enable interrupt when PWM counter overflows
5, 4	-	Reserved

#### IP1 (B9H) Interrupt Priority Register 1 (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	IPT4	IPT3	-	-	IPINT2	IPBTM	IPPWM	IPUSCI0
R/W	R/W	R/W	-		R/W	R/W	R/W	R/W
POR	0	0	x	х	0	0	0	0

Bit number	Bit Mnemonic	Description
1	IPPWM	PWM interrupt priority selection  0: Set the PWM interrupt priority to "low"  1: Set the PWM interrupt priority to "High"
5,4	-	Reserved

### 13.2.2 PWM Fault Detection Function Setting

The SC92L753X supports fault detection. The fault detection function is often applied to the protection of motor systems. When the fault detection function is enabled, FLTEN1 (PWMFLT.7) is set to 1, and the fault detection signal input pin (FLT) becomes effective. When the signal of the FLT pin meets the fault condition, the flag bit FLTSTA1 is set by hardware, and the PWM output stops. The PWM counter still keeps counting and THE PWM

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interrupt is not affected. The fault detection mode is divided into latch mode and immediate mode; in immediate mode, when the fault signal on the FLT pin meets the disabling condition, the flag FLTSTA1 is cleared by hardware, PWM counter restores counting, and until the PWM counter returns to zero. Output; In the latch mode, when the fault signal on the FLT pin meets the disabling condition, the status of the FLTSTA1 flag remains unchanged, and the user can clear it through software. Once the FLTSTA1 status is cleared, the PWM counter resumes counting until the PWM Count overflow or PWM counter returns The PWM resumes output after zero. The fault detection mode is divided into latch mode and immediate mode. The specific configuration methods are as follows:

#### PWMFLT (D7H) PWM Fault Detection Setting Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	FLTEN1	FLTSTA1	FLTMD1	FLTLV1	-		FLTDT	71[1: 0]
R/W	R/W	R/W	R/W	R/W	-		R/W	R/W
POR	0	0	0	0	x	х	0	0

Bit number	Bit Mnemonic	Description
7	FLTEN1	PWM fault detection function control bit
		0: The fault detection function is turned off
		1: The fault detection function is turned on
6	FLTSTA1	PWM fault detection status flag
		0: PWM is in normal output state;
		1: Fault detection is valid, the PWM output is in a high-impedance state, if in latch mode, this bit can be cleared by software
5	FLTMD1	PWM fault detection mode setting bit
		0: Latch mode: when the fault input is valid, FLTSTA1 is set to "1", the PWM stops outputting, and the FLTSTA1 state remains unchanged when the fault input is invalid
		1: Immediate mode: When the fault input is valid, FLTSTA1 is set to "1" and the PWM stops outputting. When the fault input is invalid, the state of FLTSTA1 is cleared immediately. The PWM waveform will resume

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		output when the PWM counter counts to 0 or up to match the value of the period setting item PWMPD[15:0]+1
4	FLTLV1	PWM fault detection level selection bit  0: Low level of fault detection is effective  1: High level of fault detection is effective
1~0	FLTDT1[1: 0]	PWM fault detection input signal filtering time setting  00: filtering time is 0  01: filtering time is 1us  10: filter time is 4us  11: The filtering time is 16us
3~2	-	Reserved

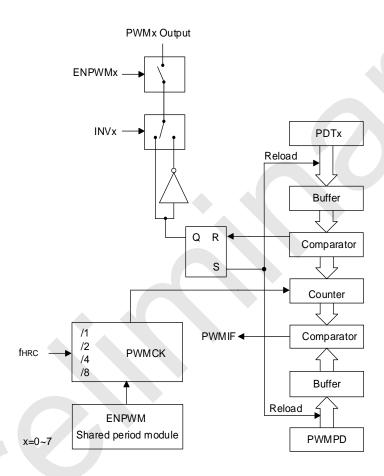
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# 13.3 PWM Independent Mode

In independent mode (PWMMD.1 = 0), the duty cycle of 8 PWM channels can be set independently. The user configures the PWM output status and period, and then configures the duty cycle register of the corresponding PWM channel to output the PWM waveform at a fixed duty cycle.

#### 13.3.1 PWM Independent Mode Block Diagram



SC92L753X PWM Independent mode block diagram

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### 13.3.2 PWM Independent Mode Duty Cycle Configuration

### PWM Duty Cycle Adjustment Register PDTx (Read/Write)

Address	7	6	5	4	3	2	1	0	POR	
0F40H				PDT0	[15:8]				0000000b	
0F41H				PDT	0[7:0]				0000000b	
0F42H		PDT1[15:8]								
0F43H		PDT1[7:0]								
0F44H		PDT2[15:8]								
0F45H		PDT2[7:0]								
0F46H		PDT3[15:8]								
0F47H		PDT3[7:0]								
0F48H				PDT4	[15:8]				0000000b	
0F49H				PDT	4[7:0]				0000000b	
0F4AH				PDT5	[15:8]				0000000b	
0F4BH				PDT	5[7:0]				0000000b	
0F4CH				PDT6	6[15:8]				0000000b	
0F4DH		PDT6[7:0]								
0F4EH		PDT7[15:8]								
0F4FH				PDT	7[7:0]				0000000b	

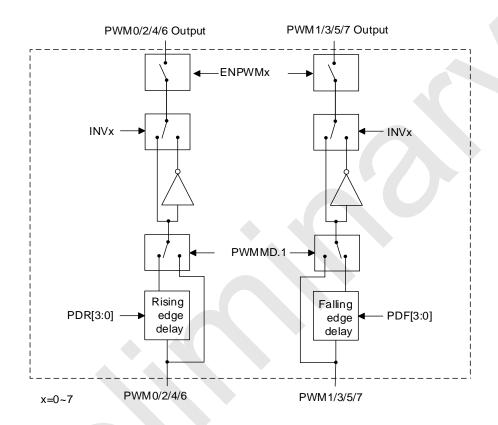
Bit number	Bit Mnemonic	Description
3~0	PDTx [15:8] (x=0~7)	PWMx waveform duty cycle length setting  The high-level width of the PWMx waveform is (PDTx [15: 0]) PWM clocks

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### 13.4 PWM Complementary Model

#### 13.4.1 PWM Block Diagram of Complementary Mode



SC92L753X PWM block diagram of complementary mode

### 13.4.2 PWM Complementary Mode Duty Cycle Configuration

In complementary mode (PWMMD[1: 0] = 1x), PWM0/PWM1, PWM2/PWM3, PWM4/PWM5 and PWM6/PWM7 are divided into four groups, respectively through **PDT0[15:0]**, **PDT2[15:0]**, **PDT4[15:0]** and **PDT6[15:0]** adjust the duty ratio;

In complementary mode, registers PDT1[15:0], PDT3[15:0], PDT5[15:0] and PDT7[15:0] are invalid.

#### PWM Duty Cycle Adjustment Register PDTx (Read/Write)

Address	7	6	5	4	3	2	1	0	POR	
0F40H		PDT0[15:8]								
0F41H		PDT0[7:0]								

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		1
0F42H	PDT1[15:8]	0000000b
0F43H	PDT1[7:0]	0000000b
0F44H	PDT2[15:8]	0000000b
0F45H	PDT2[7:0]	0000000b
0F46H	PDT3[15:8]	0000000b
0F47H	PDT3[7:0]	0000000b
0F48H	PDT4[15:8]	0000000b
0F49H	PDT4[7:0]	0000000b
0F4AH	PDT5[15:8]	0000000b
0F4BH	PDT5[7:0]	0000000b
0F4CH	PDT6[15:8]	0000000b
0F4DH	PDT6[7:0]	0000000b
0F4EH	PD <b>T7</b> [15;8]	0000000b
0F4FH	PDT7[7:0]	0000000b
0F4FH	PD17[7:0]	0000000b

Bit number	Bit Mnemonic	Description
7~0	PDTx [7:0] (x=0,2,4,6)	PWMx and PWMy, y=x+1 port PWM waveform duty cycle length setting
	(11–3,2), 1,0)	The high-level width of the PWM waveform on the Px and Py pins is (PDTx [15: 0]) PWM clocks

### 13.4.3 PWM Complementary Mode Dead Time Setting

When the PWM of the SC92L753X works in complementary mode, the dead zone control module can prevent the effective time zones of the two PWM signals of complementary outputs from overlapping each other, so as to ensure that a pair of complementary power switch tubes driven by PWM signals will not be turned on at the same time.

#### PWMDFR (D6H) PWM Dead Time Setting Register (read/write)

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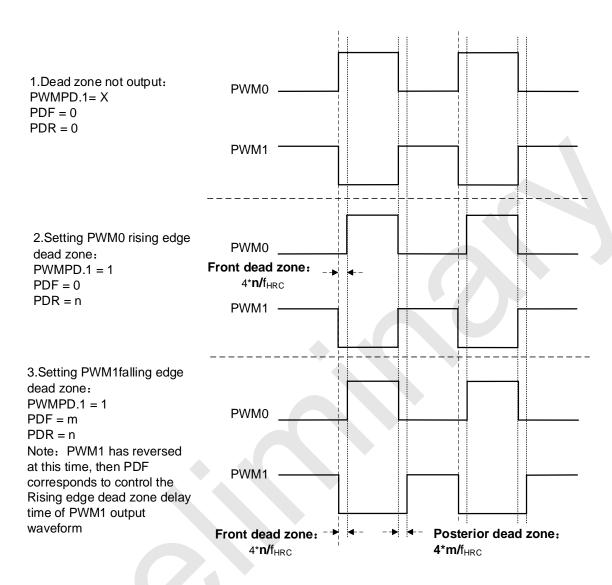
Bit number	7	6	5	4	3	2	1	0	
Bit Mnemonic	PDF[3: 0]				PDR[3: 0]				
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
POR	0	0	0	0	0	0	0	0	

Bit number	Bit Mnemonic	Description
7~4	PDF[3: 0]	Complementary mode:  PWM falling edge dead time= 4*PDF[3: 0] / fhrc
3~0	PDR[3: 0]	Complementary mode:  PWM rising edge dead time= 4*PDR[3: 0] / fhrc

### 13.4.4 PWM Dead Zone Output Waveform

The following figure is based on the PWM0 and PWM1 in the complementary mode of the dead time adjustment waveform, in order to facilitate the distinction, PWM1 has reversed (INV1=1).

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PWM dead zone output waveform

#### 13.5 PWM Waveforms and Directions

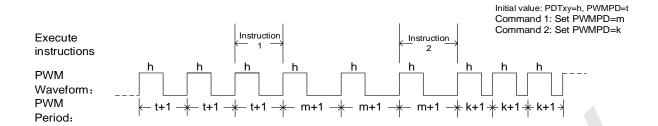
The effect of changing SFR parameters on the PWM waveform is as follows:

1 Duty cycle change characteristics

When the PWMn outputs a waveform, if the duty cycle needs to be changed, it can be achieved by changing the value of the high-level setting register (PDTx). However, it should be noted that if you change the value of PDTx, the duty cycle will not change immediately, but wait until the end of this cycle and change in the next cycle.

② Periodic change characteristics

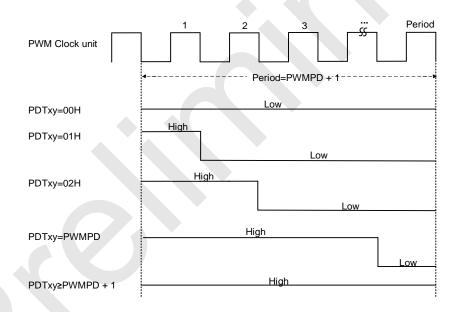
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Periodic change characteristic diagram

When the PWM output waveform, if you need to change the period, you can change the period to set the PWMPD register value to achieve. When you change the PWMPD value, the cycle does not change immediately. Instead, you wait until the end of this cycle and change the next cycle, as shown in the figure above.

#### 3 Relationship between period and duty cycle



Relationship between cycle and duty cycle

The relationship between period and duty cycle is shown in the figure above. The premise of this result is that the PWM output inverse control (INVx, x-0~7) is initially 0. If you want to get the opposite result, you can set INVx to 1.

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### 14 General-purpose I/O (GPIO)

The SC92L753X provides up to 30 bidirectional GPIO ports that can be controlled. The input and output control registers are used to control the input and output status of each port. When the port is used as an input, each I/O port has an internal pull-up resistor controlled by PxPHy. The 30 IOs are multiplexed with other functions. When the I/O port is in the input or output state, the actual state value of the port is read from the port data register.

Note: The unused and unleaded IO ports should be set to strong push-pull output mode.

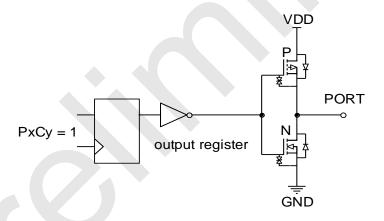
### 14.1 GPIO Structure Diagram

#### **Strong Push-pull Output Mode**

In the strong push-pull output mode, it can provide continuous high-current drive:

- Other than P05/P20/P21, the I/O driver capability is an output greater than 10mA is high, and an output greater than 50mA is low.
- P05/P20/P21 drive can be achieved an output greater than 20mA is high, and an output greater than 50mA is low.

The schematic diagram of the port structure of the strong push-pull output mode is as follows:



Strong push-pull output mode

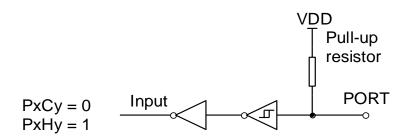
#### **Pull-up Input Mode**

In the pull-up input mode, a pull-up resistor is constantly connected to the input port. Only when the input port is pulled low, the low-level signal is detected.

The schematic diagram of the port structure with pull-up input mode is as follows:

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Input mode with pull-up resistor

#### **High Impedance Input Mode (Input only)**

The schematic diagram of the port structure of the high impedance input mode is as follows:

High impedance input mode

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# 14.2 I/O Port-related Registers

#### P0CON (9AH) P0 Port Input/Output Control Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	P0C7	P0C6	P0C5	P0C4	P0C3	P0C2	P0C1	P0C0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

#### P0PH (9BH) P0 Port pull-up Resistor Control Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	P0H7	P0H6	P0H5	P0H4	P0H3	P0H2	P0H1	Р0Н0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

#### P1CON (91H) P1 Port Input/Output Control Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	P1C7	P1C6	P1C5	P1C4	P1C3	P1C2	P1C1	P1C0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

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#### P1PH (92H) P1 Port Pull-up Resistor Control Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	P1H7	P1H6	P1H5	P1H4	P1H3	P1H2	P1H1	P1H0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

#### P2CON (A1H) P2 Port Input/output Control Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	P2C7	P2C6	P2C5	P2C4	P2C3	P2C2	P2C1	P2C0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

#### P2PH (A2H) P2 Port Pull-up Resistor Control Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	P2H7	P2H6	P2H5	P2H4	P2H3	P2H2	P2H1	P2H0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

P5CON (D9H) P5 Port Input/output Control Register (read/write)

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Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	-	-	P5C5	P5C4	P5C3	P5C2	P5C1	P5C0
R/W	-	-	R/W	R/W	R/W	R/W	R/W	R/W
POR	х	х	0	0	0	0	0	0

### P5PH (DAH) P5 Port Pull-up Resistor Control Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	-		P5H5	P5H4	P5H3	P5H2	P5H1	P5H0
R/W	-	-	R/W	R/W	R/W	R/W	R/W	R/W
POR	х	x	0	0	0	0	0	0

Bit number	Bit Mnemonic	Description
7~0	PxCy (x=0~2, y=0~7; x=5, y=0~5)	Px port input and output control:  0: Pxy is the input mode (initial value at power-on)  1: Pxy is a strong push-pull output mode
7~0	PxHy (x=0~2, y=0~7; x=5, y=0~5)	The Px port pull-up resistor setting is only valid when PxCy=0:  0: Pxy is the high-impedance input mode (initial value at power-up), and the pull-up resistor is turned off;  1: Pxy pull-up resistor is on

#### P0 (80H) P0 Port Data Register (read/write)

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Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	P0.7	P0.6	P0.5	P0.4	P0.3	P0.2	P0.1	P0.0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

#### P1 (90H) P1 Port Data Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	P1.7	P1.6	P1.5	P1.4	P1.3	P1.2	P1.1	P1.0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

### P2 (A0H) P2 Port Data Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	P2.7	P2.6	P2.5	P2.4	P2.3	P2.2	P2.1	P2.0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

#### P5 (D8H) P5 Port Data Register (read/write)

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Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	-	-	P5.5	P5.4	P5.3	P5.2	P5.1	P5.0
R/W	-	-	R/W	R/W	R/W	R/W	R/W	R/W
POR	х	х	0	0	0	0	0	0

Bit number	Bit Mnemonic	Description
7~0	P0.x (x=0~7)	P0 port latch register data
7~0	P1.x (x=0~7)	P1 port latch register data
7~0	P2.x (x=0~7)	P2 port latch register data
5~0	P5.x (x=0~5)	P5 port latch register data

### IOHCON0 (96H) IOH Setting Register 0 (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	P1H	[1: 0]	P1L[	1: 0]	P0H	[1: 0]	P0L[	[1: 0]
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

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	POR	0	0	0	0	0	0	0	0	
--	-----	---	---	---	---	---	---	---	---	--

Bit number	Bit Mnemonic	Description
7~6	P1H[1: 0]	P1 high four IOH settings  00: Set P1 high four IOH level 0 (IO port driver capability maximum);  01: Set P1 high four IOH level 1;  10: Set P1 high four IOH level 2;  11: Set P1 high four IOH level 3 (IO port driver capability minimum);
5~4	P1L[1: 0]	P1 low four IOH settings  00: Set P1 low four IOH level 0 (IO port driver capability maximum);  01: Set P1 low four IOH level 1;  10: Set P1 low four IOH level 2;  11: Set P1 low four IOH level 3 (IO port driver capability minimum);
3~2	P0H[1: 0]	P0 high four IOH settings  00: Set P0 high four IOH level 0 (IO port driver capability maximum);  01: Set P0 high four IOH level 1;  10: Set P0 high four IOH level 2;  11: Set P0 high four IOH level 3 (IO port driver capability minimum);
1~0	P0L[1: 0]	P0 low four IOH settings  00: Set P0 low four IOH level 0 (IO port driver capability maximum);  01: Set P0 low four IOH level 1;  10: Set P0 low four IOH level 2;  11: Set P0 low four IOH level 3 (IO port driver capability minimum);

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### IOHCON1 (97H) IOH Setting Register 1 (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	P5H[1: 0]		P5L[1: 0]		P2H[1: 0]		P2L[1: 0]	
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit number	Bit Mnemonic	Description
7~6	P5H[1: 0]	P3 low four IOH settings
		00: set P54,P55 IOH level 0 (IO port driver capability maximum);
		01: Set P54,P55 IOH level 1;
		10: Set P54,P55 IOH level 2;
		11: Set P54,P55 IOH level 3 (IO port driver capability minimum);
5~4	P5L[1: 0]	P3 low four IOH settings
		00: set P5 low four IOH level 0 (IO port driver capability maximum);
		01: Set P5 low four IOH level 1;
		10: Set P5 low four IOH level 2;
		11: Set P5 low four IOH level 3 (IO port driver capability minimum);
3~2	P2H[1: 0]	P2 high four IOH settings
		00: Set P2 high four IOH level 0 (IO port driver capability maximum);
		01: Set P2 high four IOH level 1;
		10: Set P2 high four IOH level 2;
		11: Set P2 high four IOH level 3 (IO port driver capability minimum);

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1~0	P2L[1: 0]	P2 low four IOH settings
		00: Set P2 low four IOH level 0 (IO port driver capability maximum);
		01: Set P2 low four IOH level 1;
		10: Set P2 low four IOH level 2;
		11: Set P2 low four IOH level 3 (IO port driver capability minimum);
7~6	-	Reserved

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# 15 LCD/LED Display Driver

The SC92L753X integrates hardware LCD/LED display drive circuit inside, which can facilitate users to realize LCD and LED display drive. Its main features are as follows:

- 1. Choose one of LCD and LED display driver;
- 2. LCD and LED display drivers share related IO ports and registers.

#### The LCD display driver functions are as follows:

- 1. 4 display drive modes are available: 8 X 20, 6 X 22, 5 X 23, or 4X 24 segments;
- 2. 2 kinds of offset methods are available: 1/4 Bias and 1/3 Bias;
- 4 levels of COM port drive capability are optional;
- 4. The display drive circuit can choose the built-in 32 kHz LRC or external 32 kHz oscillator as the clock source, the frame frequency is about 64Hz.

Note: If the LCD driver frame frequency is not 64Hz, you are advised to contact sinone technical support for solutions.

#### The LED display driver functions are as follows:

- 4 display drive modes are available: 8 X 20, 6 X 22, 5 X 23, or 4X 24 segments;
- 2. SEG port drive capability is optional in 4 levels;
- 3. The display drive circuit can select the built-in 32 kHz LRC or external 32.768kHz oscillator as the clock source, and the frame frequency is about 64Hz.

### 15.1 LCD/LED Display Drive-related Registers

#### DDRCON (95H) Display Drive Control Register (read/write)

Bit number	7	6	5	4	3	2	1	0	
Bit Mnemonic	DDRON	DMOD	DUTY[1: 0]		VLCD[3: 0]				
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
POR	0	0	0	0	0	0	0	0	

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### **Super High-Speed Flash MCU**

Bit number	Bit Mnemonic	Description
7	DDRON	UCD/LED display drive enable control  0: The display driver scan is turned off  1: The display driver scan is turned on
6	DMOD	LCD/LED display drive mode  0: LCD mode;  1: LED mode
5~4	DUTY[1: 0]	LCD/LED display duty control  00: 1/8 duty cycle, S0~S19 are segments, C0~C7 are common;  01: 1/6 duty cycle, S0~S21 are segments, C0~C5 are common;  10: 1/5 duty cycle, S0~S22 are segments, C0~C4 are common;  11: 1/4 duty cycle, S0~S23 is segment, C0~C3 is common, or S0~S19 is segment, C4~C7 is common
3~0	VLCD[3: 0]	LCD voltage regulation  VLCD=V <sub>DD</sub> *(17+VLCD[3: 0])/32

### P0VO (94H) P0 Port Display Driver Output Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	P07VO	P06VO	P05VO	P04VO	P03VO	P02VO	P01VO	P00VO
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

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### **Super High-Speed Flash MCU**

Bit number	Bit Mnemonic	Description
7~0	P0Nvo	Open P0n port display driver output
		0: Disable the display driver output function of P0n port
		1: Enable the display driver output function of P0n port

#### P1VO (93H) P1 Port Display Driver Output Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	-	-	P17VO	P16VO	P15VO	P14VO	P13VO	P10VO
R/W	-	-	R/W	R/W	R/W	R/W	R/W	R/W
POR	Х	Х	0	0	0	0	0	0

Bit number	Bit Mnemonic	Description
5~0	P1nVO	Open P1n port display driver output
		O: Disable the display driver output function of P1n port  1: Enable the display driver output function of P1n port
7~6	-	Reserved

### P2VO (A3H) P2 Port Display Driver Output Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	P27VO	P26VO	P25VO	P24VO	P23VO	P22VO	P21VO	P20VO

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| R/W |
|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| POR | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   |

Bit number	Bit Mnemonic	Description
7~0	P2nVO	Open P2n port display driver output
		0: Disable the display driver output function of P2n port
		1: Enable the display driver output function of P2n port

### P5VO (DBH) P5 Port Display Driver Output Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	-	-	P55VO	P54VO	P53VO	P52VO	P11VO	P12VO
R/W	-	-	R/W	R/W	R/W	R/W	R/W	R/W
POR	X	X	0	0	0	0	0	0

Bit number	Bit Mnemonic	Description
5~2	P5nVO	Open P5n port display driver output  0: Disable the display driver output function of P5n port  1: Enable the display driver output function of the P5n port
1~0	P1nVO	Open P1n port display driver output  0: Disable the display driver output function of P1n port

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	1: Enable the display driver output function of the P1n port

#### OTCON (8FH) Output Control Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	USMD1[1: 0]		USMD0[1: 0]		VOIRS[1: 0]		scs	BIAS
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit number	Bit Mnemonic	Description
3~2	VOIRS[1: 0]	LCD voltage output port voltage divider resistance selection 00: Set the total resistance of the internal voltage divider to be $100k\Omega$ 01: Set the total resistance of the internal voltage divider resistor to $200k\Omega$ 10: Set the total resistance of the internal voltage divider to $400k\Omega$ 11: Set the total resistance of the internal voltage divider to $800k\Omega$ Each time Common is switched, the first 1/16 time is fixed to select a $100k$ resistor, and the last $15/16$ time is switched to the resistance value
1	scs	selected by VORIS  LCD/LED Segment/Common multiplex pin selection  0: When set to 1/4 duty cycle, S0~S23 are segments and C0~C3 are common  1: When set to 1/4 duty cycle, S0~S19 are segments and C4~C7 are common
0	BIAS	LCD display drive bias voltage setting:  0: 1/4 bias voltage;

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	1: 1/3 bias voltage

# 15.2 LCD/LED Display RAM Configuration

Address	7	6	5	4	3	2	1	0
	СОМ7	СОМ6	COM5	COM4	СОМЗ	COM2	COM1	СОМО
0F00H	SEG0							
0F01H	SEG1							
0F02H	SEG2							
0F03H	SEG3							
0F04H	SEG4							
0F05H	SEG5							
0F06H	SEG6							
0F07H	SEG7							
0F08H	SEG8							
0F09H	SEG9							
0F0AH	SEG10							
0F0BH	SEG11							
0F0CH	SEG12							
0F0DH	SEG13							

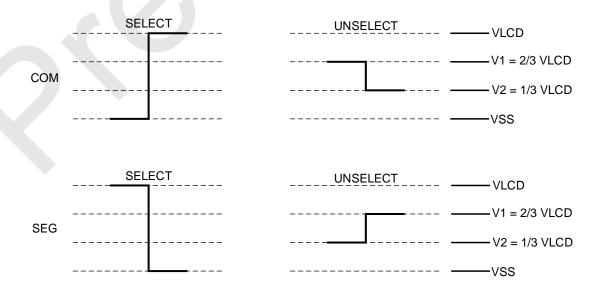
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| 0F0EH | SEG14 |
|-------|-------|-------|-------|-------|-------|-------|-------|-------|
| 0F0FH | SEG15 |
| 0F10H | SEG16 |
| 0F11H | SEG17 |
| 0F12H | SEG18 |
| 0F13H | SEG19 |
| 0F14H | SEG20 |
| 0F15H | SEG21 |
| 0F16H | SEG22 |
| 0F17H | SEG23 |

#### 15.3 LCD Waveform

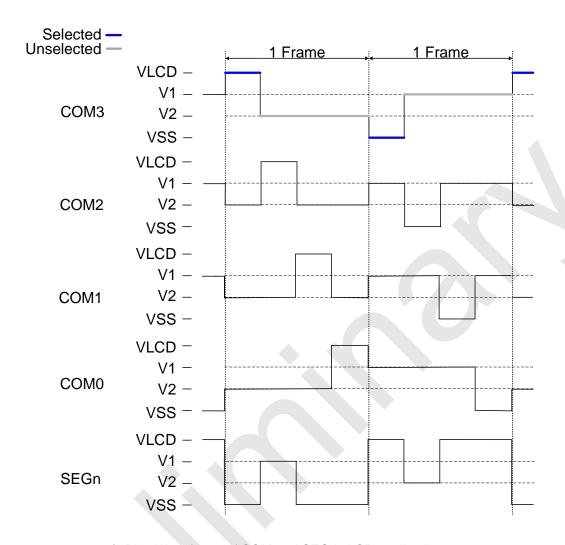
#### 15.3.1 1/3Bias LCD Waveform



1/3 Bias LCD Gated and non-gated voltages

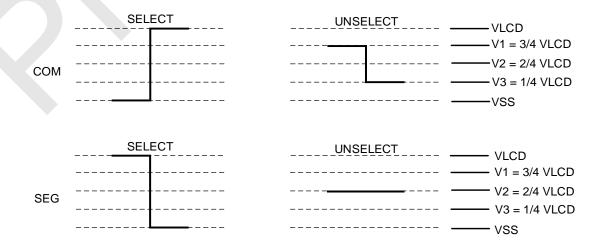
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1/3 Bias Waveforms of COM and SEG in LCD applications

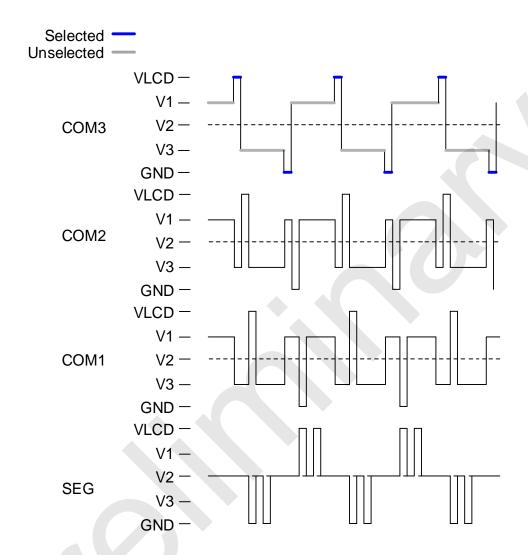
#### 15.3.2 1/4Bias LCD Waveform



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#### 1/4 Bias LCD Gated and non-gated voltages

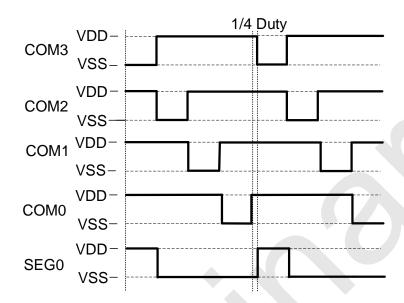


1/4 Bias Waveforms of COM and SEG in LCD applications

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#### 15.4 LED Waveform



Waveforms of COM and SEG in LED applications

#### 15.5 LCD/LED Example

#### 15.5.1 LCD Configuration Demo Program

unsigned char xdata LCDRAM[30] \_at\_ 0x2000;

unsigned char lcd\_addr;

unsigned char lcd\_data;

DDRCON |= 0x00; //0: LCD mode 1: LED mode

DDRCON |= 0x30; //1/4 Duty cycle

DDRCON  $\mid = 0x07$ ; // VLCD= $V_{DD}*3/4$ 

DDRCON |= 0x80; // Display driver scan on

P0VO = 0xFF; // Open the display driver output function

P1VO = 0x3F;

P2VO = 0xFF;

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P5VO = 0x3F;

OTCON = 0x06; // Set the total resistance of the internal voltage divider resistor to  $200K\Omega$ 

//1/4 Bias voltage; S0~S19 is segment,C4~C7 is common

LCDRAM[lcd\_addr] = lcd\_data; /Write the value to be displayed to the LCD RAM

#### 15.5.2 LED Configuration Demo Program

unsigned char xdata LEDRAM[30] \_at\_ 0x1000;

unsigned char led\_addr;

unsigned char led\_data;

DDRCON |= 0x4F; //0: LCD mode1 : LED mode

//LED mode; 1/8 Duty cycle

//S4~S27 is segment, C0~C7 is common;

DDRCON |= 0x80; // Display driver scan on

IOHCON0 = 0xC0; // Set P1 high four IOH level 3 (minimum), other pins IOH level 0

(maximum)

IOHCON1 = 0x00;

P0VO = 0xFF; // Open the display driver output function

P1VO = 0x3F;

P2VO = 0xFF;

P5VO = 0x3F;

OTCON = 0x00;

LCDRAM[led\_addr] = led\_data; //Write the value to be displayed to the LED RAM

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# **16 SERIAL INTERFACE (UART0)**

The SC92L753X supports a full-duplex serial port, which can be conveniently used for connection with other devices or equipment, such as Wifi module circuit or other UART communication interface driver chip. The functions and features of UART0 are as follows:

- 1. Three communication modes are available: Mode 0, Mode 1 and Mode 3;
- 2. Can choose Timer 1 or Timer 2 as the baud rate generator;
- 3. Interrupt RI/TI can be generated after transmission and reception are completed, and the interrupt flag needs to be cleared by software.

#### SCON (98H) Serial Control Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	SM0	SM1	SM2	REN	TB8	RB8	TI	RI
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit number	Bit Mnemonic	Description
7~6	SM0~1	<ul> <li>Serial communication mode control bit</li> <li>00: Mode 0, 8-bit half-duplex synchronous communication mode, serial data is sent and received on the RX pin. The TX pin is used as the transmit shift clock. 8 bits are sent and received per frame, the low bit is received or sent first;</li> <li>01: Mode 1, 10-bit full-duplex asynchronous communication, consisting of 1 start bit, 8 data bits and 1 stop bit, the communication baud rate is variable;</li> <li>10: reserved;</li> <li>11: Mode 3, 11-bit full-duplex asynchronous communication, consisting of 1 start bit, 8 data bits, a programmable 9th bit, and 1 stop bit. The communication baud rate is variable.</li> </ul>
5	SM2	Serial communication mode control bit 2, this control bit is only valid for mode 3

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		0: set RI to generate an interrupt request every time a complete data frame is received;  1: When a complete data frame is received, RI will be set to generate an interrupt request only when RB8=1.  The baud rate override setting bit is only valid in mode 0 (SM0~1 = 00):  0: The serial port runs at 1/12 of the system clock  1: The serial port runs at 1/4 of the system clock
4	REN	Receive enable control bit  0: data reception is not allowed;  1: Allow receiving data.
3	TB8	Only valid for mode 3, which is the 9th bit of the transmitted data
2	RB8	Only valid for mode 3, the 9th bit of the received data
1	TI	Transmit interrupt flag
0	RI	Receive interrupt flag

### SBUF (99H) Serial Data Buffer Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	SBUF[7: 0]							
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit number	Bit Mnemonic	Description
------------	--------------	-------------

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7~0	SBUF[7: 0]	Serial data buffer register	
		SBUF contains two registers: a transmit shift register and a receive latch. The data written to SBUF will be sent to the transmit shift register and start the transmission process. Reading SBUF will return the contents of the receive latch.	

#### PCON (87h) Power Management Control Register (write only, \*unreadable\*)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	SMOD	-	-	-	RST		STOP	IDL
R/W	-\write only	-	-	-	Write only		Write only	Write only
POR	0	х	х	х	n	х	0	0

Bit number	Bit Mnemonic	Description
7~0	SBUF[7: 0]	When SM0~1 = 01 (UART0 mode 1) or SM0~1 = 11 (UART0 mode 3), the baud rate is set to bit:
		0: the serial port runs at 1/fsys
		1: indicates that the serial port runs at 16/fsys

#### 16.1 Baud Rate of Serial Communication

In mode 0, the baud rate can be programmed to 1/12 or 1/4 of the system clock:

- 1. SM2=0, the serial port runs at 1/12 of the system clock;
- 2. SM2=1, the serial port runs at 1/4 of the system clock.
- In modes 1 and 3, the serial port clock source can be programmed as either 1 or 16 of the system clock, determined by SMOD(pcon.7) bits. When SMOD is 0, the serial port runs at 1/fsys. When SMOD is 1, the serial port runs at 16/fsys. After the serial port clock source is determined, set the baud rate overflow rate by Timer 1 or Timer 2:When TCLK(TXCON. 4) and RCLK(TXCON. 5) bits are both 0, then timer 1 is baud rate generator mode, and the baud rate overflow rate of UART0 is set by [TH1,TL1]. The formula is as follows, note: When timer 1 acts as a baud rate generator, timer 1 must stop counting, i.e. TR1=0:

■ SMOD = 0: BaudRate=fsys/([TH1,TL1]); (Note: [TH1, TL1] must be bigger than 0x0010)

■ SMOD = 1: BaudRate= 1/16 \* fsys/([TH1,TL1]);

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- When TCLK(TXCON. 4) or RCLK(TXCON. 5) is 1, then timer 2 is in baud rate generator mode, and the baud rate overflow rate of UART0 is set by [RCAP2H, RCAP2L], the formula is as follows:
  - SMOD = 0: BaudRate=fsys/[RCAP2H,RCAP2L]; Note: [RCAPXH, RCAPXL] must be bigger than 0x0010)

■ SMOD = 1: BaudRate= 1/16 \* fsys/[RCAP2H,RCAP2L];

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# 17 SPI/TWI/UART Serial Interface (USCI0/1/2)

Symbol	Address	Description	7	6	5	4	3	2	1	0	POR
US0CO N0	95H	USCI0 control register 0		US0CON0[7: 0]				0000000 0b			
US0CO N1	9DH	USCI0 control register 1				US0CO	N1[7: 0]				0000000 0b
US0CO N2	9EH	USCI0 control register 2				US0CO	N2[7: 0]				0000000 0b
US0CO N3	9FH	USCI0 control register 3				US0CO	N3[7: 0]				0000000 0b
US1CO N0	A4H	USCI1 control register 0		US1CON0[7: 0]					0000000 0b		
US1CO N1	A5H	USCI1 control register 1		US1CON1[7: 0]					0000000 0b		
US1CO N2	A6H	USCI1 control register 2				US1CO	N2[7: 0]				0000000 0b
US1CO N3	A7H	USCI1 control register 3				US1CO	N3[7: 0]				0000000 0b
US2CO N0	C4H	USCI2 control register 0				US2CO	N0[7: 0]				0000000 0b
US2CO N1	С5Н	USCI2 control register 1	US2CON1[7: 0]		0000000 0b						
US2CO N2	С6Н	USCI2 control register 2	US2CON2[7: 0]			0000000 0b					
US2CO N3	C7H	USCI2 control register 3				US2CO	N3[7: 0]				0000000 0b

The SC92L753X internally integrates 3 three-select one universal serial circuits interface (referred to as USCI), which can facilitate the connection between MCU and devices or equipment with different interfaces. The user

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can configure the USCI interface to any one of SPI, TWI and UART through the USMD1[1: 0], USMD0[1: 0] bits of the configuration register OTCON, or the USMD2[1: 0] bits of TMCON. Its characteristics are as follows:

- 1. When USCI0 is set to SPI0, the output drive capability is enhanced, which is consistent with common I/O features in other modes
- SPI mode can be configured as one of master mode or slave mode, with 8-bit or 16-bit transmission mode
- 3. TWI mode communication can be configured as master mode or slave mode
- 4. UART modes can work in: Mode 0: 8-bit half-duplex synchronous communication, Mode 1: 10-bit full-duplex asynchronous communication and Mode 3: 11-bit full-duplex asynchronous communication

The specific configuration method is as follows:

#### OTCON (8FH) Output Control Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	USMD	1[1: 0]	USMD	0[1: 0]			1	-
R/W	R/W	R/W	R/W	R/W	-	-	-	-
POR	0	0	0	0	Х	X	Х	Х

Bit number	Bit Mnemonic	Description
7~6	USMD1[1: 0]	USCI1 Communication mode control bit  00: USCI1 close  01: USCI1 Set to SPI communication mode;  10: USCI1 Set to TWI communication mode;  11: USCI1 Set to UART communication mode;
5~4	USMD0[1: 0]	USCI0 Communication mode control bit  00: Reserved;  01: USCI0 Set to SPI communication mode;

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10: USCI0 Set to TWI communication mode;
11: USCI0 Set to UART communication mode;

#### TMCON (8EH) Timer Frequency Control Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	USMD2[1: 0]		-	-	-	- (	T1FD	TOFD
R/W	R/W	R/W	-	-	-		R/W	R/W
POR	0	0	х	X	x	x	0	0

Bit number	Bit Mnemoni c	Description
		USCI2 Communication mode control bit
		00: USCI2 close
7~6	USMD2[ 1: 0]	01: USCI2 set to SPI communication mode;
		10: USCI2 set to TWI communication mode;
		11: USCI2 set to UART communication mode;

#### Note:

A USCI interface can be set to different communication modes by USMD, each of which has a corresponding operation register group. The control register groups in different communication modes share the same mapped address, but the operations among the groups are independent. Setting the control register in one communication mode does not affect the values in the register groups in other communication modes.

#### For example:

- Set USMD1 = 01, USCI0 is SPI communication interface, in this mode set US0CON0 (9CH) = 0x80H;
- Then set USMD1 =11, USCI0 is the UART communication interface, set US0CON0 (9CH) = 0x0FH;

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- Then set USMD1 = 01, USCI0 is set back to SPI communication interface, read US0CON0 (9CH) in this mode, should be 0x80H;
- Then set USMD1 =11, USCI0 is set back to the UART communication interface, and US0CON0 (9CH) is read in this mode, which should be 0x0FH.

#### 17.1 SPI

Serial Peripheral Device Interface (SPI for short) is a high-speed serial communication interface that allows the MCU to perform full-duplex, synchronous serial communication with peripheral devices (includi5g other MCUs).

#### 17.1.1 SPI Operation Related Registers

USMDn[1: 0] = 01,  $n=0\sim5$ , select one of three serial interface USCI is configured as SPI interface:

- USTXn as MOSI signal
- USRXn as MISO signal
- USCKn as CLK signal

SPI0/1/2 can be set to master mode or slave mode

US0CON0 (95H) SPI0 control register (read/write)

US1CON0 (A4H) SPI1 control register (read/write)

US2CON0 (C4H) SPI2 control register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	SPEN		MSTR	CPOL	СРНА	SPR2	SPR1	SPR0
R/W	R/W	,	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	х	0	0	0	0	0	0

Bit number	Bit Mnemonic	Description
7	SPEN	SPI Enable control
		0: close SPI

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		1: open SPI
5	MSTR	SPI master-slave selection
		0: SPI is slave device
		1: SPI is master device
4	CPOL	Clock polarity control bit
		0: SCK is low in idle state
		1: SCK is high in idle state
3	СРНА	Clock phase control bit
		0: Collect data on the first edge of the SCK cycle
		1: Collect data on the second edge of the SCK cycle
2~0	SPR[2: 0]	SPI Clock rate selection bit
		000: fsys
		001: fsys/2
		010: fsys/4
		011: fsys/8
		100: fsys/16
		101: fsys/32
		110: fsys/64
		111: fsys/128
		Note: The clock rate of SPI1 and SPI2 is up to 16MHz, but when the load on the communication interface line increases, the waveform output from the port will be distorted, resulting in abnormal communication sequence. Therefore, when the communication rate of SPI1 or SPI2 exceeds 10MHz, users need to consider the load on the interface line to ensure normal communication
1	-	Reserved

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US0CON1 (9DH) SPI0 Status Register (read/write)

US1CON1 (A5H) SPI1 Status Register (read/write)

US2CON1 (C5H) SPI2 Status Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	SPIF	WCOL	-	-	-	DORD	SPMD	TBIE
R/W	R/W	R/W	-	-	-	R/W	R/W	R/W
POR	0	0	х	х	х	0	0	0

Bit number	Bit Mnemonic	Description
7	SPIF	SPI data transmission flag  0: Cleared by software  1: Indicates that data transmission has been completed, set by hardware
6	WCOL	Write conflict flag  0: Cleared by software, indicating that the write conflict has been processed  1: Set by hardware to indicate that a conflict is detected  Transmission direction selection bit
2	DORD	Transmission direction selection bit  0: MSB first sent  1: LSB first sent
1	SPMD	SPI transmission mode selection:  0: 8-bit mode

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		1: 16-bit mode
	TBIE	Interrupt enable bit when the send cache is empty:
		0: When TXE=1, interrupts are not allowed
		1: When TXE=1, SPI interrupt is generated
5~3	-	Reserved

US0CON2 (9EH) SPI0 Data register low byte (read/write)

US1CON2 (A6H) SPI1 Data register low byte (read/write)

US2CON2 (C6H) SPI2 Data register low byte (read/write)

Bit number	7	6	5	4	3	2	1	0	
Bit Mnemonic	SPD[7: 0]								
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
POR	0	0	0	0	0	0	0	0	

Bit number	Bit Mnemonic	Description
7~0	SPD[7: 0]	SPI data buffer register low byte (8/16 bit mode)  Low byte of data written to data register SPD  Read data low byte of data register SPD

US0CON3 (9FH) SPI0 Data register high byte (read/write)

US1CON3 (A7H) SPI1 Data register high byte (read/write)

US2CON3 (C7H) SPI2 Data register high byte (read/write)

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Bit number	7	6	5	4	3	2	1	0	
Bit Mnemonic	SPD[15: 8]								
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
POR	0	0	0	0	0	0	0	0	

Bit number	Bit Mnemonic	Description
7~0	SPD[15: 8]	SPI data buffer register high byte (only for 16-bit mode)
		High byte of data written to data register SPD
		Read data high byte of data register SPD
		Note: When SPI is set to 16-bit mode, you must write the high byte first, then write the low byte, for SPI1~2, and start sending immediately after the low byte is written

#### 17.1.2 Signal Description

#### Master-Out/Slave-In (MOSI):

This signal connects the master device and a slave device. Data is serially transmitted from the master device to the slave device through MOSI, the master device outputs, and the slave device inputs.

#### Master-In and Slave-Out (MISO):

This signal connects the slave device and the master device. Data is serially transmitted from the slave device to the master device through MISO, the slave device is output, and the master device is input. When the SPI is configured as a slave device and not selected, the MISO pin of the slave device is in a high impedance state.

#### SPI Serial Clock (SCK):

The SCK signal is used to control the synchronous movement of input and output data on the MOSI and MISO lines. A byte is transmitted on the wire every 8 clock cycles. If the slave is not selected, the SCK signal is ignored by the slave.

#### 17.1.3 Operating Modes

SPI can be configured as one of master mode or slave mode. The configuration and initialization of the SPI module are completed by setting the SPI control register USnCON0 (n=1~2) and the SPI status register USnCON1. After

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the configuration is completed, the data transfer is completed by setting the SPI data registers SPD.

During SPI communication, data is shifted in and out serially synchronously. The serial clock line (SCK) keeps the movement and sampling of data on the two serial data lines (MOSI and MISO) synchronized. If the slave is not selected, it cannot participate in activities on the SPI bus.

When the SPI master device transmits data to the slave device through the MOSI line, the slave device sends the data to the master device as a response via the MISO line, which realizes the synchronous full-duplex transmission of data sending and receiving under the same clock. The sending shift register and the receiving shift register use the same special function address. Writing to the SPI data register SPD will write to the sending shift register, and reading the SPD will get the data of the receiving shift register.

The SPI interface of some devices will lead to the SS pin (slave device selection pin, active low). When communicating with the SPI of the SC92L753X, the connection mode of the SS pin of other devices on the SPI bus needs to be connected according to different communication modes. The following table lists the connection modes of the SS pin of other devices on the SPI bus in different SPI communication modes of the SC92L753X:

SC92L753X SPI	Other devices on the SPI bus	Mode	Slave SS (Slave selection pin)
Master mode	Slave mode	One master and one slave	Pull down
		One master and multiple slaves	The SC92L753X leads to multiple I/Os, which are connected to the SS pin of the slave. Before data transmission, the SS pin of the slave device must be set low
Slave mode	Master mode	One master and one slave	Pull up

#### **Master Mode**

#### • Mode Startup:

The SPI master device controls the start of all data transfers on the SPI bus. When the MSTR bit in the SPI control register USnCON0(n=1,2) is set to 1, the SPI runs in the master mode and only one master device can start the transfer.

#### Transmitting:

In SPI master mode, perform the following operations on SPD: write a byte of data to SPDL in 8-bit mode or write the high byte to SPDH first, and then write the low byte to SPDL in 16-bit mode, the data will be written to the transmit shift buffer. If there is already a data in the transmit shift register, the main SPI generates a WCOL signal to indicate that the write is too fast. But the data in the transmission shift register will not be affected, and the transmission will not be interrupted. In addition, if the transmission shift register is empty, the master device immediately shifts the data in the transmission shift register to the MOSI line in accordance with the SPI clock frequency on SCK. When the transfer is complete, the SPIF bit in the SPI status register

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USnCON1 is set to 1. If the SPI interrupt is enabled, an interrupt will also be generated when the SPIF bit is set.

#### • Receiving:

When the master device transmits data to the slave device through the MOSI line, the corresponding slave device also transmits the contents of its transmitting shift register to the receiving shift register of the master device through the MISO line, realizing full-duplex operation. Therefore, the SPIF flag set 1 means that the transmission is complete and the data is received. The data received by the slave device is stored in the receive shift register of the master device according to the MSB or LSB first transmission direction. When a byte of data is completely moved into the receive register, the processor can obtain the data by reading the SPD.

#### Slave mode

#### Mode Startup:

When the MSTR bit in the SPI control register USnCON0 register is cleared to 0, SPI runs in slave mode.

#### • Transmitting and Receiving:

In slave mode, according to the SCK signal controlled by the master device, data is shifted in through the MOSI pin, and the MISO pin is shifted out. A bit counter records the number of edges of SCK. When the receiving shift register shifts in 8-bit data (one byte) and the sending shift register shifts out 8-bit data (one byte), the SPIF flag bit is set to 1. The data can be obtained by reading the SPD register. If the SPI interrupt is enabled, an interrupt will also be generated when SPIF is set. At this time, the receiving shift register keeps the original data and the SPIF bit is 1, so that the SPI slave device will not receive any data until SPIF is cleared. The SPI slave device must write the data to be transmitted into the transmit shift register before the master device starts a new data transmission. If no data is written before starting to send, the slave device will transmit the "0x00" byte to the master device. If the SPD write operation occurs during the transfer, the WCOL flag of the SPI slave device is set to 1, that is, if the transfer shift register already contains data, the WCOL bit of the SPI slave device is set to 1, indicating that the write SPD conflicts. But the data of the shift register is not affected, and the transmission will not be interrupted.

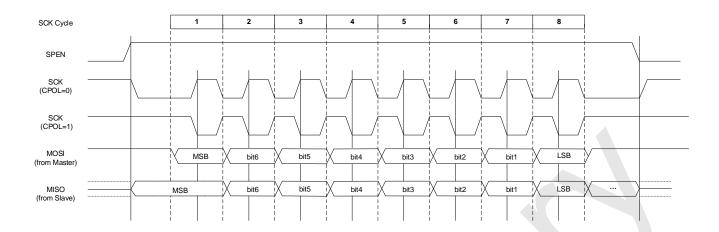
#### 17.1.4 Transfer Form

By software setting the CPOL bit and CPHA bit of the SPI control register USnCON0(n=1,2), the user can select four combinations of SPI clock polarity and phase. The CPOL bit defines the polarity of the clock, that is, the level state when idle, and it has little effect on the SPI transmission format. The CPHA bit defines the phase of the clock, that is, defines the clock edge that allows data sampling and shifting. In the two devices of master-slave communication, the setting of the clock polarity phase should be the same.

When CPHA = 0, the first edge of SCK captures data, and the slave must prepare the data before the first edge of SCK.

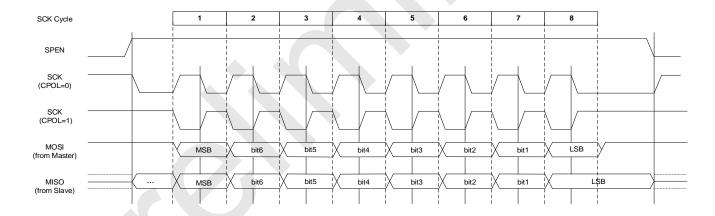
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CPHA = 0 Data transfer diagram

When CPHA = 1, the master device outputs data to the MOSI line on the first edge of SCK, the slave device uses the first edge of SCK as the sending signal, and the second edge of SCK starts to capture data, So the user must write SPD inside two edges of the first SCK. This form of data transmission is the preferred form of communication between a master device and a slave device.



CPHA = 1 Data transfer diagram

#### 17.1.5 Error Detection

Writing to SPD during the data transmission sequence will cause a write conflict, and the WCOL bit in the SPI status register USnCON1 is set to 1. WCOL bit 1 will not cause interruption, and transmission will not be aborted. The WCOL bit needs to be cleared by software.

### 17.2 TWI

USMDn[1: 0] = 10,n=0~2 One of three serial interface USCI is configured as TWI interface:

- USTXn as SDA signal
- USCKn as CLK signal

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The SC92L753X can be set as master or slave mode according to application requirements during TWI communication.

### US0CON0 (95H) TWI0 Control Register 0 (read/write)

#### US1CON0 (A4H) TWI1 Control Register 0 (read/write)

#### US2CON0 (C4H) TWI2 Control Register 0 (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	TWEN	TWIF	MSTR	GCA	AA	STATE[2: 0]		
R/W	R/W	R/W	Read	Read	R/W	Read	Read	Read
POR	0	0	0	0	0	0	0	0

Bit number	Bit Mnemonic	Description
7	TWEN	TWI enable control  0: Disable TWI
		1: Enable TWI
6	TWIF	TWI interrupt flag  1. Cleared by software  2. Under the following conditions, the interrupt flag bit is set by hardware:  1) Master mode:  ① Send start signal ② After sending the address frame ③ Receive or send the data frame  2) Slave mode:

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	1	
		① The first frame address matches successfully
		② Successfully receive or send 8-bit data
		Receive repeated start condition
		The slave receives a stop signal
5	MSTR	Master-slave flag
		0: Slave mode
		1: Master mode
		Description:
		1. When the TWI interface sends a start condition to the bus, it will automatically switch to the master mode, and the hardware will set this bit at the same time;
		2. When a stop condition is detected on the bus, the hardware clears this bit.
4	GCA	General address response flag
		0: Non-response general address
		1: When GC is set to 1 and the general address matches at the same time, this bit is set to 1 by hardware and automatically cleare
3	AA	Answer enable bit
		0: No response, return UACK (the response bit is high)
		1: After receiving a matching address or data, a response ACK is returned
2~0	STATE[2: 0]	State machine status flag
		Slave mode:
		000: The slave is in the idle state, waiting for TWEN to be set to 1, and detecting the TWI start signal. When the slave receives the stop condition, the jump will go to this state
		001: The slave is receiving the first frame address and read/write bit (the 8th bit is the read/write bit, 1 is read, and 0 is write). The slave will jump to this state after receiving the start condition
		010: Slave receiving data status
		to this state after receiving the start condition

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011: slave sending data status

100: In the state of sending data from the slave, when the master returns to UACK, it jumps to this state and waits for a restart signal or a stop signal.

101: When the slave is in the sending state, writing 0 to AA will enter this state, waiting for a restart signal or a stop signal.

110: If the address of the slave does not match the address sent by the master, it will jump to this state and wait for a new start condition or stop condition.

#### Master mode:

000: The state machine is idle

001: The Master sends the start condition or the Master is sending the slave device address

010: Master sends data

011: Master receives data

100: The master sends a stop condition or receives a UACK signal from the slave

#### US0CON1 (9DH) TWI0 Control Register 1 (read/write)

#### US1CON1 (A5H) TWI1 Control Register 1 (read/write)

#### US2CON1 (C5H) TWI2 Control Register 1 (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	TXnE/ RXnE	STRETCH	STA	STO	TWCK[3: 0]			
R/W	Read Only	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

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Bit number	Bit Mnemonic	Description
7	TXnE/RXnE	Send/receive complete flag
		In the following situations, TXnE/RXnE is set to 1
		Master mode:
		① The Master sends an address frame (write) and receives an ACK from the slave
		② The master sends the data and receives the slave ACK
		③ The Master receives the data, and the Master returns an ACK to the slave
		Slave mode:
		① The slave receives the address frame (read), and it matches the slave address (TWA)
		② The slave receives the data, and the slave returns an ACK to the master
		③ The slave sends the data and receives the master ACK (AA=1)
		Reading and writing to TWIDAT will clear this flag.
6	STRETCH	Allow clock extension (slave mode)
		0: disable clock extension
		Allow clock extension, the Master needs to support the clock extension function
		Description: After the data transmission is completed, and ACK is 0, clock stretching occurs at this time
5	STA	Start bit
		Set "1" to generate start condition, TWI will switch to Master mode
		Software can set or clear this bit, or it can be cleared by hardware when the start condition is issued.
4	sто	Master mode stop bit

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		Set to "1" in the Master mode, a stop condition will be generated after the current byte is transmitted or the start condition is sent  Software can set or clear this bit, or it can be cleared by hardware when a stop condition is detected.
3~0	TWCK[3: 0]	TWI communication rate setting in Master mode:
		0000: f <sub>sys</sub> /1024
		0001: fsys/512
		0010: f <sub>SYS</sub> /256
		0011: f <sub>sys</sub> /128
		0100: f <sub>sys</sub> /64
		0101: fsys/32
		0110: f <sub>sys</sub> /16
		Others: Reserved
		Note:
		The setting is invalid in slave mode. The maximum clock frequency is 400 kHz;
7	-	Reserved

US0CON2 (9EH) TWI0 Address Register (read/write)

US1CON2 (A6H) TWI1 Address Register (read/write)

US2CON2 (C6H) TWI2 Address Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	TWA[6: 0]					GC		
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

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Bit number	Bit Mnemonic	Description
7~1	TWA[6: 0]	TWI address register  TWA[6: 0] cannot be written as all 0s, 00H is dedicated to general address addressing. Invalid setting in Master mode
0	GC	TWI general address enable  0: Forbid to respond to general address 00H  1: Allow response to general address 00H

US0CON3 (9FH) TWI0 Data Buffer Register (read/write)

US1CON3 (A7H) TWI1 Data Buffer Register (read/write)

US2CON3 (C7H) TWI2 Data Buffer Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic		TWDAT[7: 0]						
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit number	Bit Mnemonic	Description
7~0	TWDAT[7: 0]	TWI Data buffer register

### 17.2.1 Signal Description

TWI Clock Signal Line(SCL)

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The clock signal is sent by the master and connected to all slaves. One byte of data is transmitted every 9 clock cycles. The first 8 cycles are used for data transmission, and the last clock is used as the receiver's response clock. It should be high when it is idle, pulled up by the pull-up resistor on the SCL line.

#### TWI Data Signal Line(SDA)

SDA is a bidirectional signal line, which should be high when it is idle, and is pulled high by the pull-up resistor on the SDA line.

#### 17.2.2 Slave Operating Mode

#### Mode Start:

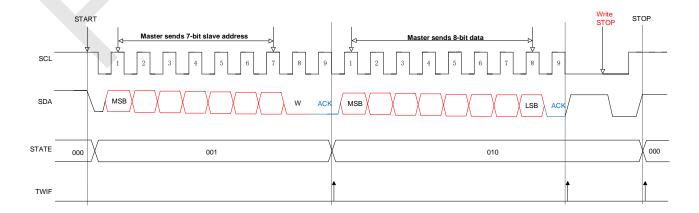
When the TWI enable flag is turned on (TWEN = 1) and the start signal sent by the Master is received at the same time, the mode is started.

The slave enters the state of receiving the first frame address (STATE[2: 0] = 001) from the idle mode (STATE[2: 0] = 000), and waits for the first frame of data from the master. The first frame of data is sent by the Master, including 7-bit address bits and 1 bit for reading and writing. All slaves on the TWI bus will receive the first frame of data from the Master. The Master releases the SDA signal line after sending the first frame of data. If the address sent by the Master is the same as the value in a slave's own address register, it means that the slave is selected. The selected slave will judge the 8th bit on the bus, that is, the data read and write bit (=1, read command) ;=0, write command), then occupy the SDA signal line, give the Master a low-level response signal in the 9th clock cycle of SCL, and then release the bus. After the slave is selected, it will enter different states according to the different read and write bits:

#### Non-general Address Response, Slave Device Receiving Mode:

If the read/write bit received in the first frame is write (0), the slave enters the slave receiving state (STATE[2: 0] = 010) and waits for the data sent by the Master. The master must release the bus every time it sends 8 bits and wait for the response signal from the slave in the 9th cycle.

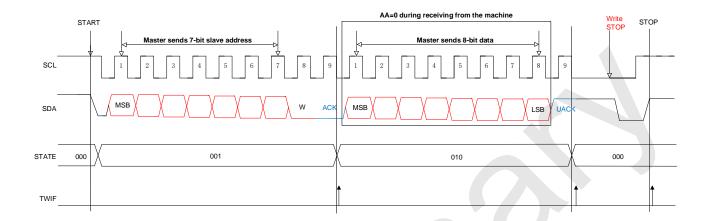
- 1. If the response signal of the slave is low, the communication of the master can be in the following three ways:
  - Continue to send data;
  - 2) Resend the start signal (start), at this time the slave re-enters the state of receiving the first frame address (STATE[2: 0] = 001);
  - 3) Send a stop signal to indicate the end of this transmission, and the slave returns to the idle state, waiting for the next start signal from the Master.



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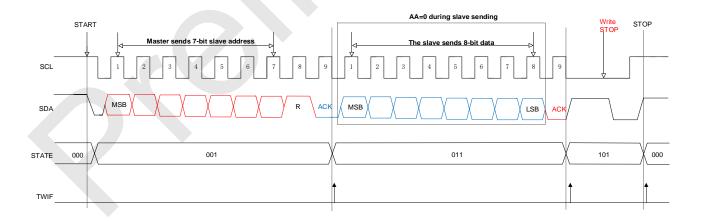
2. If the slave responds to a high level (during the receiving process, the AA value in the slave register is rewritten to 0), it means that after the current byte is transmitted, the slave will actively end the transmission and return to the idle state (STATE[2: 0] = 000), no longer receive data from the Master.



#### Non-general Address Response, Slave Device Transmitting Mode:

If the read/write bit received in the first frame is read (1), the slave will occupy the bus and send data to the Master. Every time 8 bits of data are sent, the slave releases the bus and waits for the response from the master:

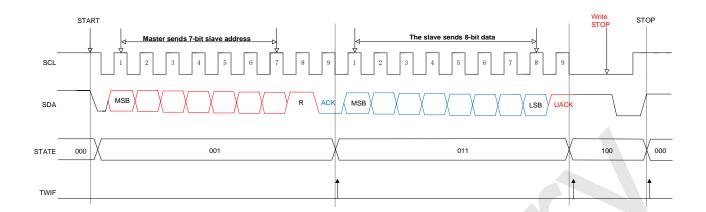
If the master responds with a low level, the slave continues to send data. In the process of sending, if the AA value in the slave register is rewritten to 0, the slave will actively end the transmission and release the bus after the current byte is transmitted, and wait for the stop signal or restart signal of the master (STATE[2: 0] = 101).



2. If the master responds to a high level, the slave STATE[2: 0] = 100, waiting for the master's stop signal or restart signal.

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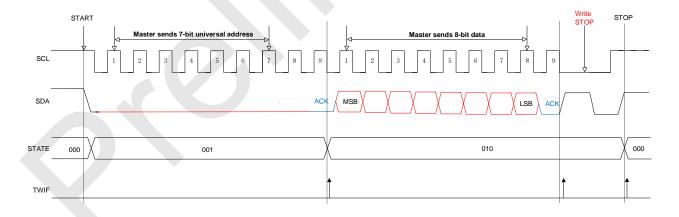




#### General Address Response:

When GC=1, the general address is allowed to be used at this time. The slave enters the state of receiving the first frame address (STATE[2: 0] = 001), the address bit data in the first frame of data received is 0x00, and all slaves respond to the master at this time. The read and write bits sent by the master must be write (0), and all slaves enter the state of receiving data (STATE[2: 0] = 010) after receiving. The Master releases the SDA line every time 8 data is sent, and reads the status on the SDA line:

- 1. If there is a response from the slave, the communication of the master can be in the following three ways:
  - 1) Continue to send data;
  - 2) Restart;
  - 3) Send a stop signal to end this communication.



2. If no slave responds, SDA is idle.

Note: When using the universal address in the one-master multiple-slave mode, the read and write bits sent by the Master cannot be in the read (1) state, otherwise, all devices on the bus will respond except for the device sending the data.

### 17.2.3 Slave Mode Operation Steps

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### Super High-Speed Flash MCU

- Configure USMDn[1: 0] and select TWI mode;
- 2. Configure the TWIn control registers USnCON0 and USnCON1;
- 3. Configure the TWI address register USnCON2;
- 4. If the slave receives data, it waits for the interrupt flag bit TWIF in USnCON0 to be set. Every time the slave receives 8 bits of data, TWIF will be set to 1. The interrupt flag bit TWIF needs to be manually cleared:
- 5. If the slave sends data, write the data to be sent into TWDAT, and TWI will automatically send the data. Every 8 bits are sent, the interrupt flag bit TWIF will be set.

#### 17.2.4 Master operating Mode

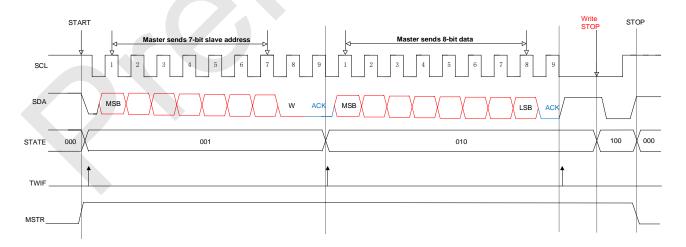
#### Mode startup:

When the TWI interface sends an initial condition to the bus, it will automatically switch to the main mode, and the hardware will set the MSTR bit to 1. The Master state bit STATE[2: 0] switches from 000 to 001, and the interrupt condition TWIF is set to 1.

#### TWI Master sending mode:

In the master sending mode, the first frame of data sent by the master includes 7 address bits (selected slave address) and 1 read/write bit (=0, write command). All slaves on the TWI bus will receive the master The first frame of data. The Master releases the SDA signal line after sending the first frame of data. The selected slave sends a response signal to the master in the 9th clock cycle of SCL, and then releases the bus and enters the slave receiving state to wait for the data sent by the master. The master must release the bus every time it sends 8 bits and wait for the response signal from the slave in the 9th cycle.

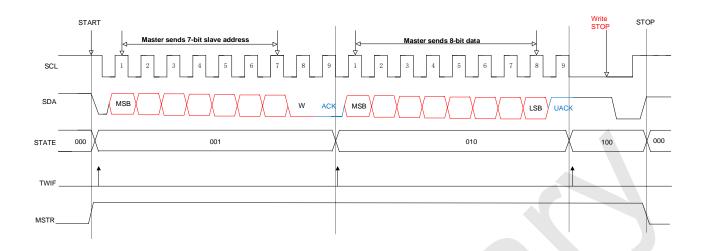
1. If the slave responds low, the master can continue to send data. You can also resend the start signal:



2. If the slave responds to a high level, it means that after the current byte has been transmitted, the slave will actively end this transmission and will no longer receive the data sent by the master. The master STATE[2: 0] will switch from the sending data state 010 to 100:

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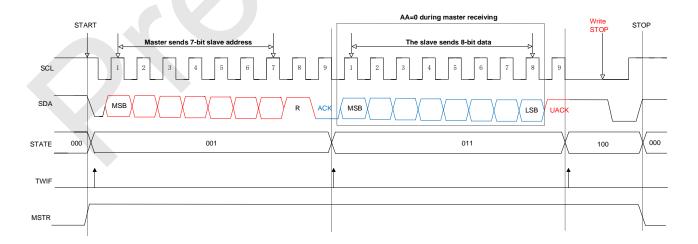


#### • TWI Master Receiving Mode:

In the master sending mode, the first frame of data sent by the master includes a 7-bit address bit (selected slave address) and a 1-bit read and write bit (=1, read command). All slaves on the TWI bus will receive The first frame of data to the Master. The Master releases the SDA signal line after sending the first frame of data. The selected slave sends an acknowledge signal to the master in the 9th clock cycle of SCL, and then will occupy the bus and send data to the master. Every time 8 bits of data are sent, the slave releases the bus and waits for the response from the master. The Master receives the response signal ACK after the slave address is successfully matched, and starts to receive the slave data (STATE=011):

- 1. If the Master response bit is enabled (AA=1), every time a BYTE data is received, the Master responds with the response signal ACK, and TWIF is set;
- 2. Before receiving the last byte of data, if the response enable bit is turned off (AA=0), the Master will reply UACK after receiving the last byte of data, and then the Master can send a stop signal.

In the Master receiving mode, the way to actively release the bus is as follows:



#### 17.2.5 Master Mode Operation Steps

Configure USMDn[1: 0] and select TWI mode;

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### **Super High-Speed Flash MCU**

- 2. Configure the TWIn control register USnCON0: TWEN = 1, enable TWI
- 3. Configure the TWIn control register USnCON1: configure the TWI communication rate (TWCK[3: 0]), set the start bit STA to "1"
- 4. Configure TWIn address register USnCON3: write "slave address plus read and write bits" into TWDAT, and send out an address frame on the bus
- If the Master receives data, it waits for the interrupt flag bit TWIF in USnCON0 to be set 1. When the Master receives 8 bits of data, the interrupt flag bit will be set. The interrupt flag bit needs to be manually cleared;
- 6. If the Master sends data, write the data to be sent into TWDAT, and TWI will automatically send the data. Every 8 bits are sent, the interrupt flag bit TWIF will be set 1.
- 7. After the data is sent and received, the Master can send a stop condition (STO=1), and the Master state switches to 000. Or send a repeated start signal to start a new round of data transmission.

The TWIF of the Master will not be set after the Master generates a stop!

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# 17.3 Serial Interface (UART)

USMDn[1: 0] = 11,  $n=0\sim2$  one of three serial interface USCI is configured as UART interface. It can be easily used to connect with other devices or equipment, such as Wifi module circuit or other UART communication interface driver chip. Its functions and characteristics are as follows:

- 1. Three communication modes are available: mode 0, mode 1 and mode 3;
- 2. Independent baud rate generator;
- 3. The interrupt RI/TI can be generated after sending and receiving, and the interrupt flag needs to be cleared by software, the clearing mode is "Write 1 clear".

When USCI is configured as UART interface: :

- USTXn as TX signal
- USRXn as RX signal

US0CON0 (9CH) Serial Port 1 Control Register (read/write)

US1CON0 (A4H) Serial Port 2 Control Register (read/write)

US2CON0 (C4H) Serial Port 3 Control Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	SM0	SM1	SM2	REN	TB8	RB8	TI	RI
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/ Write 1 clear	R/ Write 1 clear
POR	0	0	0	0	0	0	0	0

Bit number	Bit Mnemonic	Description
7~6	SM0~1	Serial communication mode control bit  00: Mode 0, 8-bit half-duplex synchronous communication mode, serial data is sent and received on the RX pin. The TX pin is used as the transmit shift clock. 8 bits are sent and received per frame, and the lower bits are received or sent first;

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		01: Mode 1, 10-bit full-duplex asynchronous communication, composed of 1 start bit, 8 data bits and 1 stop bit, and the communication baud rate is variable;
		10: Reserved;
		11: Mode 3, 11-bit full-duplex asynchronous communication, composed of 1 start bit, 8 data bits, a programmable 9th bit and 1 stop bit, and the communication baud rate is variable.
5	SM2	Serial communication mode control bit 2, this control bit is only valid for mode 3
		0: Set RI every time a complete data frame is received to generate an interrupt request;
		1: When a complete data frame is received, RI will be set to generate an interrupt request only when RB8=1.
		Baud rate multiplier setting bit, only valid in mode 0 (SM0~1 = 00):
		0: The serial port runs at 1/12 of the system clock
		1: The serial port runs at 1/4 of the system clock
4	REN	Receive permission control bit
		0: It is not allowed to receive data;
		1: Allow to receive data.
3	TB8	Only valid for mode 3, which is the 9th bit of the transmitted data
2	RB8	Only valid for mode 3, which is the 9th bit of the received data
1	ТІ	Send interrupt flag
0	RI	Receive interrupt flag

US0CON1 (9DH) Serial Port 1 Baud Rate Control Register Low Bit (read/write)

**US1CON1 (A5H) Serial Port 2 Baud Rate Control Register Low Bit (read/write)** 

US2CON1 (C5H) Serial Port 3 Baud Rate Control Register Low Bit (read/write)

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Bit number	7	6	5	4	3	2	1	0
Symbol		BAUD1L [7: 0]						
Read/ Write	Read/ Write	Read/ Write	Read/ Write	Read/ Write	Read/ Write	Read/ Write	Read/ Write	Read/ Write
Initial power-on value	0	0	0	0	0	0	0	0

US0CON2 (9EH) Serial Port 1 Baud Rate Control Register High Bit (read/write)

US1CON2 (A6H) Serial Port 2 Baud Rate Control Register High Bit (read/write)

US2CON2 (C6H) Serial Port 3 Baud Rate Control Register High Bit (read/write)

Bit number	7	6	5	4	3	2	1	0
Symbol		BAUD1H [7: 0]						
Read/ Write	Read/ Write	Read/ Write	Read/ Write	Read/ Write	Read/ Write	Read/ Write	Read/ Write	Read/ Write
Initial power-on value	0	0	0	0	0	0	0	0

Bit number	Bit Mnemonic	Description
7~0	BAUD1 [15: 0]	USCI Serial port baud rate control
		$BaudRate = \frac{fsys}{[BAUD1H, BAUD1L]}$

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### **Super High-Speed Flash MCU**

**US0CON3 (9FH) Serial 1 Data Buffer Register (read/write)** 

**US1CON3 (A7H) Serial 2 Data Buffer Register (read/write)** 

US2CON3 (C7H) Serial 3 Data Buffer Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic				SBUF	1[7: 0]			
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit number	Bit Mnemonic	Description
7~0	SBUF1[7: 0]	Serial Data Buffer Register
		SBUF1 contains two registers: a sending shift register and a receiving latch. The data written in SBUF1 will be sent to the sending shift register and the sending process will be started. Reading SBUF1 will return the contents of the receiving latch.

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# 18 High-speed Analog-to-Digital Converter (ADC)

The SC92L753X integrates 11 channels of 12-bit high-precision high-speed ADC, and the external 10 channels of ADC and other functions of the IO port are multiplexed. The internal one channel can be connected to 1/4 VDD, and the internal 2.4V, 1.024V or 2.048V reference voltage is used for Measure the VDD voltage. 1 MHz superhigh-speed sampling clock, the total time from sampling to completion of conversion is as low as  $2\mu$ s

There are 4 choices for the ADC reference voltage of SC92L753X:

- 1) VDD pin (that is directly the internal VDD);
- (2) The reference voltage output by the internal Regulator is accurately 2.4V.
- 3 The reference voltage output by the internal Regulator is exactly 1.024V.
- 4 The reference voltage output by the internal Regulator is exactly 2.048V.

### 18.1 ADC-related Registers

#### ADCCON (ADH) ADC Control Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	ADCEN	ADCS	EOC/ADCIF		P	ADCIS[4: 0]		
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	n

Bit number	Bit Mnemonic	Description
7	ADCEN	Power on ADC  0: Disable the ADC module power  1: Enable the ADC module power
6	ADCS	ADC start trigger control (ADC Start)  Write "1" to this bit to start ADC conversion, that is, this bit is only the trigger signal of ADC conversion. This bit can only be written with 1 to be valid.

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5	EOC /ADCIF	Conversion complete/ADC Interrupt Flag (End Of Conversion / ADC Interrupt Flag)
		0: Conversion has not been completed
		1: ADC conversion is complete. Need user software to clear
		ADC conversion complete flag EOC: when the user sets ADCS to start conversion, this bit will be automatically cleared to 0 by the hardware; when the conversion is completed, this bit will be automatically set to 1 by the hardware;
		ADC interrupt request flag ADCIF:
		This bit is also used as an interrupt request flag for ADC interrupt. If the user enables the ADC interrupt, the user must clear this bit by software after the ADC interrupt occurs.
4~0	ADCIS[4: 0]	ADC Input Selector (ADC Input Selector)
		00000: select AIN0 as ADC input
		00001: select AIN1 as ADC input
		00010: Use AIN2 as ADC input
		00011: Choose AIN3 as ADC input
		00100: Choose AIN4 as ADC input
		00101: Choose AIN5 as ADC input
		00110: select AIN6 as ADC input
		00111: Choose AIN7 as ADC input
		01000: select AIN8 as ADC input
		01001: select AIN9 as ADC input
		01010~11110: reserved
		11111: ADC input is 1/4 $V_{\text{DD}}$ , which can be used to measure power supply voltage

### ADCCFG2 (B5H) ADC Set Register 2 (read/write)

Bit number	7	6	5	4	3	2	1	0

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Symbol	-	-	-	ı	LOWSP[2: 0	-	-	
Read/ Write	-	-	-	Read/ Write	Read/ Write	Read/ Write	-	-
Initial power-on value	х	х	х	0	0	0	x	х

Bit number	Bit Mnemonic	Description
4~2	LOWSP[2: 0]	ADC sampling period selection:
		100: The sampling time is 3 system clocks, (about 100ns @fsys = 32 MHz)
		101: The sampling time is about 6 system clocks, (about 200ns @fsys = 32 MHz)
		110: The sampling time is about 16 system clocks, (about 500ns @ fsys = 32 MHz)
		111: The sampling time is about 32 system clocks, (about 1000ns @ fsys = 32 MHz)
		Other: Reserved
		Description: The total time from ADC sampling to completion of conversion TADC = sampling time + conversion time
		The ADC conversion time is fixed at 950ns.
7~5, 1~0	-	Reserved

### ADCCFG0 (ABH) ADC Set Register 0 (read/write)

Bit nu	mber	7	6	5	4	3	2	1	0
--------	------	---	---	---	---	---	---	---	---

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Bit Mnemonic	EAIN7	EAIN6	EAIN5	EAIN4	EAIN3	EAIN2	EAIN1	EAIN0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

### ADCCFG1 (ACH) ADC Set Register 1 (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic		-	-	-			EAIN9	EAIN8
R/W	1	-	-	-		-	R/W	R/W
POR	х	х	х	х	x	х	0	0

Bit number	Bit Mnemonic	Description
0~9	EAINx	ADC port setting register
	(x=0~9)	0: Set AINx as IO port
		Set AINx as ADC input and automatically remove the pull-up resistor.

### OP\_CTM1 (C2H@FFH) Customer Option Register 1(read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	VREF	S[1: 0]	OP_BL	DISJTG	IAPS	[1: 0]	LDSIZ	

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### **Super High-Speed Flash MCU**

R/W	R/	\W						
POR	n	n	n	n	n	n	n	n

Bit number	Bit Mnemonic	Description
7~6	VREFS[1: 0]	Reference voltage selection (the initial value is transferred from Customer Option, the user can modify the setting)
		00: Set VREF of ADC to VDD;
		01: Set the VREF of ADC to the internal accurate 2.4V;
		10: Set the VREF of ADC to the internal accurate 1.024V;
		11: Set the VREF of ADC to the internal accurate 2.048V;

### ADCVL (AEH) ADC Conversion Value Register (low bit) (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	ADCV[3: 0]			-	-	-	-	
R/W	R/W	R/W	R/W	R/W	-	-	-	-
POR	1	1	1	1	х	х	х	х

### ADCVH (AFH) ADC Conversion Value Register (high bit) (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic				ADCV	[11: 4]			

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# Super High-Speed Flash MCU

| R/W |
|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| POR | 1   | 1   | 1   | 1   | 1   | 1   | 1   | 1   |

Bit number	Bit Mnemonic	Description
11~4	ADCV[11: 4]	The high 8-bit value of ADC conversion value
3~0	ADCV[3: 0]	Low 4 bits of ADC conversion value

### IE (A8H) Interrupt Enable Register (read/write)

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	EA	EADC	ET2	EUART	ET1	EINT1	ET0	EINT0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit number	Bit Mnemonic	Description
6	EADC	ADC interrupt enable control  0: Do not allow EOC/ADCIF to generate interrupts  1: Enable EOC/ADCIF to generate interrupt

### IP (B8H) Interrupt Priority Control Register (read/write)

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Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	-	IPADC	IPT2	IPUART	IPT1	IPINT1	IPT0	IPINT0
R/W	-	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	х	0	0	0	0	0	0	0

Bit number	Bit Mnemonic	Description					
6	IPADC	ADC interrupt priority selection					
		0: Set the interrupt priority of ADC to "low"					
		1: Set the interrupt priority of ADC to "High"					

# 18.2 ADC Conversion Steps

The actual operation steps required for the user to perform ADC conversion are as follows:

- Set the ADC input pin; (set the bit corresponding to AINx as ADC input, usually the ADC pin will be fixed in advance);
- ② Set ADC reference voltage Vref, set the frequency used for ADC conversion;
- 3 Enable the ADC module power supply;
- (4) Select ADC input channel; (set ADCIS bit, select ADC input channel);
- Start ADCS and start conversion;
- Wait for EOC/ADCIF=1. If the ADC interrupt is enabled, the ADC interrupt will be generated. The user needs to clear the EOC/ADCIF flag by software;
- (7) Get 12-bit data from ADCVH and ADCVL, first high bit and then low bit, one conversion is completed;
- (8) If you do not change the input channel, repeat steps 5~7 for the next conversion.

Note: Before setting IE[6] (EADC), the user is better to clear EOC/ADCIF with software, and also clear the EOC/ADCIF when the ADC interrupt service routine is executed to avoid continuous ADC interrupts. .

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### 19 CRC Module

The SC92L753X has a built-in hardware CRC module. During the CRC execution calculation, the CPU keeps the program counter. After the CRC calculation is completed, the program counter continues to execute the following instructions.

The module has two calculation modes:

#### Hardware CRC mode 1: CRC operation processing on specified data:

Write the data needed for CRC calculation to the CRC data register CRCREG. When the CRC calculation result needs to be read, read it out from CRCDRn ( $n = 0 \sim 3$ ).

CRC calculation for a single byte requires 8 system clocks, namely 0.25µs@32 MHz.

#### Hardware CRC mode 2: CRC calculation processing for APROM:

It can be used to generate the 32-bit CRC value of APROM (ie 32 Kbytes Flash ROM) in real time. This value is compared with the theoretical value to monitor whether the content of the program area is correct. The theoretical value of CRC does not need to be calculated by the user. The burning software will automatically complete the calculation according to the loaded code and Code area setting items and write the 4 bytes CRC32 calculation result into the CRC result storage area through the programmer during burning. The specific operation For the method, please refer to "User Manual of SinOne Development Mass Production Tool".

It takes about 8.3ms@32 MHz to calculate CRC for 32 Kbytes APROM.

Note: Mode two is invalid when hardware CRC is started in LDROM.

#### The hardware CRC parameter model of SC92L753X:

CRC algorithm name	CRC-32/MPEG-2
Polynomial formula	$x^{32}+x^{26}+x^{23}+x^{22}+x^{16}+x^{12}+x^{11}+x^{10}+x^{8}+x^{7}+x^{5}+x^{4}+x^{2}+x+1$
Data width	32bit
Initial value	0xFFFFFFF
XOR value	0x0000000
Input value inversion	false
Output value inversion	false
LSB/MSB	MSB

#### **CRC Precautions for use:**

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### **Super High-Speed Flash MCU**

- CRCDRn write data and read data are not the same;
- 2. The CRC value calculated by the hardware is the 32-bit CRC check value of the data in the entire program area (note that the IAP area is not included here!). If there is a residual value after the user's last operation in the address unit, it will cause the CRC value to be inconsistent with the theoretical value. Therefore, it is recommended that the user erase the entire Flash ROM before programming the code to ensure that the CRC value is consistent with the theoretical value;
- 3. The hardware CRC calculation range does not include the IAP area;
- 4. Be sure to add at least 8 NOP instructions after the CRC start operation statement to ensure that the CRC calculation is completed;
- 5. When performing CRC calculation, it is necessary to disable the global interrupt EA, and then reopen the global interrupt after 8 NOPs.

# 19.1 CRC Check Operation Related Registers

### **OPERCON (EFH) Operation Control Register (read/write)**

Bit number	7	6	5	4	3	2	1	0
Bit Mnemonic	OPERS	MD	-			-	CRCRST	CRCSTA
R/W	R/W	R/W	-	-	1	1	R/W	R/W
POR	0	0	x	х	х	х	0	0

Bit number	Bit Mnemonic	Description
1	CRCRST	CRCDR register reset (Q31~Q0) Write "1" to this bit to reset CRCDR to all 1s
0	CRCSTA	CRC hardware calculation start bit  Write "1" to this bit to start a check sum calculation. This bit can only be written with 1 to be valid.

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The read and write operations of the CRC data register CRCDRn (n =  $0\sim3$ ) are controlled by the two registers CRCINX and CRCREG. The specific position of each CRCRN is determined by CRCINX, as shown in the following table:

Symbol	Address	Description		POR
CRCINX	FCH	CRC pointer	CRCINX[7: 0]	0000000b
CRCREG	FDH	CRC register	CRCREG[7: 0]	nnnnnnnb

Symbol	Address	Description	7	6	5	4	3	2	1	0
CRCDR3	03H@FDH	CRC Data register 3	Q31	Q30	Q29	Q28	Q27	Q26	Q25	Q24
CRCDR2	02H@FDH	CRC Data register 2	Q23	Q22	Q21	Q20	Q19	Q18	Q17	Q16
CRCDR1	01H@FDH	CRC Data register 1	Q15	Q14	Q13	Q12	Q11	Q10	Q9	Q8
CRCDR0	00H@FDH	CRC Data register 0	Q7	Q6	Q5	Q4	Q3	Q2	Q1	Q0

The related description of CRCDRn (n = 0~3) bits is as follows:

Bit number	Bit Mnemonic	Description
Bit31~0	Qx (x = 0~31)	<ol> <li>Hardware CRC mode 1: CRC operation processing on specified data:</li> <li>You must write CRCRST first, reset CRCDR to all 1s</li> <li>When CRCREG is written, the hardware automatically calculates the CRC result and continues to store it in CRCDR</li> <li>When needed, read the CRC calculation result instantly</li> </ol>

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Hardware CRC mode 2: CRC calculation processing on APROM:

- 1. Started by CRCSTA, at this time the CPU automatically enters IDLE
- 2. Automatically reset CRCDR to all 1:

The hardware CRC calculation range does not include the IAP area. The calculation range of CRC is divided into four types according to the value of IAPS[1: 0]:

- ① IAPS[1:0]=00(Flash ROM last 0K available for IAP): 0000H ~ before last 0K
- ② IAPS[1:0]=01(Flash ROM last 1K available for IAP): 0000H ~ before last 1K
- ③ IAPS[1:0]=10(Flash ROM last 1K available for IAP): 0000H ~ before last 2K
- ④ IAPS[1:0]=11(Flash ROM all available for IAP): 0000H ~ All Flash ROM
- After the end, the CPU automatically exits IDLE, you can read the CRC calculation result

Note: Write data and read data are not the same data.

When operating CRC-related SFR, the CRCINX register stores the address of the relevant CRCTION register, and the CRCREG register stores the corresponding value.

Before reading CRCREG, you need to set CRCINX and then read it. After each reading, CRCINX automatically adds 1 (0~3 cycles).

#### Hardware CRC mode 1 example: calculate CRC according to the data provided by the user

#include "intrins.h"

xdata unsigned int i;

xdata unsigned long int CRC\_Result = 0x00; // Verification result

unsigned char  $a[16] = \{0x00,0x01,0x02,0x03,0x04,0x05,$ 

0x06,0x07,0x08,0x09,0x0A,

0x0B,0x0C,0x0D,0x0E,0x0F; // The value to be verified

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```
typedef struct
char a3; // Highest address
char a2; // Second highest address
char a1; // Second lowest address
char a0; // Lowest address
}Value_Typedef;
typedef union
Value_Typedef reg;
unsigned long int result; // Final Results
}Result_Typedef;
Result_Typedef CRC_Result;
                           // Disable the global interrupt
  EA = 0;
OPERCON |= 0x02;
                            // Start software inspection
                            // At least 8 NOP instructions
_nop_();
for(i=0; i<16; i++)
{
```

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```
CRCREG = a[i];
                  // Calculated value
                  // At least 8 NOP instructions
_nop_();
}
CRCINX = 0x00;
CRC_Result.reg.a0 = CRCREG;
CRC_Result.reg.a1 = CRCREG;
CRC_Result.reg.a2 = CRCREG;
CRC_Result.reg.a3 = CRCREG;
temp = CRC_Result.result; // Get results
                                 // Enable global interrupt
 EA = 1;
```

#### Hardware CRC mode 2 routines: generate APROM CRC in real time

```
#include "intrins.h"
typedef struct
{
    char a3; // Highest address
    char a2; // Second highest address
    char a1; // Second lowest address
    char a0; // Lowest address
}Value_Typedef;
```

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```
typedef union
Value_Typedef reg;
unsigned long int result; //Final Results
}Result_Typedef;
unsigned long int temp = 0x00;
Result_Typedef CRC_Result;
                       // Disable global interrupts
  EA = 0:
OPERCON |= 0x01;
                       // Start hardware verification
                       // At least 8 NOP instructions
_nop_();
_nop_();
_nop_();
_nop_();
_nop_();
_nop_();
_nop_();
_nop_();
CRCINX = 0x00;
CRC_Result.reg.a0 = CRCREG;
CRC_Result.reg.a1 = CRCREG;
CRC_Result.reg.a2 = CRCREG;
CRC_Result.reg.a3 = CRCREG;
  temp = CRC_Result.result;
                               // Get results
  EA = 1;
                               // Enable global interrupt
```

Note: It is prohibited to write values other than the CRC register address to the CRCINX register! Otherwise it will cause abnormal system operation!

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# **20 Electrical Characteristics**

# 20.1 Absolute Maximum Ratings

Symbol	Parameter	Min Value	Max Value	UNIT	Condition
VDD/VSS	DC supply voltage	-0.3	5.5	V	
Voltage ON any Pin	Input/output voltage of any pin	-0.3	V <sub>DD</sub> +0.3	V	
TA	Operating temperature	-40	105	°C	
T <sub>STG</sub>	Storage temperature	-55	125	$^{\circ}$ C	
I <sub>VDD</sub>	Current value flowing through VDD	-	200	mA	T <sub>A</sub> = +25℃
Ivss	Current value flowing through VSS	-	200	mA	T <sub>A</sub> = +25℃

# **20.2 Recommended Operating Conditions**

Symbol	Parameter	Min Value	Max Value	UNIT	Condition
V <sub>DD1</sub>	Operating Voltage	1.8	5.5	V	T <sub>A</sub> = 0°C ~85°C
V <sub>DD2</sub>	Operating Voltage	2.0	5.5	٧	T <sub>A</sub> = -40°C ~105°C

### 20.3 Flash ROM Characteristics

Symbol Par	meter Min Value	Typical Values	Max Value	UNIT	Condition
------------	-----------------	-------------------	--------------	------	-----------

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### **Super High-Speed Flash MCU**

Nend	Wipe the number	100,000	-	-	Cycle s	
T <sub>DR</sub>	Data Retention Time	100	-	-	Years	T <sub>A</sub> = +25°C
Ts-Erase	Sector Erase Time	-	5	-	ms	T <sub>A</sub> = +25℃
T All-Erase	32k Flash ROM Erase Time	-	25	-	ms	T <sub>A</sub> = +25°C
Twrite	Byte Program Time	-	30		μs	T <sub>A</sub> = +25℃

# 20.4 DC Characteristics

 $(V_{DD} = 5V, T_A = +25$ °C, Unless otherwise specified)

Symbol	Parameter	Minimum	Typical value	Maximum	Unit	Test Conditions
Current						
l <sub>op1</sub>	Operating current	-	4.5	1	mA	fsys=32 MHz
l <sub>op2</sub>	Operating current	-	3	-	mA	fsys=16 MHz
l <sub>ор3</sub>	Operating current	-	2	-	mA	fsys=8 MHz
l <sub>op4</sub>	Operating current	-	1.7	-	mA	fsys=4 MHz
l <sub>pd1</sub>	Stand-by current (Power Down Mode)	-	1	2	μΑ	
I <sub>IDL1</sub>	Stand-by current (IDLE Mode)	-	3	-	mA	fsys=32 MHz

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				1		Ī
Івтм	Base Timer Operating current	-	0.5	1	μА	BTMFS[3: 0]= 1000 Generate an interrupt every 4.0 seconds
Іwdт	WDT current	-	0.5	1	μА	WDTCKS[2: 0]= 000 WDT overflow time 500ms
IO port chai	racteristics					
V <sub>IH1</sub>	Input high voltage	0.7V <sub>DD</sub>	-	V <sub>DD</sub> +0.3	V	GPIO
V <sub>IL1</sub>	Input low voltage	-0.3	٠	0.3V <sub>DD</sub>	V	
V <sub>IH2</sub>	Input high voltage	$0.8V_{DD}$		$V_{DD}$	V	Schmitt trigger input: RST
V <sub>IL2</sub>	Input low voltage	-0.2	<u>-</u>	0.2V <sub>DD</sub>	V	tCK / tDIO  UART0 input RX0  USCI signal input port  INT0~2  PWM fault detection FLT  Timer clock input port  Timer capture port
I <sub>OL1</sub>	Output low current	-	29	-	mA	V <sub>Pin</sub> =0.4V
I <sub>OL2</sub>	Output low current	-	50	-	mA	V <sub>Pin</sub> =0.8V

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## Super High-Speed Flash MCU

	SPI0 Signal port:					
IOHSPI0A	USCK0 (P05)	-	20	-	mA	Only applicable to SPI0 data
	USTX0 (P20)					transmission
	USRX0 (P21)					
	Output high current@ V <sub>Pin</sub> =4.3V					
I <sub>OH1</sub>	Output high current @ V <sub>Pin</sub> =4.3V	-	10	-	mA	Pxyz=0,I <sub>OH</sub> level 0
		-	7.5		mA	Pxyz=1,I <sub>OH</sub> level
		-	5		mA	Pxyz=2,Iон level 2
		-	2	-	mA	Pxyz=3,I <sub>OH</sub> level 3
I <sub>ОНЅРЮВ</sub>	SPI0 Signal port: USCK0 (P05) USTX0 (P20)		8	-	mA	Only applicable to SPI0 data transmission
	USRX0 (P21)					
	Output high current @ V <sub>Pin</sub> =4.7V					
Іон2	Output high current @ V <sub>Pin</sub> =4.3V	-	4.5	-	mA	Pxyz=0,loн level 0
		-	3.5	-	mA	Pxyz=1,l <sub>OH</sub> level
		-	2	-	mA	Pxyz=2,I <sub>OH</sub> level 2
		-	1	-	mA	Pxyz=3,I <sub>OH</sub> level 3
R <sub>PH1</sub>	Pull-up resistor	-	30	-	kΩ	

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# ( $V_{DD} = 3.3V$ , $T_A = +25$ °C, Unless otherwise specified)

Symbol	Parameters	Min Value	Typical value	Max Value	Unit	Test condition	
Current	Current						
l <sub>op5</sub>	Operating current	-	4.5	-	mA	fsys=32 MHz	
I <sub>op6</sub>	Operating current	-	3	-	mA	fsys=16 MHz	
I <sub>op7</sub>	Operating current	-	2	-	mA	fsys=8 MHz	
l <sub>op8</sub>	Operating current	-	1.7		mA	fsys=4 MHz	
l <sub>pd2</sub>	Stand-by current(Power Down Mode)	-	1	2	μА		
l <sub>IDL2</sub>	Stand-by current (IDLE Mode)		3	-	mA	fsys=32 MHz	
IO port cha	racteristics						
V <sub>IH3</sub>	Input high voltage	0.7V <sub>DD</sub>	-	V <sub>DD</sub> +0.3	V		
V <sub>IL3</sub>	Input low voltage	-0.3	-	0.3V <sub>DD</sub>	V		
V <sub>IH4</sub>	Input high voltage	0.8V <sub>DD</sub>	-	V <sub>DD</sub>	V	Schmitt trigger input: RST	
V <sub>IL4</sub>	Input low voltage	-0.2	-	0.2V <sub>DD</sub>	V	tCK / tDIO	
						UART0 input RX0	
						USCI signal input port	
						IINTU~Z	

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						PWM fault detection FLT
						Timer clock input port
						Timer capture port
l <sub>ОL3</sub>	Output low current	-	20	-	mA	V <sub>Pin</sub> =0.4V
l <sub>OL4</sub>	Output low current	-	35	-	mA	V <sub>Pin</sub> =0.8V
Іонѕрюс	SPI0 Signal port: USCK0 (P05) USTX0 (P20)	-	6		mA	Only applicable to SPI0 data transmission
	USRX0 (P21)		(			
	Output high current@ V <sub>Pin</sub> =3.0V					
Іонз	Output high current @ V <sub>Pin</sub> =3.0V		3	-	mA	Pxyz=0,I <sub>OH</sub> level 0
			2.5	-	mA	Pxyz=1,I <sub>OH</sub> level 1
		-	1.5	-	mA	Pxyz=2,I <sub>OH</sub> level 2
		-	0.8	-	mA	Pxyz=3,I <sub>OH</sub> level 3
R <sub>PH2</sub>	Pull-up resistor	-	55	-	kΩ	

## 20.5 AC Characteristics

 $(V_{DD} = 1.8V \sim 5.5V, T_A = 25$ °C, Unless otherwise indicated)

Symbol Par	ameters Min Value	Typical Value	Max Value	Unit	Test condition
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### **Super High-Speed Flash MCU**

Tosc	External 32.768k oscillator start- up time	-	-	1	S	External 32.768 kHz crystal oscillator
T <sub>POR</sub>	Power On Reset time	1	15	1	ms	
T <sub>PDW</sub>	Power Down mode wake-up time	-	65	130	μs	
T <sub>Reset</sub>	Reset pulse width	18	ı	-	μs	Low level valid
T <sub>LVR</sub>	LVR buffeting time	-	30	-	μs	
fHRC1	RC oscillation stability	31.68	32	32.32	MHz	T <sub>A</sub> =-10~105℃
f <sub>HRC2</sub>	RC oscillation stability	31.36	32	32.64	MHz	T <sub>A</sub> =-20~105 ℃

## 20.6 ADC Characteristics

### (T<sub>A</sub> = 25°C,Unless otherwise indicated)

Symbol	Parameters	Min Value	Typical Value	Max Value	Uni t	Condition
V <sub>AD1</sub>	Supply voltage 1	2.7	5.0	5.5	V	Vref = 2.4V
V <sub>AD2</sub>	Supply voltage 2	2.0	5.0	5.5	V	Vref = 1.024V OR Vref = V <sub>DD</sub>
V <sub>AD3</sub>	Power supply voltage 3	2.7	5.0	5.5	V	Vref = 2.048V
V <sub>REF1</sub>	Internal reference 2.4V	2.38	2.40	2.42	V	V <sub>DD</sub> = 2.7~5.5V
V <sub>REF2</sub>	Internal reference 1.024V	1.004	1.024	1.044	V	V <sub>DD</sub> = 2.0~5.5V

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V <sub>REF3</sub>	Internal reference 2.048V	2.028	2.048	2.068	V	V <sub>DD</sub> = 2.7~5.5V
N <sub>R</sub>	Precision	-	12	-	bit	GND≤V <sub>AIN</sub> ≤V <sub>DD</sub>
Vain	ADC input voltage	GND	-	V <sub>DD</sub>	V	
Rain	ADC input resistance	1	-		МΩ	V <sub>IN</sub> =5V
ladc1	ADC conversion current 1	-	-	2	mA	ADC module open V <sub>DD</sub> =5V
l <sub>ADC2</sub>	ADC conversion current 2	-	-	1.8	mA	ADC module open VDD=3.3V
DNL	Differential Non- Linearity	-		±3	LS B	
INL	Integral Non- Linearity			±3	LS B	
Ez	Offset error	-	±3	-	LS B	V <sub>DD</sub> =5V V <sub>REF</sub> =5V
E <sub>F</sub>	Full scale error	<b>)</b> -	±1	1	LS B	
E <sub>AD</sub>	Absolute Accuracy	-	±3	-	LS B	
T <sub>ADC1</sub>	ADC conversion time	-	1.1	1.4	μs	Fsys=32MHz LOWSP[2:0] = 100
T <sub>ADC2</sub>	ADC conversion time 2	-	1.2	1.5	μs	Fsys=32MHz LOWSP[2:0] = 101
Тадсз	ADC conversion time 3	-	1.5	1.9	μs	Fsys=32MHz LOWSP[2:0] = 110

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T <sub>ADC4</sub>	ADC conversion time 4	-	2.0	2.6	μs	Fsys=32MHz LOWSP[2:0] = 111
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## 20.7 LPD Characteristics

Symbol	position	Test condition	Typical Value	Min Value	Typical Value	Max Value	Unit
V/	1.85V	LPD threshold	Falling edge	1.80	1.84	1.88	
V <sub>LPD0</sub>	1.007	0	Rising edge	1.88	1.94	1.99	
V	2.05V	LPD threshold	Falling edge	1.98	2.04	2.09	
V <sub>LPD1</sub>	2.05 V	1	Rising edge	2.08	2.14	2.18	
V <sub>LPD2</sub>	2.25V	LPD threshold	Falling edge	2.20	2.24	2.28	
V LPD2	2.25 V	5	Rising edge	2.28	2.34	2.38	
V <sub>LPD3</sub>	2.45V	LPD threshold	Falling edge	2.39	2.44	2.48	
V LPD3	2.45 V	2	Rising edge	2.47	2.54	2.58	V
V <sub>LPD4</sub>	2.85V	LPD threshold	Falling edge	2.77	2.83	2.88	V
V LPD4	2.65 V	3	Rising edge	2.87	2.94	2.99	
V <sub>LPD5</sub>	3.45V	LPD threshold	Falling edge	3.39	3.44	3.48	
V LPD5	3.45 V	4	Rising edge	3.47	3.54	3.58	
V	3.85V	LPD threshold	Falling edge	3.77	3.83	3.88	
V <sub>LPD6</sub>	3.03 V	6	Rising edge	3.87	3.94	3.99	
V <sub>LPD7</sub>	4.45V	LPD threshold	Falling edge	4.39	4.44	4.48	
V LPD7	4.45 V	7	Rising edge	4.47	4.54	4.58	

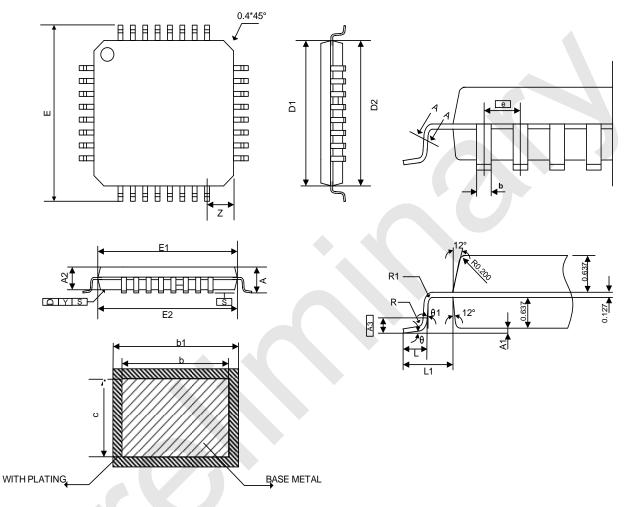
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# 21 Package Information

SC92L7535P32R

### LQFP32 (7X7) Overall Dimensions Unit: mm



Symbol	mm				
Symbol	Min Value	Typical Value	Max Value		
Α	1.45	1.55	1.65		
A1	0.01		0.21		
A2	1.30	1.4	1.5		
A3		0.254			
b	0.30	0.35	0.41		
b1	0.31	0.37	0.43		

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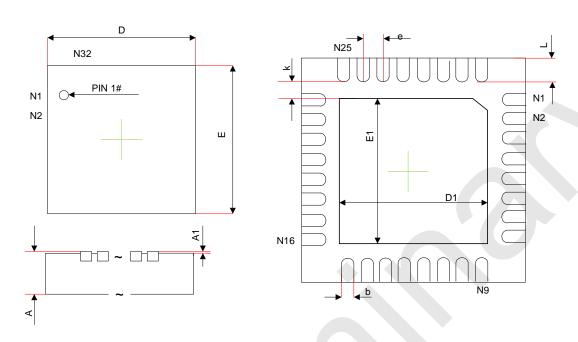
С	0.12	0.13	0.14
D1	6.85	6.95	7.05
D2	6.90	7.00	7.10
Е	8.80	9.00	9.20
E1	6.85	6.95	7.05
E2	6.90	7.00	7.10
e		0.8	
L	0.43	1	0.75
L1	0.90	1.0	1.10
R	0.1		0.25
R1	0.1		
θ	0°		10°
θ1	0°		
у			0.1
Z		0.70	

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#### SC92L7535Q32R

### QFN32 (5X5) Overall Dimensions Unit: mm



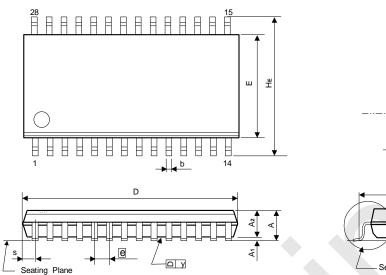
Cumbal		mm				
Symbol	Min Value	Typical Value	Max Value			
А	0.70	0.75	0.80			
A1		0.02	0.05			
b	0.18	0.25	0.30			
D	5 BSC					
E	5 BSC					
е	0.5 BSC					
k		0.4 REF				
D1	3.30	3.45	3.60			
E1	3.30	3.45	3.60			
L	0.30	0.40	0.50			

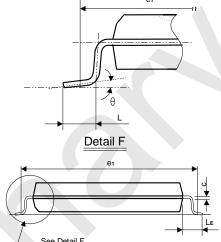
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#### SC92L7533M28U

### SOP28L(300mil) Overall Dimensions Unit: mm





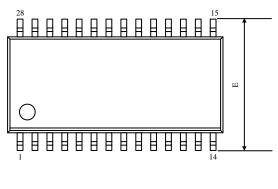
Cymbal		mm	
Symbol	Min Value	Typical Value	Max Value
Α	2.40	2.56	2.65
A <b>1</b>	0.100	0.200	0.300
A <b>2</b>	2.240	2.340	2.440
b	0.39		0.48
С		0.254(BSC)	
D	17.80	18.00	18.20
E	7.30	7.50	7.70
HE	10.100	10.300	10.500
e		1.270(BSC)	
L	0.7	0.85	1.0
LE	1.3	1.4	1.5
θ	0°	-	8°

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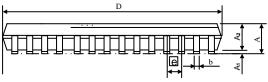


#### SC92L7533X28U

### TSSOP28L Overall Dimensions Unit:mm









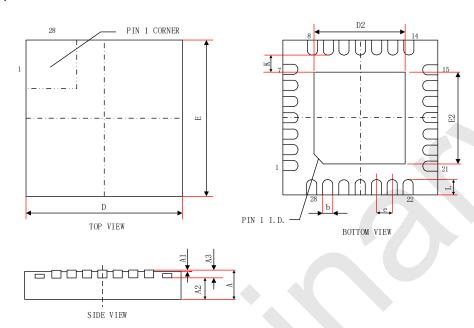
Cumah al	mm					
Symbol	Min Value	Typical Value	Max Value			
Α	-	-	1.200			
A1	0.050	-	0.150			
A <b>2</b>	0.800	-	1.050			
b	0.190	-	0.300			
С	0.090	-	0.200			
D	9.600	-	9.800			
E	6.250	-	6.550			
e1	4.300	-	4.500			
e		0.65(BSC)				
L	-	-	1.0			
θ	0°	-	8°			
Н	0.05	-	0.25			

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#### SC92L7533Q28R

### QFN28(4X4)外形尺寸 单位: 毫米



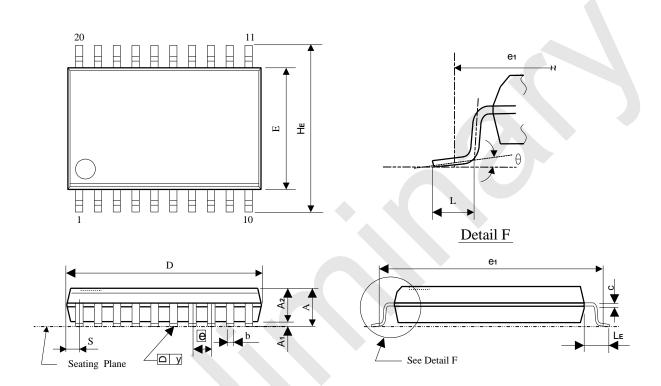
Symbol		mm		
	Min Value	Typical Value	Max Value	
Α	0.7	0.75	0.8	
A1	0	0.02	0.05	
A2		0.55	-	
A3		0.203 REF		
b	0.18	0.23	0.28	
D		4 BSC		
Е		4 BSC		
е		0.45 BSC		
D2	2.5	2.6	2.7	
E2	2.5	2.6	2.7	
L	0.25	0.35	0.45	
K		0.35 REF		

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#### SC92L7532M20U

### SOP20L(300mil) Overall Dimensions Unit: mm



Symb	a d	mm				
Symb	101	Min Value	Typical Value	Max Value		
А		2.40	2.56	2.65		
A1	1	0.100	0.200	0.300		
A2	2	2.240	2.340	2.440		
b		0.35		0.47		
С		0.25		0.31		
D		12.60	12.80	13.00		
Е		7.30	7.50	7.70		
Н	E	10.100	10.300	10.500		
е			1.27(BSC)			

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Super High-Speed Flash MCU

L	0.700	0.850	1.000
LE	1.30	1.40	1.50
θ	0°	-	8°

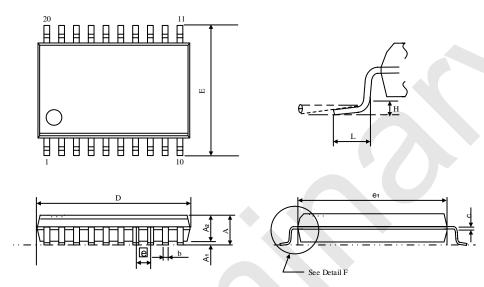
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#### SC92L7532X20U

### TSSOP20L Overall Dimensions Unit: mm



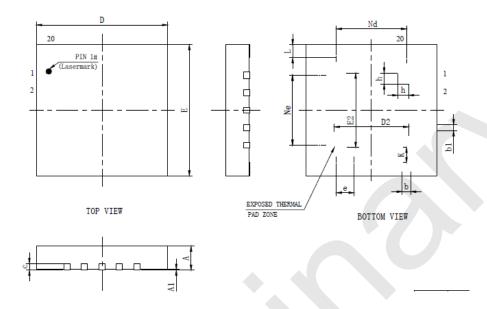
Cumbal		mm	
Symbol	Min Value	Typical Value	Max Value
А	-	-	1.200
A1	0.050	-	0.150
A <b>2</b>	0.800	-	1.050
b	0.190	-	0.300
С	0.090	-	0.200
D	6.400	-	6.600
E	6.20	-	6.60
e1	4.300	-	4.500
e		0.65(BSC)	
L	-	-	1.00
θ	0°	-	8°
Н	0.05	-	0.15

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#### SC92L7532Q20R

### QFN20 L(3\*3) Overall Dimensions Unit: mm



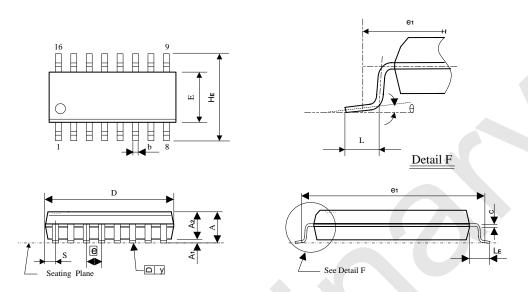
Symbol	mm			
_	Min Value	Typical Value	Min Value	
Α	0.50	0.55	0.60	
A1	0	0.02	0.05	
b	0.15	0.20	0.25	
b1	0.14REF			
С	0.15REF			
D	2.90	3.00	3.10	
D2	1.60	1.70	1.80	
е	0.40BSC			
Ne	1.60BSC			
Nd	1.60BSc			
E	2.90	3.00	3.10	
E2	1.60	1.70	1.80	
L	0.25	0.30	0.35	
h	0.20	0.25	0.30	
K	0.30	0.35	0.40	

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#### SC92L7531M16U

### SOP16L(150mil) Overall Dimensions Unit: mm



Symbol	mm			
	Min Value	Typical Value	Min Value	
Α	1.500	1.625	1.750	
A1	0.050	0.1375	0.225	
A2	1.30	1.45	1.55	
b	0.38	0.43	0.48	
С	0.20	0.23	0.26	
D	9.70	9.90	10.10	
Е	3.70	3.90	4.10	
HE	5.80	6.00	6.20	
е	1.27(BSC)			
L	0.50	0.65	0.80	
LE	0.95	1.05	1.15	
θ	0°	-	8°	

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# **22 Revision History**

Revision	Changes	Date
V0.1	Initial Release.	May 2022

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# **Important Notice**

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